

TinyPower[™] A/D Type with LCD 8-Bit OTP MCU HT56R62/HT56R65 HT56R642/HT56R644/HT56R654/HT56R656

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Features

- · Operating voltage:
 - f_{SYS}=32768Hz: 2.2V~5.5V
 - f_{SYS}=4MHz: 2.2V~5.5V
 - f_{SYS}=8MHz: 3.0V~5.5V
 - f_{SYS}=12MHz: 4.5V~5.5V
- · Operating current:
 - f_{SYS}=1MHz at 3V, 170μA, typ.
 - f_{SYS}=32kHz at 3V, 6µA, typ.
- OTP Program Memory: 2K×14~8K×16
- RAM Data Memory: 128×8~1152×8
- 20 to 24 bidirectional I/O lines
- · TinyPower technology for low power operation
- · Three pin-shared external interrupts lines
- Multiple programmable Timer/Event Counters with overflow interrupt and 7-stage prescaler
- External Crystal, RC and 32768 XTAL oscillators
- Fully integrated RC 32kHz oscillator
- · Externally supplied system clock option
- · Watchdog Timer function
- PFD/Buzzer for audio frequency generation
- Dual Serial Interfaces: SPI and I²C
- · LCD and LED driver function
- 4 operating modes: normal, slow, idle and sleep
- 6 or 8-channel 12-bit resolution A/D converter
- 3 or 4-channel 12-bit PWM outputs
- Low voltage reset function: 2.1V, 3.15V, 4.2V
- Low voltage detect function: 2.2V, 3.3V, 4.4V
- · Bit manipulation instruction
- · Table read instructions
- 63 powerful instructions
- Up to $0.33\mu s$ instruction cycle with 12MHz system clock at $V_{DD}=5V$
- · Multiple level subroutine nesting
- · All instructions executed in one or two machine cycles
- · Power down and wake-up functions to reduce power consumption
- Wide range of available package types



General Description

These TinyPower™ A/D Type with LCD 8-bit high performance RISC architecture microcontrollers are specifically, designed for applications that interface directly to analog signals and which require an LCD or LED interface. The devices include an integrated multi-channel Analog to Digital Converter, Pulse Width Modulation outputs and an LCD/LED driver.

With their fully integrated SPI and I²C functions, designers are provided with a means of easy communication with external peripheral hardware. The benefits of integrated A/D, LCD, and PWM functions, in addition to low power consumption, high performance, I/O flexibility and low-cost, provides the device with the versatility for a wide range of products in the home appliance and industrial application areas. Some of these products could include electronic metering, environmental monitoring, handheld instruments, electronically controlled tools, motor driving in addition to many others.

The unique Holtek TinyPower technology also gives the devices extremely low current consumption characteristics, an extremely important consideration in the present trend for low power battery powered applications. The usual Holtek MCU features such as power down and wake-up functions, oscillator options, programmable frequency divider, etc. combine to ensure user applications require a minimum of external components.

Selection Table

Most features are common to all devices, the main feature distinguishing them are Program Memory capacity, I/O count, stack capacity and package types. The following table summarises the main features of each device.

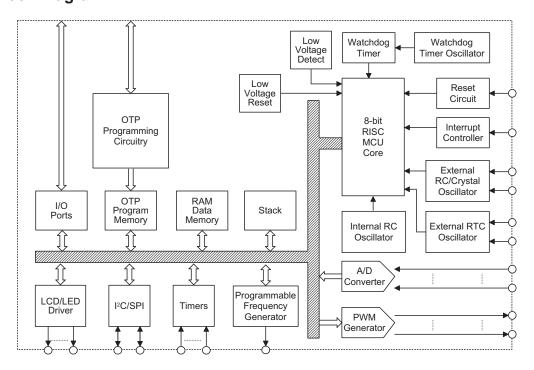
Part No.	V	Program	Data	I/O	LCD	Ti		A/D	PWM	Stack	Package
Part No.	V _{DD}	Memory	Memory	1/0	LCD	8-bit	16-bit	A/D	PVVIVI	Stack	Types
HT56R62	2.2V~5.5V	2K×14	128×8	20	24×4 or 25×3	2	_	12-bit×6	12-bit×3	6	52QFP, 64LQFP
HT56R65	2.2V~5.5V	8K×16	576×8	24	40×4 or 41×3	2	1	12-bit×8	12-bit×4	12	52QFP, 64LQFP, 100LQFP
HT56R642	2.2V~5.5V	4K×15	384×8	24	16×16 or 24×8	1	1	12-bit×8	12-bit×4	8	64LQFP
HT56R644	2.2V~5.5V	4K×15	576×8	24	32×16 or	1	1	12-bit×8	12-bit×4	8	100LQFP
HT56R654	2.2 0 ~ 3.3 0	8K×16	1152×8	24	40×8	2	'	12-01180	12-01184	12	TOOLQIFF
HT56R656	2.2V~5.5V	8K×16	1152×8	24	48×16 or 56×8	2	1	12-bit×8	12-bit×4	12	100LQFP

Note: 1. The devices are only available in OTP versions.

2. For devices that exist in more than one package formats, the table reflects the situation for the larger package.

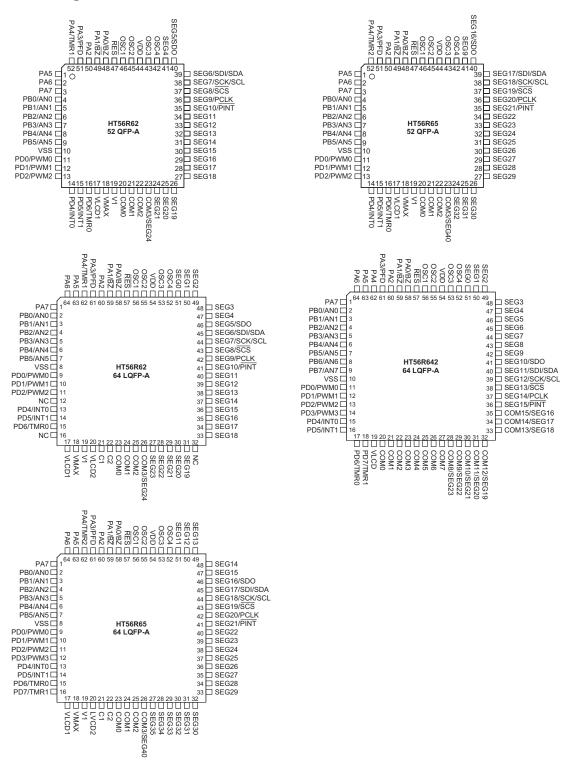


Block Diagram

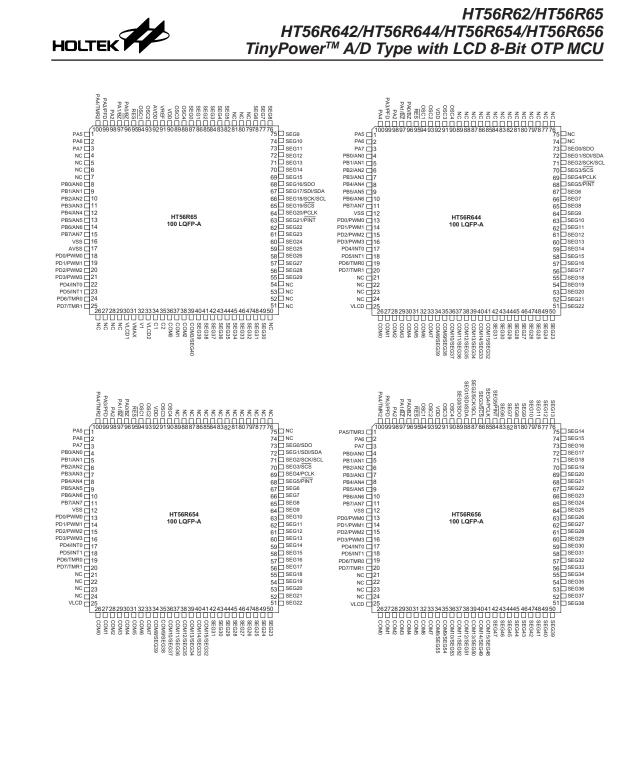




Pin Assignment









Pin Description

The following table depicts the pins common to all devices.

Pin Name	I/O	Configuration Option	Description
PA0/BZ PA1/BZ PA2 PA3/PFD PA4 or PA4/TMR1 or PA4/TMR2 PA5~PA7	I/O	BZ/BZ PFD	Bidirectional 8-bit input/output port. Each individual bit on this port can be configured as a wake-up input using the PAWU register. Software instructions determine if the pin is a CMOS output or Schmitt trigger input. A pull-high resistor can be connected to each pin using the PAPU register. Pins PA0, PA1 and PA3 are shared with BZ, $\overline{\rm BZ}$ and PFD respectively, the function of which is chosen via configuration option. Pins PA0~PA3 can also be setup as open drain pins using the MISC register. The HT56R642 has no shared pins with PA4. Pin PA4 is shared with TMR1 on the HT56R62 and with TMR2 on the HT56R65, HT56R654, HT56R656 and HT56R666.
PB0/AN0~ PB7/AN7 or PB0/AN0~ PB5/AN5	I/O	_	Bidirectional 8-bit input/output port. Software instructions determine if the pin is a CMOS output or Schmitt trigger input. A pull-high resistor can be connected to each pin using the PBPU register. PB is pin-shared with the A/D input pins. The A/D inputs are selected via software instructions. Once selected as an A/D input, the I/O function and pull-high resistor selections are disabled automatically. HT56R62 has six PB pins, PB0/AN0~PB5/AN5 only.
PD0/PWM0~ PD3/PWM3 PD4/INT0 PD5/INT1 PD6/TMR0 PD7/TMR1	I/O		Bidirectional 8-bit input/output port. Software instructions determine if the pin is a CMOS output or Schmitt trigger input. A pull-high resistor can be connected to each pin using the PDPU register. The PWM outputs, PWM0~PWM3, are pin shared with pins PD0~PD3, the function of which is chosen using the PWM registers. Pins PD4~PD7 are pin-shared with INT0, INT1, TMR0 and TMR1 respectively. HT56R62 has three PWM pins and PD7 is not available.
OSC1 OSC2	0	Crystal or RC or EC	OSC1, OSC2 are connected to an external RC network or external crystal, determined by configuration option, for the internal system clock. If the RC system clock option is selected, pin OSC2 can be used to measure the system clock at 1/4 frequency. EC is external clock mode, we can connect OSC1 pin with external clock source directly.
OSC3 OSC4	I О	32768Hz	OSC3 and OSC4 are connected to a 32768Hz crystal oscillator to form a real time clock for timing purposes and for f_{SUB} or f_{SL} . This 32768Hz crystal is disabled/enabled by configuration option.
VREF	ı	_	A/D reference voltage input pin
RES	ı	_	Schmitt Trigger reset input. Active low
VDD	_	_	Positive power supply
VSS	_	_	Negative power supply, ground
AVDD	_	_	Analog positive power supply
AVSS		_	Analog negative power supply, ground



The following tables depict the device dependent pins.

		Configuration	1 1			
Pin Name	I/O	Option	Description			
HT56R62						
VMAX	ı	_	IC maximum voltage, connect to VDD, VLCD1 or V1			
VLCD1/VLCD2/V1, C1, C2	_	_	LCD Voltage pump pins for C-type biasing. For R-type biasing only pin VLCD1 are used.			
SEG0~SEG4 SEG5/SDO SEG6/SDI/SDA SEG7/SCK/SCL SEG8/SCS SEG9/PCLK SEG10/PINT SEG11~SEG23	0 0 1/0 1/0 0 1/0 0	SIM PINT	SEG0~SEG23 are LCD driver outputs for LCD panel segments. SEG5 is pin-shared with the SPI bus data output line, SDO. SEG6 is pin-shared with the SPI bus data input line, SDI and the I²C Bus data line SDA. SEG7 is pin-shared with the SPI bus clock line, SCK and the I²C Bus clock line SCL. SEG8 is pin-shared with the SPI bus select line, SCS. SEG9 is pin-shared with the Peripheral Clock line, PCLK. SEG10 is pin-shared with the Peripheral Interrupt line, PINT. The SEG0~SEG15 lines can be can be chosen to be either segment drivers or CMOS outputs using control bits in the LCD control registers.			
COM0~COM2 COM3/SEG24	0	_	COM0~COM2 are the LCD common outputs. A bit in the LCD Control Register determines if pin COM3/SEG24 is configured as a segment driver or as a common output driver.			
HT56R65						
VMAX	ı	_	IC maximum voltage, connect to VDD, VLCD1 or V1			
VLCD1/VLCD2/V1, C1, C2	_	_	LCD Voltage pump pins for C-type biasing. For R-type biasing only pin VLCD1 are used.			
SEG0~SEG15 SEG16/SDO SEG17/SDI/SDA SEG18/SCK/SCL SEG19/SCS SEG20/PCLK SEG21/PINT SEG22~SEG39	0 0 1/0 1/0 0 1/0 0	SIM PINT	SEG0~SEG39 are LCD driver outputs for LCD panel segments. SEG16 is pin-shared with the SPI bus data output line, SDO. SEG17 is pin-shared with the SPI bus data input line, SDI and the I²C Bus data line SDA. SEG18 is pin-shared with the SPI bus clock line, SCK and the I²C Bus clock line SCL. SEG19 is pin-shared with the SPI bus select line, SCS. SEG20 is pin-shared with the Peripheral Clock line, PCLK. SEG21 is pin-shared with the Peripheral Interrupt line, PINT. The SEG0~SEG23 lines can be can be chosen to be either segment drivers or CMOS outputs using control bits in the LCD control registers.			
COM0~COM2 COM3/SEG40	0	_	COM0~COM2 are the LCD common outputs. A bit in the LCD Control Register determines if pin COM3/SEG40 is configured as a segment driver or as a common output driver.			
HT56R642						
VLCD	I	_	LCD bias pin - must less than or equal to VDD			
SEG0~SEG9 SEG10/SDO SEG11/SDI/SDA SEG12/SCK/SCL SEG13/SCS SEG14/PCLK SEG15/PINT COM15/SEG16~ COM8/SEG23	0 0 1/0 1/0 0 1/0 0	SIM PINT	SEG0~SEG15 are LCD driver outputs for LCD panel segments. SEG10 is pin-shared with the SPI bus data output line, SDO. SEG11 is pin-shared with the SPI bus data input line, SDI and the I²C Bus data line SDA. SEG12 is pin-shared with the SPI bus clock line, SCK and the I²C Bus clock line SCL. SEG13 is pin-shared with the SPI bus select line, SCS. SEG14 is pin-shared with the Peripheral Clock line, PCLK. SEG15 is pin-shared with the Peripheral Interrupt line, PINT. The SEG0~SEG15 lines can be can be chosen to be either segment drivers or CMOS outputs using control bits in the LCD control registers.			
COM0~COM7	0	_	COM0~COM7 are the LCD common outputs.			



Pin Name	I/O	Configuration Option	Description
HT56R644/HT56R6	54		
VLCD	I	_	LCD bias pin – must less than or equal to VDD
SEG0/SDO SEG1/SDI/SDA SEG2/SCK/SCL SEG3/SCS SEG4/PCLK SEG5/PINT SEG6~SEG31 COM15/SEG32~ COM8/SEG39	0 1/0 1/0 0 1/0 0 0	SIM PINT	SEG0~SEG31 are LCD driver outputs for LCD panel segments. SEG0 is pin-shared with the SPI bus data output line, SDO. SEG1 is pin-shared with the SPI bus data input line, SDI and the I²C Bus data line SDA. SEG2 is pin-shared with the SPI bus clock line, SCK and the I²C Bus clock line SCL. SEG3 is pin-shared with the SPI bus select line, SCS. SEG4 is pin-shared with the Peripheral Clock line, PCLK. SEG5 is pin-shared with the Peripheral Interrupt line, PINT. The SEG0~SEG23 lines can be can be chosen to be either segment drivers or CMOS outputs using control bits in the LCD control registers.
COM0~COM7	0	_	COM0~COM2 are the LCD common outputs.
HT56R656			
VLCD	Ι	_	LCD bias pin – must less than or equal to VDD
SEG0/SDO SEG1/SDI/SDA SEG2/SCK/SCL SEG3/SCS SEG4/PCLK SEG5/PINT SEG6~SEG47 COM15/SEG48~ COM8/SEG55	0 1/9 1/9 0 1/9 0 0	SIM PINT	SEG0~SEG47 are LCD driver outputs for LCD panel segments. SEG0 is pin-shared with the SPI bus data output line, SDO. SEG1 is pin-shared with the SPI bus data input line, SDI and the I²C Bus data line SDA. SEG2 is pin-shared with the SPI bus clock line, SCK and the I²C Bus clock line SCL. SEG3 is pin-shared with the SPI bus select line, SCS. SEG4 is pin-shared with the Peripheral Clock line, PCLK. SEG5 is pin-shared with the Peripheral Interrupt line, PINT. The SEG0~SEG23 lines can be can be chosen to be either segment drivers or CMOS outputs using control bits in the LCD control registers.
COM0~COM7	0	_	COM0~COM7 are the LCD common outputs.

Note: The Pin Description tables represents the largest package type available, therefore some of the pins and functions may not be available on smaller package types.

Absolute Maximum Ratings

Supply Voltage	V_{SS} -0.3V \sim V _{SS} +6.0V
Input Voltage	V_{SS} -0.3V \sim V _{DD} +0.3V
Storage Temperature	-50°C~125°C
Operating Temperature	
I _{OL} Total	80mA
I _{OH} Total	-80mA
Total Power Dissipation	500mW

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.



D.C. Characteristics

HT56R62/HT56R65

Ta=25°C

		Test Conditions					
Symbol	Parameter	V _{DD}	Conditions	Min.	Тур.	Max.	Unit
		₩ DD	f _{sys} =4MHz	2.2		5.5	V
V_{DD}	Operating Voltage	_	f _{SYS} =8MHz	3.0	_	5.5	V
			f _{SYS} =12MHz	4.5	_	5.5	V
AV _{DD}	Analog Operating Voltage	_	V _{REF} =AV _{DD}	3.0	T —	5.0	V
I _{DD1}	Operating Current	3V	No load, f _{sys} =f _M =1MHz	_	170	250	μΑ
וטטז	(Crystal OSC, RC OSC)	5V	TWO TOdd, ISYS=IM= TWITIZ	_	380	570	μΑ
I _{DD2}	Operating Current	3V	No load, f _{sys} =f _M =2MHz		240	360	μΑ
	(Crystal OSC, RC OSC)	5V	, , , ,		490	730	μA
I _{DD3}	Operating Current (Crystal OSC, RC OSC)	3V	No load, f _{SYS} =f _M =4MHz ^(note 5)		440	660	μA
	,	5V			900	1350	μA
I_{DD4}	Operating Current (EC Mode, Filter On)	3V 5V	No load, f _{SYS} =f _M =4MHz		380	570	μΑ
	, ,	3V			720 370	1080 550	μA μA
I_{DD5}	Operating Current (EC Mode, Filter Off)	5V	No load, f _{SYS} =f _M =4MHz		680	1020	μΑ
I _{DD6}	Operating Current (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _M =8MHz	_	1.8	2.7	mA
I _{DD7}	Operating Current (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _M =12MHz	_	2.6	4.0	mA
	Operating Current	3V		_	150	220	μA
I_{DD8}	(Slow Mode, f _M =4MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =500kHz	_	340	510	μA
	Operating Current	3V		_	180	270	μA
I_{DD9}	(Slow Mode, f _M =4MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =1MHz	_	400	600	μA
	Operating Current	3V		_	270	400	μA
I _{DD10}	(Slow Mode, f _M =4MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =2MHz	_	560	840	μA
	Operating Current	3V		_	240	360	μA
I _{DD11}	(Slow Mode, f _M =8MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =1MHz	_	540	810	μA
	Operating Current	3V		_	320	480	μA
I _{DD12}	(Slow Mode, f _M =8MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =2MHz	_	680	1020	μA
	Operating Current	3V		_	500	750	μA
I _{DD13}	(Slow Mode, f _M =8MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =4MHz	_	1000	1500	μΑ
1	Operating Current (fsys=32768Hz ^(note 1)	3V	No load, WDT off, LCD on ^(note 2) , R type, V _{LCD1} =V _{DD} ,	_	12	18	μΑ
I _{DD14}	or 32K_INT internal RC OSC)	5V	1/2 bias (R_{BIAS} =400k Ω)	_	20	30	μA
	Operating Current	3V	No load, WDT off, LCD on ^(note 2) ,	_	10	15	μΑ
I _{DD15}	(f _{SYS} =32768Hz ^(note 1) or 32K_INT internal RC OSC)	5V	R type, V _{LCD1} =V _{DD} , 1/3 bias (R _{BIAS} =600kΩ)	_	18	27	μΑ
lance	Operating Current (f _{SYS} =32768Hz ^(note 1)	3V	No load, WDT off, LCD on ^(note 2) ,	_	8	12	μΑ
I _{DD16}	or 32K_INT internal RC OSC)	5V	C type, 1/3 bias, V _{LCD1} =3V	_	12	18	μΑ



11.	8 12 6 10 0.2 0.3 1	12 18 9 15 1.0 2.0	μA μA μA μA μA
	12 6 10 0.2 0.3	18 9 15 1.0	μA μA μA
	6 10 0.2 0.3	9 15 1.0	μΑ
	10 0.2 0.3	15	μΑ
	0.2	1.0	<u> </u>
	0.3	_	μA
		2.0	
	1	0	μΑ
-	3	2 5	μΑ
.	1	2	μA
	-		μΑ
	1	2	μΑ
	3	5	μΑ
	10	15	μΑ
	18	27	μΑ
	10	15	μΑ
	16	24	μΑ
	150	250	μΑ
	350	550	μA
	_	0.3V _{DD}	V
DD	_	V _{DD}	V
	_	$0.4V_{DD}$	V
\rightarrow			V
-			V
\rightarrow			V
-			V
-			V
			V
_	12	_	mA
	25	_	mA
\rightarrow	-4 -8	<u> </u>	mA mA
\rightarrow	420		μΑ
_	700	_	μA
_	-160 -360	_	μA μA
	/ _{DD}	3 - 1 - 3 - 10 - 18 - 10 - 16 - 150 - 350	3 5 - 1 2 - 3 5 - 10 15 - 18 27 - 10 15 - 16 24 - 150 250 - 350 550 - 0.3V _{DD} - 0.4V _{DD} - V _{DD} - 0.4V _{DD} - V _{DD} - 0.4V _{DD} - 0.



Symbol	Parameter	Test Conditions		Min.	Typ	Max.	Unit
Syllibol	Farameter	V_{DD}	Conditions	IVIIII.	. Typ. Max. I	yp. Iviax.	Oilit
В	Pull-high Resistance for I/O Ports 3V 5V	3V		20	60	100	kΩ
R _{PH}		_	10	30	50	kΩ	

Note: 1. 32768Hz is in slow start mode (RTCC.4=1) for the D.C. current measurement.

- 2. LCD waveform is in Type A condition.
- 3. f_s is the internal clock for the Buzzer, RTC Interrupt, Time Base Interrupt and the WDT.
- 4. Both Timer/Event Counters are off. Timer filter is disabled for all test conditions.
- 5. All peripherals are in OFF condition if not mentioned at I_{DD} , I_{STB} tests.

HT56R642/HT56R644/HT56R654/HT56R656

Ta=25°C

Orang In a l	Barrenster		Test Conditions	NA!	T	Mari	
Symbol	Parameter	V _{DD}	Conditions	Min.	Тур.	Max.	Unit
			f _{SYS} =4MHz	2.2	_	5.5	V
V_{DD}	Operating Voltage	—	f _{SYS} =8MHz	3.0	_	5.5	V
			f _{SYS} =12MHz	4.5	_	5.5	V
AV_{DD}	Analog Operating Voltage	- V _{REF} =AV _{DD}		3.0	_	5.0	V
I_{DD1}	Operating Current	3V	No load, f _{sys} =f _M =1MHz	_	170	250	μΑ
וטטי	(Crystal OSC, RC OSC)	5V	140 load, 1575-IM- HWI 12		380	570	μΑ
I _{DD2}	Operating Current	3V	No load, f _{sys} =f _M =2MHz	_	240	360	μΑ
1002	(Crystal OSC, RC OSC)	5V	140 10dd, 1313-1M ZIWI1Z	_	490	730	μΑ
I _{DD3}	Operating Current	3V	No load, f _{SYS} =f _M =4MHz ^(note 5)	_	440	660	μΑ
1003	(Crystal OSC, RC OSC)	5V	110 10dd, 1313-1M -1M112		900	1350	μΑ
I _{DD4}	Operating Current	3V	No load, f _{SYS} =f _M =4MHz	_	380	570	μΑ
1004	(EC Mode, Filter On)	5V	110 10dd, 1313-1M -1M112	_	720	1080	μΑ
I _{DD5}	Operating Current	3V	No load, f _{sys} =f _M =4MHz	_	370	550	μA
1005	(EC Mode, Filter Off)	5V	110 10dd, 1313-1M -1M112	_	680	1020	μΑ
I _{DD6}	Operating Current (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _M =8MHz	_	1.8	2.7	mA
I _{DD7}	Operating Current (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _M =12MHz	_	2.6	4.0	mA
	Operating Current	3V		_	150	220	μA
I _{DD8}	(Slow Mode, f _M =4MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =500kHz	_	340	510	μΑ
	Operating Current (Slow Mode, f _M =4MHz)	3V	No load, f _{sys} =f _{sl ow} =1MHz	_	180	270	μΑ
I _{DD9}	(Crystal OSC, RC OSC)	5V	NO IOdu, ISYS=ISLOW- IIVITZ	_	400	600	μΑ
	Operating Current	3V	Na la ad f	_	270	400	μA
I _{DD10}	(Slow Mode, f _M =4MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =2MHz	_	560	840	μA
	Operating Current	3V	No local 6 6 4MHz	_	240	360	μA
I _{DD11}	(Slow Mode, f _M =8MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =1MHz	_	540	810	μΑ
	Operating Current	3V	No load f f =OM!-	_	320	480	μΑ
I _{DD12}	(Slow Mode, f _M =8MHz) (Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =2MHz	_	680	1020	μΑ
	Operating Current	3V	No load f f =4MU-	_	500	750	μΑ
-	Slow Mode, f _M =8MHz) Crystal OSC, RC OSC)	5V	No load, f _{SYS} =f _{SLOW} =4MHz		1000	1500	μA



Course			Test Conditions	NA".	т.		He !
Symbol	Parameter	V _{DD}	Conditions	Min.	Тур.	Max.	Unit
I _{DD14}	Operating Current (f _{SYS} =32768Hz ^(note 1)	3V	WDT off, LCD on ^(note 2) , 1/5 bias (R _{BIAS} =1MΩ),	_	8	12	μΑ
IDD14	or 32K internal RC OSC)	5V	V _{LCD} =V _{DD}	_	14	21	μΑ
I _{DD15}	Operating Current (f _{SYS} =32768Hz ^(note 1)	3V	3V WDT off, LCD on ^(note 2) , 1/4 bias (R _{BIAS} =800kΩ),		8	12	μΑ
10013	or 32K internal RC OSC)	5V	VLCD=VDD	_	14	21	μA
I _{DD16}	Operating Current (f _{SYS} =32768Hz ^(note 1)	3V	WDT off, LCD on ^(note 2) , 1/3 bias (R _{BIAS} =600kΩ),		10	15	μA
-5510	or 32K internal RC OSC)	5V	V _{LCD} =V _{DD}		16	24	μΑ
I _{DD17}	Operating Current (f _{SYS} =32768Hz ^(note 1)	3V	WDT off, LCD on ^(note 2) , 1/5 bias (R _{BIAS} =100kΩ),		30	45	μΑ
-5517	or 32K internal RC OSC)	5V	V _{LCD} =V _{DD}	_	50	75	μA
I _{DD18}	Operating Current (f _{SYS} =32768Hz ^(note 1)	3V	WDT off, LCD on ^(note 2) , 1/4 bias (R _{BIAS} =80kΩ),		40	60	μΑ
-5510	or 32K internal RC OSC)	5V	V _{LCD} =V _{DD}	_	60	90	μΑ
I _{DD19}	Operating Current (f _{SYS} =32768Hz ^(note 1)	3V	WDT off, LCD on ^(note 2) , 1/3 bias (R_{BIAS} =60k Ω),		50	75	μA
-5513	or 32K internal RC OSC)	5V	V _{LCD} =V _{DD}	_	80	120	μΑ
I _{DD20}	Operating Current (fsys=32768Hz ^(note 1)	3V	No load, LCD off, WDT off,		6	9	μΑ
-5520	or 32K internal RC OSC)	5V		_	10	15	μA
I _{STB1}	Standby Current (Sleep) (fsys, fsub, fs, flcd, fwdt=off)	3V 5V	No load, system HALT, LCD off, WDT off	_	0.2	1.0 2.0	μA μA
	Standby Current (Sleep)	3V	·		1	2.0	μΑ
I _{STB2}	(f _{SYS} , f _{LCD} , f _{WDT} =f _{SUB} =32768Hz ^(note 1) or 32K RC OSC)	5V	No load, system HALT, LCD off, WDT off	_	3	5	μA
	Standby Current (Idle) (fsys, fwpt=off; fs ^(note 3) =fsub=32768Hz ^(note 1)	3V	No load, system HALT, WDT off, LCD on ^(note 2) ,	_	6	10	μA
I _{STB3}	or 32K RC OSC)	5V	1/5 bias (R_{BIAS} =1M Ω), V_{LCD} = V_{DD}	_	10	15	μA
	Standby Current (Idle) (fsys, fwbt=off; fs ^(note 3) =fsub=32768Hz ^(note 1)	3V	No load, system HALT, WDT off, LCD on ^(note 2) ,	_	6	10	μA
I _{STB4}	or 32K RC OSC)	5V	1/4 bias (R_{BIAS} =800k Ω), V_{LCD} = V_{DD}	_	10	15	μA
	Standby Current (Idle) (fsys, fwpt=off; fs ^(note 3) =fsub=32768Hz ^(note 1)	3V	No load, system HALT, WDT off, LCD on ^(note 2) ,	_	8	12	μA
I _{STB5}	or 32K RC OSC)	5V	1/3 bias (R_{BIAS} =600k Ω), V_{LCD} = V_{DD}	_	12	16	μA
I _{STB6}	Standby Current (Idle) (fsys, fwpt=off; fs ^(note 3) =fsub=32768Hz ^(note 1)	3V	No load, system HALT, WDT off, LCD on ^(note 2) ,	_	26	39	μΑ
10180	or 32K RC OSC)	5V	1/5 bias (R_{BIAS} =100k Ω), V_{LCD} = V_{DD}		44	66	μΑ
I _{STB7}	Standby Current (Idle) (f _{SYS} , f _{WDT} =off; f _S ^(note 3) =f _{SUB} =32768Hz ^(note 1)	3V	No load, system HALT, WDT off, LCD on ^(note 2) ,	_	32	48	μA
·01B/	or 32K RC OSC)	5V	1/4 bias (R_{BIAS} =80k Ω), V_{LCD} = V_{DD}	_	54	81	μA
I _{STB8}	Standby Current (Idle) (fsys, fwbt=off; fs ^(note 3) =fsub=32768Hz ^(note 1)	3V	No load, system HALT, WDT off, LCD on ^(note 2) ,	_	44	66	μA
10188	or 32K RC OSC)	5V	1/3 bias (R_{BIAS} =60k Ω), V_{LCD} = V_{DD}	_	70	105	μΑ



Cumbal	Povemeter		Test Conditions	Min	Tim	Max.	Unit
Symbol	Parameter	V _{DD}	Conditions	Min.	Тур.	wax.	Unit
I _{STB9}	Standby Current (Idle) (f _{SYS} On, f _{SYS} =f _M =4MHz, f _{WDT} , f _{LCD} off;	3V	No load, system HALT, LCD off, WDT off,	_	150	250	μA
12189	fs ^(note 3) =f _{SUB} =32768Hz ^(note 1) or 32K RC OSC)	5V	SPI or I ² C On, PCLK On, PCLK=f _{SYS} /8	_	350	550	μΑ
V _{IL1}	Input Low Voltage for I/O Ports, TMR and INT	-	_	0	_	0.3V _{DD}	V
V _{IH1}	Input High Voltage for I/O Ports, TMR and INT	_	_	0.7V _{DD}	_	V _{DD}	V
V _{IL2}	Input Low Voltage (RES)	_	_	0	_	0.4V _{DD}	V
V_{IH2}	Input High Voltage (RES)	—	_	$0.9V_{DD}$	—	V_{DD}	V
			Configuration option: 4.2V	3.98	4.2	4.42	V
V_{LVR}	Low Voltage Reset Voltage	—	Configuration option: 3.15V	2.98	3.15	3.32	V
			Configuration option: 2.1V	1.98	2.1	2.22	V
			Configuration option: 2.2V	2.08	2.2	2.32	V
$V_{\text{\tiny LVD}}$	Low Voltage Detector Voltage	—	Configuration option: 3.3V	3.12	3.3	3.50	V
			Configuration option: 4.4V	4.12	4.4	4.70	V
I _{OL1}	I/O Port Sink Current (PA, PB, PD; SEG, COM Level or LED	3V	V _{OL} =0.1V _{DD}	6	12	_	mA
	Output)	5V		10	25	_	mA
I _{OH1}	I/O Port Source Current (PA, PB, PD; SEG, COM Level or LED	3V	V _{OH} =0.9V _{DD}	-2	-4	_	mA
-0111	Output)	5V	1011 010 188	-5	-8	_	mA
	LCD Common and Commont Current	3V	V _{OL} =0.1V _{DD}	210	420	_	μA
I _{OL2}	LCD Common and Segment Current	5V	V _{OL} =0.1V _{DD}	350	700	_	μA
la	LCD Common and Segment Current	3V	V _{OH} =0.9V _{DD}	-80	-160	_	μA
I _{OH2}	COD Common and Segment Current	5V	V _{OH} =0.9V _{DD}	-180	-360	_	μA
Rph	Pull-high Resistance for I/O Ports	3V	_	20	60	100	kΩ
INPH	i dii-iligii Nesistalice idi i/O FUIS	5V	_	10	30	50	kΩ

Note: 1. 32768Hz is slow start mode (RTCC.4=1) in D.C. current measurement.

- 2. LCD waveform is in Type A condition.
- 3. f_s is internal clock for Buzzer, RTC, Time base and WDT.
- 4. Timer0/1 off. Timer filter disable in all test condition.
- 5. All peripherals are in OFF condition if not mentioned at I_{DD} , I_{STB} tests.



A.C. Characteristics

Ta=25°C

Councile ad	Donomoton		Test Conditions	N/II:	T	Mari	I I m i t
Symbol	Parameter	V _{DD}	Conditions	Min.	Тур.	Max.	Unit
		2.2V~5.5V		32	_	4000	kHz
f _{SYS}	System Clock (Crystal OSC, RC OSC)	3.0V~5.5V	_	32	_	8000	kHz
	(Orysiai CCC, NC CCC)	4.5V~5.5V		32	_	12000	kHz
f _{RTCOSC}	RTC Frequency	_	_	_	32768	_	Hz
	T 1/0 5	2.2V~5.5V		0	_	4000	kHz
f _{TIMER}	Timer I/P Frequency (TMR0/TMR1)	3.0V~5.5V	_	0	_	8000	kHz
	(TWING/TWINT)	4.5V~5.5V			_	12000	kHz
f _{RC32K}	32K RC Oscillator	2.2V~5.5V	After Trim	28.8	32.0	35.2	kHz
t _{RES}	External Reset Low Pulse Width	_	_	1	_	_	μS
t _{LVR}	Low Voltage Reset Time	_	_	0.1	0.4	0.6	ms
t _{SST1}	System Start-up Timer Period	_	Power-on	<u> </u>	1024	_	t _{SYS} *
t _{SST2}	System Start-up Timer Period for XTAL or RTC oscillator	_	Wake-up from Power Down Mode	_	1024	_	tsys*
t _{SST3}	System Start-up Timer Period for External RC or External Clock	_	Wake-up from Power Down Mode	_	1	2	t _{SYS} *
t _{INT}	Interrupt Pulse Width	_	_	1			μS

Note: $t_{SYS}=1/f_{SYS1}$ or $1/f_{SYS2}$

ADC Characteristics

HT56R62/HT56R65

Ta=25°C

Cumbal	Parameter		Test Conditions	B/I:m	Tim	Mey	Unit
Symbol	Parameter	V _{DD}	Conditions	Min.	Тур.	Max.	Unit
V _{AD}	A/D Input Voltage		52QFP, 64LQFP	0	_	AV _{DD}	V
VAD	A/D Input voltage	_	100QFP	0	_	V _{REF}	V
V_{REF}	A/D Input Reference Voltage Range	_	AV _{DD} =5V	1.6	_	AV _{DD} +0.1	V
DNL	ADC Differential Non-Linearity	_	AV _{DD} =5V, V _{REF} =AV _{DD} , t _{AD} =0.5µs	-2	_	2	LSB
INL	ADC Integral Non-Linearity	_	AV _{DD} =5V, V _{REF} =AV _{DD} , t _{AD} =0.5µs	-4	_	4	LSB
	Additional Power Consumption if A/D	3V		_	0.50	0.75	mA
I _{ADC}	Converter is Used	5V	_	_	1.0	1.5	mA
t _{AD}	A/D Clock Period	_	_	0.5	_	_	μs
t _{ADC}	A/D Conversion Time		_	_	16	_	t _{AD}

HT56R642/HT56R644/HT56R654/HT56R656

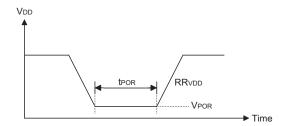
Ta=25°C

Cumbal	Parameter		Test Conditions	Min.	Tim	Max.	Unit
Symbol	Parameter	V _{DD}	Conditions	IVIII.	Тур.	IVIAX.	Unit
V _{AD}	A/D Input Voltage		128QFP	0	_	AV_{DD}	V
VAD	A/D Input voltage		100QFP	0	_	V_{REF}	V
V _{REF}	A/D Input Reference Voltage Range	_	AV _{DD} =5V	1.6	_	AV _{DD} +0.1	V
DNL	ADC Differential Non-Linearity	_	AV _{DD} =5V, V _{REF} =AV _{DD} , t _{AD} =0.5µs	-2	_	2	LSB
INL	ADC Integral Non-Linearity	_	AV _{DD} =5V, V _{REF} =AV _{DD} , t _{AD} =0.5µs	-4	_	4	LSB
	Additional Power Consumption if A/D	3V		_	0.50	0.75	mA
I _{ADC}	Converter is Used	5V	_	_	1.0	1.5	mA
t _{AD}	A/D Clock Period	_	_	0.5	_	_	μs
t _{ADC}	A/D Conversion Time	_	_	_	16	_	t _{AD}

Power-on Reset Characteristics

Ta=25°C

Cumbal	Parameter		Test Conditions	Min.	Turn	Max.	l lmi4
Symbol			Conditions	iviin.	Тур.	wax.	Unit
V _{POR}	V _{DD} Start Voltage to Ensure Power-on Reset	_	_	_	_	100	mV
R _{POR}	V _{DD} Rise Slew Rate to Ensure Power-on Reset	_	_	0.035	_	_	V/ms
t _{POR}	Minimum Time to Ensure Power-on Reset	_	V _{POR} =0.1V	1	_	_	ms





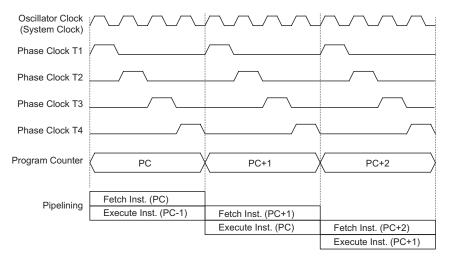
System Architecture

A key factor in the high-performance features of the Holtek range of microcontrollers is attributed to their internal system architecture. The range of devices take advantage of the usual features found within RISC microcontrollers providing increased speed of operation and enhanced performance. The pipelining scheme is implemented in such a way that instruction fetching and instruction execution are overlapped, hence instructions are effectively executed in one cycle, with the exception of branch or call instructions. An 8-bit wide ALU is used in practically all instruction set operations, which carries out arithmetic operations, logic operations, rotation, increment, decrement, branch decisions, etc. The internal data path is simplified by moving data through the Accumulator and the ALU. Certain internal registers are implemented in the Data Memory and can be directly or indirectly addressed. The simple addressing methods of these registers along with additional architectural features ensure that a minimum of external components is required to provide a functional I/O and A/D control system with maximum reliability and flexibility. This makes the device suitable for low-cost, high-volume production for controller applications.

Clocking and Pipelining

The main system clock, derived from either a Crystal/Resonator or RC oscillator is subdivided into four internally generated non-overlapping clocks, T1~T4. The Program Counter is incremented at the beginning of the T1 clock during which time a new instruction is fetched. The remaining T2~T4 clocks carry out the decoding and execution functions. In this way, one T1~T4 clock cycle forms one instruction cycle. Although the fetching and execution of instructions takes place in consecutive instruction cycles, the pipelining structure of the microcontroller ensures that instructions are effectively executed in one instruction cycle. The exception to this are instructions where the contents of the Program Counter are changed, such as subroutine calls or jumps, in which case the instruction will take one more instruction cycle to execute.

When the RC oscillator is used, OSC2 is free for use as a T1 phase clock synchronizing pin. This T1 phase clock has a frequency of $f_{SYS}/4$ with a 1:3 high/low duty cycle.



System Clocking and Pipelining



For instructions involving branches, such as jump or call instructions, two machine cycles are required to complete instruction execution. An extra cycle is required as the program takes one cycle to first obtain the actual jump or call address and then another cycle to actually execute the branch. The requirement for this extra cycle should be taken into account by programmers in timing sensitive applications.

1	N	MOV A,[12H]	Fetch Inst. 1	Execute Inst. 1			
2	(CALL DELAY		Fetch Inst. 2	Execute Inst. 2		_
3	(CPL [12H]			Fetch Inst. 3	Flush Pipeline	
4	:					Fetch Inst. 6	Execute Inst. 6
5	:						Fetch Inst. 7
6	DELAY: N	NOP					

Instruction Fetching

Program Counter

During program execution, the Program Counter is used to keep track of the address of the next instruction to be executed. It is automatically incremented by one each time an instruction is executed except for instructions, such as "JMP" or "CALL" that demand a jump to a non-consecutive Program Memory address. It must be noted that only the lower 8 bits, known as the Program Counter Low Register, are directly addressable.

When executing instructions requiring jumps to non-consecutive addresses such as a jump instruction, a subroutine call, interrupt or reset, etc., the microcontroller manages program control by loading the required address into the Program Counter. For conditional skip instructions, once the condition has been met, the next instruction, which has already been fetched during the present instruction execution, is discarded and a dummy cycle takes its place while the correct instruction is obtained.

The lower byte of the Program Counter, known as the Program Counter Low register or PCL, is available for program control and is a readable and writable register. By transferring data directly into this register, a short program jump can be executed directly, however, as only this low byte is available for manipulation, the jumps are limited to the present page of memory, that is 256 locations. When such program jumps are executed it should also be noted that a dummy cycle will be inserted.

The lower byte of the Program Counter is fully accessible under program control. Manipulating the PCL might cause program branching, so an extra cycle is needed to pre-fetch. Further information on the PCL register can be found in the Special Function Register section.



Mode					Pro	gram	Count	ter Bit	s				
Wode	b12	b11	b10	b9	b8	b7	b6	b5	b4	b3	b2	b1	b0
Initial Reset	0	0	0	0	0	0	0	0	0	0	0	0	0
External Interrupt 0	0	0	0	0	0	0	0	0	0	0	1	0	0
External Interrupt 1	0	0	0	0	0	0	0	0	0	1	0	0	0
Timer/Event Counter 0 Overflow	0	0	0	0	0	0	0	0	0	1	1	0	0
Timer/Event Counter 1 Overflow	0	0	0	0	0	0	0	0	1	0	0	0	0
SPI/I ² C Interrupt	0	0	0	0	0	0	0	0	1	0	1	0	0
Multi-Function Interrupt	0	0	0	0	0	0	0	0	1	1	0	0	0
Skip					Pro	ogram	Coun	ter + 2					
Loading PCL	PC12	PC11	PC10	PC9	PC8	@7	@6	@5	@4	@3	@2	@1	@0
Jump, Call Branch	#12	#11	#10	#9	#8	#7	#6	#5	#4	#3	#2	#1	#0
Return from Subroutine	S12	S11	S10	S9	S8	S7	S6	S5	S4	S3	S2	S1	S0

Program Counter

Note: PC12~PC8: Current Program Counter bits @7~@0: PCL bits

#12~#0: Instruction code address bits S12~S0: Stack register bits

For the HT56R65/HT56R654/HT56R656, the Program Counter is 13 bits wide, i.e. from b12~b0.

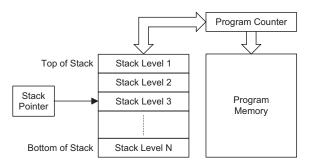
For the HT56R642/HT56R644, the Program Counter is 12 bits wide, i.e. from b11~b0, therefore the b12 column in the table is not applicable.

For the HT56R62, the Program Counter is 11 bits wide, i.e. from b10~b0, therefore the b12 and b11 columns in the table are not applicable.

Stack

This is a special part of the memory which is used to save the contents of the Program Counter only. The stack has multiple levels depending upon the device and is neither part of the data nor part of the program space, and is neither readable nor writeable. The activated level is indexed by the Stack Pointer, SP, and is neither readable nor writeable. At a subroutine call or interrupt acknowledge signal, the contents of the Program Counter are pushed onto the stack. At the end of a subroutine or an interrupt routine, signaled by a return instruction, RET or RETI, the Program Counter is restored to its previous value from the stack. After a device reset, the Stack Pointer will point to the top of the stack.

If the stack is full and an enabled interrupt takes place, the interrupt request flag will be recorded but the acknowledge signal will be inhibited. When the Stack Pointer is decremented, by RET or RETI, the interrupt will be serviced. This feature prevents stack overflow allowing the programmer to use the structure more easily. However, when the stack is full, a CALL subroutine instruction can still be executed which will result in a stack overflow. Precautions should be taken to avoid such cases which might cause unpredictable program branching.



Note: 6 levels of stack are available for the HT56R62, 8 levels of stack are available for the HT56R642/ HT56R644 and 12 levels of stack are available for the HT56R65/HT56R654/ HT56R656.

Arithmetic and Logic Unit - ALU

The arithmetic-logic unit or ALU is a critical area of the microcontroller that carries out arithmetic and logic operations of the instruction set. Connected to the main microcontroller data bus, the ALU receives related instruction codes and performs the required arithmetic or logical operations after which the result will be placed in the specified register. As these ALU calculation or operations may result in carry, borrow or other status changes, the status register will be correspondingly updated to reflect these changes. The ALU supports the following functions:

- Arithmetic operations: ADD, ADDM, ADC, ADCM, SUB, SUBM, SBC, SBCM, DAA
- · Logic operations: AND, OR, XOR, ANDM, ORM, XORM, CPL, CPLA
- Rotation RRA, RR, RRCA, RRC, RLA, RL, RLCA, RLC
- · Increment and Decrement INCA, INC, DECA, DEC
- Branch decision, JMP, SZ, SZA, SNZ, SIZ, SDZ, SIZA, SDZA, CALL, RET, RETI

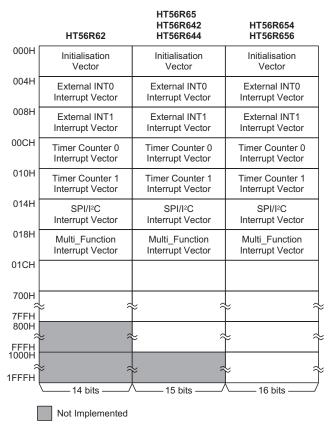


Program Memory

The Program Memory is the location where the user code or program is stored. For these device the Program Memory is an OTP type, which means it can be programmed only one time. By using the appropriate programming tools, this OTP memory device offer users the flexibility to conveniently debug and develop their applications while also offering a means of field programming.

Structure

The Program Memory has a capacity of $2K\times14$ bits to $8K\times16$ bits. The Program Memory is addressed by the Program Counter and also contains data, table information and interrupt entries. Table data, which can be setup in any location within the Program Memory, is addressed by a separate table pointer register.



Program Memory Structure



Special Vectors

Within the Program Memory, certain locations are reserved for special usage such as reset and interrupts.

· Location 000H

This vector is reserved for use by the device reset for program initialisation. After a device reset is initiated, the program will jump to this location and begin execution.

· Location 004H

This vector is used by the external interrupt 0. If the external interrupt pin receives an active edge, the program will jump to this location and begin execution if the external interrupt is enabled and the stack is not full.

· Location 008H

This vector is used by the external interrupt 1. If the external interrupt pin receives an active edge, the program will jump to this location and begin execution if the external interrupt is enabled and the stack is not full.

· Location 00CH

This internal vector is used by the Timer/Event Counter 0. If a Timer/Event Counter 0 overflow occurs, the program will jump to this location and begin execution if the timer/event counter interrupt is enabled and the stack is not full.

· Location 010H

This internal vector is used by the Timer/Event Counter 1. If a Timer/Event Counter 1 overflow occurs, the program will jump to this location and begin execution if the timer/event counter interrupt is enabled and the stack is not full.

· Location 014H

This internal vector is used by the SPI/I²C interrupt. When either an SPI or I²C bus, dependent upon which one is selected, requires data transfer, the program will jump to this location and begin execution if the SPI/I²C interrupt is enabled and the stack is not full.

· Location 018H

This internal vector is used by the Multi-function Interrupt. The Multi-function Interrupt vector is shared by several internal functions such as a Time Base overflow, a Real Time Clock overflow, an A/D converter conversion completion, an active edge appearing on the External Peripheral interrupt pin or a Timer/Event Counter 2 overflow. The program will jump to this location and begin execution if the relevant interrupt is enabled and the stack is not full.

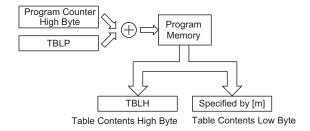


Look-up Table

Any location within the Program Memory can be defined as a look-up table where programmers can store fixed data. To use the look-up table, the table pointer must first be setup by placing the lower order address of the look up data to be retrieved in the table pointer register, TBLP. This register defines the lower 8-bit address of the look-up table.

After setting up the table pointer, the table data can be retrieved from the current Program Memory page or last Program Memory page using the "TABRDC [m]" or "TABRDL [m]" instructions, respectively. When these instructions are executed, the lower order table byte from the Program Memory will be transferred to the user defined Data Memory register [m] as specified in the instruction. The higher order table data byte from the Program Memory will be transferred to the TBLH special register. Any unused bits in this transferred higher order byte will be read as "0".

The following diagram illustrates the addressing/data flow of the look-up table:



Instruction		Table Location Bits												
instruction	b12	b11	b10	b9	b8	b7	b6	b5	b4	b3	b2	b1	b0	
TABRDC [m]	PC12	PC11	PC10	PC9	PC8	@7	@6	@5	@4	@3	@2	@1	@0	
TABRDL [m]	1	1	1	1	1	@7	@6	@5	@4	@3	@2	@1	@0	

Table Location

Note: PC12~PC8: Current program counter bits

@7~@0: Table Pointer TBLP bits

For the HT56R65/HT56R654/HT56R656, the Table address location is 13 bits, i.e. from $b12\sim b0$.

For the HT56R642/HT56R644, the Table address location is 12 bits, i.e. from b11~b0.

For the HT56R62, the Table address location is 11 bits, i.e. from b10~b0.

Table Program Example

The following example shows how the table pointer and table data is defined and retrieved from the microcontroller. This example uses raw table data located in the last page which is stored there using the ORG statement. The value at this ORG statement is "700H" which refers to the start address of the last page within the 2K Program Memory of the HT56R62. The table pointer is setup here to have an initial value of "06H". This will ensure that the first data read from the data table will be at the Program Memory address "706H" or 6 locations after the start of the last page. Note that the value for the table pointer is referenced to the first address of the present page if the "TABRDC [m]" instruction is being used. The high byte of the table data which in this case is equal to zero will be transferred to the TBLH register automatically when the "TABRDL [m]" instruction is executed.

Because the TBLH register is a read-only register and cannot be restored, care should be taken to ensure its protection if both the main routine and Interrupt Service Routine use table read instructions. If using the table read instructions, the Interrupt Service Routines may change the value of the TBLH and subsequently cause errors if used again by the main routine. As a rule it is recommended that simultaneous use of the table read instructions should be avoided. However, in situations where simultaneous use cannot be avoided, the interrupts should be disabled prior to the execution of any main routine table-read instructions. Note that all table related instructions require two instruction cycles to complete their operation.

```
; temporary register #1
tempreal
            db?
            db ? ; temporary register #2
temprea2
     :
mov a,06h
                   ; initialise table pointer - note that this address is referenced
mov tblp,a
                   ; to the last page or present page
     :
tabrdl
                   ; transfers value in table referenced by table pointer to tempregl
                   ; data at prog. memory address "706H" transferred to tempreg1 and TBLH
dec tblp
                   ; reduce value of table pointer by one
tabrdl tempreq2 ; transfers value in table referenced by table pointer to tempreq2
                   ; data at prog.memory address "705H" transferred to tempreg2 and TBLH
                   ; in this example the data "1AH" is transferred to
                   ; tempreg1 and data "OFH" to register tempreg2
    700h
                   ; sets initial address of last page
     00Ah, 00Bh, 00Ch, 00Dh, 00Eh, 00Fh, 01Ah, 01Bh
```



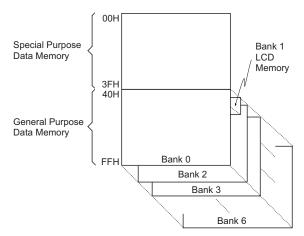
Data Memory

The Data Memory is a volatile area of 8-bit wide RAM internal memory and is the location where temporary information is stored. Divided into three sections, the first of these is an area of RAM where special function registers are located. These registers have fixed locations and are necessary for correct operation of the device. Many of these registers can be read from and written to directly under program control, however, some remain protected from user manipulation. The second area of Data Memory is reserved for general purpose use. All locations within this area are read and write accessible under program control. The third area is reserved for the LCD Memory. This special area of Data Memory is mapped directly to the LCD display so data written into this memory area will directly affect the displayed data. The addresses of the LCD Memory area overlap those in the General Purpose Data Memory area. Switching between the different Data Memory banks is achieved by setting the Bank Pointer to the correct value.

Structure

The Data Memory is subdivided into several banks, all of which are implemented in 8-bit wide RAM. The Data Memory located in Bank 0 is subdivided into two sections, the Special Purpose Data Memory and the General Purpose Data Memory.

The start address of the Data Memory for all devices is the address "00H". Registers which are common to all microcontrollers, such as ACC, PCL, etc., have the same Data Memory address. The LCD Memory is mapped into Bank. Banks 2 to 6 contain only General Purpose Data Memory for those devices with larger Data Memory capacities. As the Special Purpose Data Memory registers are mapped into all bank areas, they can subsequently be accessed from any bank location.



Data Memory Structure

General Purpose Data Memory

All microcontroller programs require an area of read/write memory where temporary data can be stored and retrieved for use later. It is this area of RAM memory that is known as General Purpose Data Memory. This area of Data Memory is fully accessible by the user program for both read and write operations. By using the "SET [m].i" and "CLR [m].i" instructions individual bits can be set or reset under program control giving the user a large range of flexibility for bit manipulation in the Data Memory. For devices with larger Data Memory capacities, the General Purpose Data Memory, in addition to being located in Bank 0, is also stored in Banks 2 to 6, the actual number of banks present depends upon the device selected.

Special Purpose Data Memory

This area of Data Memory is where registers, necessary for the correct operation of the microcontroller, are stored. Most of the registers are both read and write type but some are protected and are read only, the details of which are located under the relevant Special Function Register section. Note that for locations that are unused, any read instruction to these addresses will return the value "00H". The Special Function registers are mapped into all banks and can therefore be accessed from any bank location.

Bank Nu	mber		0	1	2	3	4	5	6
	SPDM	SA	С	ommon 00	Н	х	х	х	х
LITECDES 130 Dutos	SPDIVI	EA	С	ommon 3F	H	х	Х	х	х
HT56R62–128 Bytes	CDDM	SA	40H	40H	40H	х	Х	х	х
	GPDM	EA	7FH	58H	7FH	х	х	х	х
	CDDM	SA		Comm	on 00H		х	х	х
LITECDOE EZO D. 400	SPDM	EA	Common 3FH				х	х	х
HT56R65–576 Bytes	ODDM	SA	40H	40H	40H	40H	Х	х	х
	GPDM	EA	FFH	68H	FFH	FFH	х	х	х
	ODDM	SA	С	ommon 00)H	х	х	х	
LITEODOAO, OOA D. A.	SPDM	EA	С	ommon 3F	H	Х	Х	х	х
HT56R642-384 Bytes	GPDM	SA	40H	40H	40H	х	х	х	х
	GPDIVI	EA	FFH	5FH	FFH	Х	Х	х	х
	ODDM	SA		Comm	on 00H	х	х	х	
UT500044 570 D. 4	SPDM	EA		Comm	on 3FH		х	х	х
HT56R644–576 Bytes	ODDM	SA	40H	40H	40H	40H	Х	х	х
	GPDM	EA	FFH	7FH	FFH	FFH	х	х	х
	00014	SA			С	ommon 00	H		
LITEODOS 4 4450 D. 4	SPDM	EA			С	ommon 3F	H		
HT56R654–1152 Bytes	ODDM	SA	40H	40H	40H	40H	40H	40H	40H
	GPDM	EA	FFH	7FH	FFH	FFH	FFH	FFH	FFH
HT56R656–1152 Bytes –	00014	SA			С	ommon 00	H	•	
	SPDM	EA			С	ommon 3F	H		
	00014	SA	40H	40H	40H	40H	40H	40H	40H
	GPDM	EA	FFH	9FH	FFH	FFH	FFH	FFH	FFH

Data Memory Content

Note: SPDM: Special Purpose Data Memory GPDM: General Purpose Data Memory

> SA: Start Address EA: End Address x: Not implemented



	HT56R62	HT56R65	HT56R642	HT56R644	HT56R654 HT56R656
00H	IAR0	IAR0	IAR0	IAR0	IAR0
01H	MP0	MP0	MP0	MP0	MP0
02H	IAR1	IAR1	IAR1	IAR1	IAR1
03H	MP1	MP1	MP1	MP1	MP1
04H	BP	BP	BP	BP	BP
05H	ACC	ACC	ACC	ACC	ACC
06H	PCL	PCL	PCL	PCL	PCL
07H	TBLP	TBLP	TBLP	TBLP	TBLP
08H	TBLH	TBLH	TBLH	TBLH	TBLH
09H	RTCC	RTCC	RTCC	RTCC	RTCC
0AH	STATUS	STATUS	STATUS	STATUS	STATUS
0BH	INTC0	INTC0	INTC0	INTC0	INTC0
0CH					
0DH	TMR0	TMR0	TMR0	TMR0	TMR0
0EH	TMR0C	TMR0C	TMR0C	TMR0C	TMR0C
0FH		TMR1H	TMR1H	TMR1H	TMR1H
10H		TMR1L	TMR1L	TMR1L	TMR1L
11H	D^	TMR1C	TMR1C	TMR1C	TMR1C
12H	PA	PA	PA	PA	PA
13H	PAC PB	PAC PB	PAC	PAC PB	PAC PB
14H	PBC	PBC PB	PB PBC	<u> </u>	PBC
15H 16H	PBC	PBC	PBC	PBC	PBC
10H					
17 H	PD	PD	PD	PD	PD
19H	PDC	PDC	PDC	PDC	PDC
1AH	PWM0L	PWM0L	PWM0L	PWM0L	PWM0L
1BH	PWM0H	PWM0H	PWM0H	PWM0H	PWM0H
1CH	PWM1L	PWM1L	PWM1L	PWM1L	PWM1L
1DH	PWM1H	PWM1H	PWM1H	PWM1H	PWM1H
1EH	INTC1	INTC1	INTC1	INTC1	INTC1
1FH	114101	INTO	INTOT	INTOT	INTOT
20H	PWM2L	PWM2L	PWM2L	PWM2L	PWM2L
21H	PWM2H	PWM2H	PWM2H	PWM2H	PWM2H
22H	1 77171211	PWM3L	PWM3L	PWM3L	PWM3L
23H		PWM3H	PWM3H	PWM3H	PWM3H
24H	ADRL	ADRL	ADRL	ADRL	ADRL
25H	ADRH	ADRH	ADRH	ADRH	ADRH
26H	ADCR	ADCR	ADCR	ADCR	ADCR
27H	ACSR	ACSR	ACSR	ACSR	ACSR
28H	CLKMOD	CLKMOD	CLKMOD	CLKMOD	CLKMOD
29H	PAWU	PAWU	PAWU	PAWU	PAWU
2AH	PAPU	PAPU	PAPU	PAPU	PAPU
2BH	PBPU	PBPU	PBPU	PBPU	PBPU
2CH					
2DH	PDPU	PDPU	PDPU	PDPU	PDPU
2EH	INTEDGE	INTEDGE	INTEDGE	INTEDGE	INTEDGE
2FH			LEDCTRL	LEDCTRL	LEDCTRL
30H	LCDCTRL	LCDCTRL	LCDCTRL	LCDCTRL	LCDCTRL
31H	LCDOUT1	LCDOUT1	LCDOUT1	LCDOUT1	LCDOUT1
32H	LCDOUT2	LCDOUT2		LCDOUT2	LCDOUT2
33H	MISC	MISC	MISC	MISC	MISC
34H	MFIC	MFIC0	MFIC	MFIC	MFIC0
35H		MFIC1			MFIC1
36H	SIMCTL0	SIMCTL0	SIMCTL0	SIMCTL0	SIMCTL0
37H	SIMCTL1	SIMCTL1	SIMCTL1	SIMCTL1	SIMCTL1
38H	SIMDR	SIMDR	SIMDR	SIMDR	SIMDR
39H	SIMAR/SIMCTL2	SIMAR/SIMCTL2	SIMAR/SIMCTL2	SIMAR/SIMCTL2	SIMAR/SIMCTL2
3AH	TMR1	TMR2			TMR2
3BH	TMR1C	TMR2C			TMR2C
3CH					
3DH					
3EH					
3FH					

: Unused Read as "00"

Special Purpose Data Memory



Display Memory

The data to be displayed on the LCD or LED display is stored in an area of fully accessible Data Memory. By writing to this area of RAM, the display output can be directly controlled by the application program. As this Memory exists in Bank 1, but have addresses which map into the General Purpose Data Memory, it is necessary to first ensure that the Bank Pointer is set to the value 01H before accessing the Display Memory. The Display Memory can only be accessed indirectly using the Memory Pointer MP1 and the indirect addressing register IAR1. When the Bank Pointer is set to Bank 1 to access the Display Memory, if any addresses with a value less than 40H are read, the Special Purpose Memory in Bank 0 will be accessed. Also, if the Bank Pointer is set to Bank 1, if any addresses higher than the last address in Bank 1 are read, then a value of 00H will be returned.

Special Function Registers

To ensure successful operation of the microcontroller, certain internal registers are implemented in the Data Memory area. These registers ensure correct operation of internal functions such as timers, interrupts, etc., as well as external functions such as I/O data control and A/D converter operation. The location of these registers within the Data Memory begins at the address 00H. Any unused Data Memory locations between these special function registers and the point where the General Purpose Memory begins is reserved for future expansion purposes, attempting to read data from these locations will return a value of 00H.

Indirect Addressing Registers - IAR0, IAR1

The Indirect Addressing Registers, IAR0 and IAR1, although having their locations in normal RAM register space, do not actually physically exist as normal registers. The method of indirect addressing for RAM data manipulation uses these Indirect Addressing Registers and Memory Pointers, in contrast to direct memory addressing, where the actual memory address is specified. Actions on the IAR0 and IAR1 registers will result in no actual read or write operation to these registers but rather to the memory location specified by their corresponding Memory Pointers, MP0 or MP1. Acting as a pair, IAR0 and MP0 can together access data from Bank 0 while the IAR1 and MP1 register pair can access data from any bank. As the Indirect Addressing Registers are not physically implemented, reading the Indirect Addressing Registers indirectly will return a result of "00H" and writing to the registers indirectly will result in no operation.



Memory Pointers - MP0, MP1

Two Memory Pointers, known as MP0 and MP1 are provided. These Memory Pointers are physically implemented in the Data Memory and can be manipulated in the same way as normal registers providing a convenient way with which to address and track data. When any operation to the relevant Indirect Addressing Registers is carried out, the actual address that the microcontroller is directed to, is the address specified by the related Memory Pointer. MP0, together with Indirect Addressing Register, IAR0, are used to access data from Bank 0, while MP1 and IAR1 are used to access data from all banks.

The following example shows how to clear a section of four RAM locations already defined as locations adres1 to adres4.

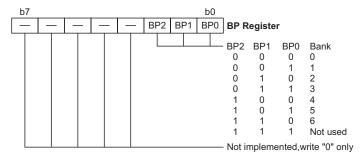
```
data .section 'data'
adres1 db?
adres2
       db?
Adres3 db?
adres4 db?
block
       db?
code .section at 0 'code'
org 00h
start:
    mov a,04h
                           ; setup size of block
    mov block,a
    mov a, offset adres1
                           ; Accumulator loaded with first RAM address
    mov mp0,a
                            ; setup memory pointer with first RAM address
loop:
    clr IAR0
                            ; clear the data at address defined by MPO
     inc mp0
                            ; increment memory pointer
    sdz block
                             ; check if last memory location has been cleared
     jmp loop
continue:
```

The important point to note here is that in the example shown above, no reference is made to specific RAM addresses.

Bank Pointer - BP

The Data Memory is divided several banks, the total number of which depends upon the device chosen. Selecting the required Data Memory area is achieved using the Bank Pointer. If data in Bank 0 is to be accessed, then the BP register must be loaded with the value 00H, while if data in Bank 1 is to be accessed, then the BP register must be loaded with the value 01H, and so on.

The Data Memory is initialised to Bank 0 after a reset, except for the WDT time-out reset in the Power Down Mode, in which case, the Data Memory bank remains unaffected. It should be noted that the Special Function Data Memory is not affected by the bank selection, which means that the Special Function Registers can be accessed from within any bank. Directly addressing the Data Memory will always result in Bank 0 being accessed irrespective of the value of the Bank Pointer. Accessing data from banks other than Bank 0 must be implemented using Indirect addressing.



Bank Pointer

Accumulator - ACC

The Accumulator is central to the operation of any microcontroller and is closely related with operations carried out by the ALU. The Accumulator is the place where all intermediate results from the ALU are stored. Without the Accumulator it would be necessary to write the result of each calculation or logical operation such as addition, subtraction, shift, etc., to the Data Memory resulting in higher programming and timing overheads. Data transfer operations usually involve the temporary storage function of the Accumulator; for example, when transferring data between one user defined register and another, it is necessary to do this by passing the data through the Accumulator as no direct transfer between two registers is permitted.

Program Counter Low Register - PCL

To provide additional program control functions, the low byte of the Program Counter is made accessible to programmers by locating it within the Special Purpose area of the Data Memory. By manipulating this register, direct jumps to other program locations are easily implemented. Loading a value directly into this PCL register will cause a jump to the specified Program Memory location, however, as the register is only 8-bit wide, only jumps within the current Program Memory page are permitted. When such operations are used, note that a dummy cycle will be inserted.



Look-up Table Registers - TBLP, TBLH

These two special function registers are used to control operation of the look-up table which is stored in the Program Memory. TBLP is the table pointer and indicates the location where the table data is located. Its value must be setup before any table read commands are executed. Its value can be changed, for example using the "INC" or "DEC" instructions, allowing for easy table data pointing and reading. TBLH is the location where the high order byte of the table data is stored after a table read data instruction has been executed. Note that the lower order table data byte is transferred to a user defined location.

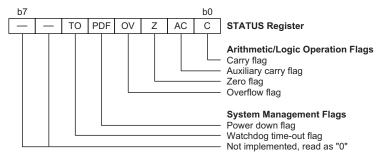
Status Register - STATUS

This 8-bit register contains the zero flag (Z), carry flag (C), auxiliary carry flag (AC), overflow flag (OV), power down flag (PDF), and watchdog time-out flag (TO). These arithmetic/logical operation and system management flags are used to record the status and operation of the microcontroller.

With the exception of the TO and PDF flags, bits in the status register can be altered by instructions like most other registers. Any data written into the status register will not change the TO or PDF flag. In addition, operations related to the status register may give different results due to the different instruction operations. The TO flag can be affected only by a system power-up, a WDT time-out or by executing the "CLR WDT" or "HALT" instruction. The PDF flag is affected only by executing the "HALT" or "CLR WDT" instruction or during a system power-up.

The Z, OV, AC and C flags generally reflect the status of the latest operations.

- C is set if an operation results in a carry during an addition operation or if a borrow does not take place during a subtraction operation; otherwise C is cleared. C is also affected by a rotate through carry instruction.
- AC is set if an operation results in a carry out of the low nibbles in addition, or no borrow from the high nibble into the low nibble in subtraction; otherwise AC is cleared.
- **Z** is set if the result of an arithmetic or logical operation is zero; otherwise Z is cleared.
- **OV** is set if an operation results in a carry into the highest-order bit but not a carry out of the highest-order bit, or vice versa; otherwise OV is cleared.
- **PDF** is cleared by a system power-up or executing the "CLR WDT" instruction. PDF is set by executing the "HALT" instruction.
- **TO** is cleared by a system power-up or executing the "CLR WDT" or "HALT" instruction. TO is set by a WDT time-out.



Status Register

In addition, on entering an interrupt sequence or executing a subroutine call, the status register will not be pushed onto the stack automatically. If the contents of the status registers are important and if the subroutine can corrupt the status register, precautions must be taken to correctly save it.

Interrupt Control Registers

These 8-bit registers, INTC0, INTC1, MFIC, MFIC0, MFIC1 and INTEDGE, control the operation of the device interrupt functions. By setting various bits within these registers using standard bit manipulation instructions, the enable/disable function of each interrupt can be independently controlled. A master interrupt bit within the INTC0 register, the EMI bit, acts like a global enable/disable and is used to set all of the interrupt enable bits on or off. This bit is cleared when an interrupt routine is entered to disable further interrupt and is set by executing the "RETI" instruction. The INTEDGE register is used to select the active edges for the two external interrupt pins INTO and INT1.

Timer/Event Counter Registers

The devices contain several internal 8-bit and 16-bit Timer/Event Counters, the actual amount depends upon which device is selected. The registers TMR0, TMR1, TMR2 and the register pair TMR1L/TMR1H are the locations where the timer values are located. These registers can also be preloaded with fixed data to allow different time intervals to be setup. The associated control registers, TMR0C, TMR1C and TMR2C contain the setup information for these timers, which determines in what mode the timer is to be used as well as containing the timer on/off control function.

Input/Output Ports and Control Registers

Within the area of Special Function Registers, the I/O registers and their associated control registers play a prominent role. All I/O ports have a designated register correspondingly labeled as PA, PB and PD. These labeled I/O registers are mapped to specific addresses within the Data Memory as shown in the Data Memory table, which are used to transfer the appropriate output or input data on that port. With each I/O port there is an associated control register labeled PAC, PBC and PDC, also mapped to specific addresses with the Data Memory. The control register specifies which pins of that port are set as inputs and which are set as outputs. To setup a pin as an input, the corresponding bit of the control register must be set high, for an output it must be set low. During program initialization, it is important to first setup the control registers to specify which pins are outputs and which are inputs before reading data from or writing data to the I/O ports. One flexible feature of these registers is the ability to directly program single bits using the "SET [m].i" and "CLR [m].i" instructions. The ability to change I/O pins from output to input and vice versa by manipulating specific bits of the I/O control registers during normal program operation is a useful feature of these devices.

Pulse Width Modulator Registers

The devices contain multiple Pulse Width Modulator outputs each with their own related independent control register pair, known as PWM0L/PWM0H, PWM1L/PWM1H, PWM2L/PWM2H and PWM3L/PWM3H. The 12-bit contents of each register pair, which defines the duty cycle value for the modulation cycle of the Pulse Width Modulator, along with an enable bit are contained in these register pairs.

A/D Converter Registers - ADRL, ADRH, ADCR, ACSR

The device contains a multiple channel 12-bit A/D converter. The correct operation of the A/D requires the use of two data registers and two control registers. The two data registers, a high byte data register known as ADRH, and a low byte data register known as ADRL, are the register locations where the digital value is placed after the completion of an analog to digital conversion cycle. Functions such as the A/D enable/disable, A/D channel selection and A/D clock frequency are determined using the two control registers, ADCR and ACSR.



Serial Interface Registers

The device contains two serial interfaces, an SPI and an I²C interface. The SIMCTL0, SIMCTL1, SIMCTL2 and SIMAR are the control registers for the Serial Interface function while the SIMDR is the data register for the Serial Interface Data.

Port A Wake-up Register - PAWU

All pins on Port A have a wake-up function enable a low going edge on these pins to wake-up the device when it is in a power down mode. The pins on Port A that are used to have a wake-up function are selected using this resister.

Pull-High Resistors - PAPU, PBPU, PDPU

All I/O pins on Ports PA, PB and PD, if setup as inputs, can be connected to an internal pull-high resistor. The pins which require a pull-high resistor to be connected are selected using these registers.

Register - CLKMOD

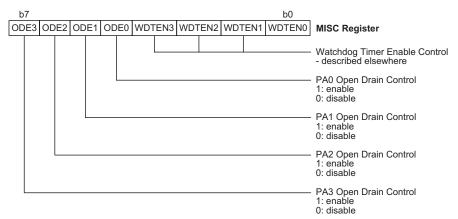
The device operates using a dual clock system whose mode is controlled using this register. The register controls functions such as the clock source, the idle mode enable and the division ratio for the slow clock.

LCD/LED Registers - LCDCTRL, LEDCTRL, LCDOUT1, LCDOUT2

The device contains a fully integrated LCD/LED Driver function which can be setup in various configurations allowing it to control a wide range of external LCD and LED panels. Most of these options are controlled using the LCDCTRL and LEDCTRL registers. As some of the LCD segment driving pins can also be setup to be used as CMOS outputs, two registers, LCDOUT1 and LCDOUT2, are used to select the required function.

Miscellaneous Register - MISC

The miscellaneous register is used to control two functions. The four lower bits are used for the Watchdog Timer control, while the highest four bits are used to select open drain outputs for pins PA0~PA3.



PA0~PA3 Open Drain Control - MISC

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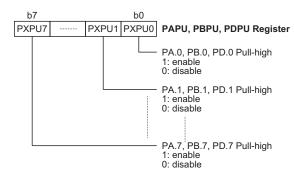
Input/Output Ports

Holtek microcontrollers offer considerable flexibility on their I/O ports. With the input or output designation of every pin fully under user program control, pull-high selections for all ports and wake-up selections on certain pins, the user is provided with an I/O structure to meet the needs of a wide range of application possibilities.

The device provides 24 bidirectional input/output lines labeled with port names PA, PB and PD. These I/O ports are mapped to the RAM Data Memory with specific addresses as shown in the Special Purpose Data Memory table. All of these I/O ports can be used for input and output operations. For input operation, these ports are non-latching, which means the inputs must be ready at the T2 rising edge of instruction "MOV A,[m]", where m denotes the port address. For output operation, all the data is latched and remains unchanged until the output latch is rewritten.

Pull-high Resistors

Many product applications require pull-high resistors for their switch inputs usually requiring the use of an external resistor. To eliminate the need for these external resistors, all I/O pins, when configured as an input have the capability of being connected to an internal pull-high resistor. These pull-high resistors are selected using registers PAPU, PBPU and PDPU and are implemented using weak PMOS transistors.



Pull-High Resistor Register - PAPU, PBPU, PDPU

Port A Wake-up

The HALT instruction forces the microcontroller into a Power Down condition which preserves power, a feature that is important for battery and other low-power applications. Various methods exist to wake-up the microcontroller, one of which is to change the logic condition on one of the Port A pins from high to low. After a HALT instruction forces the microcontroller into entering a Power Down condition, the processor will remain in a low-power state until the logic condition of the selected wake-up pin on Port A changes from high to low. This function is especially suitable for applications that can be woken up via external switches. Each pin on Port A can be selected individually to have this wake-up feature using the PAWU register.

Port A Open Drain Function

All I/O pins in the device have CMOS structures, however Port A pins PA0~PA3 can also be setup as open drain structures. This is implemented using the ODE0~ODE3 bits in the MISC register.

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I/O Port Control Registers

Each I/O port has its own control register known as PAC, PBC and PDC, to control the input/output configuration. With this control register, each CMOS output or input with or without pull-high resistor structures can be reconfigured dynamically under software control. Each pin of the I/O ports is directly mapped to a bit in its associated port control register. For the I/O pin to function as an input, the corresponding bit of the control register must be written as a "1". This will then allow the logic state of the input pin to be directly read by instructions. When the corresponding bit of the control register is written as a "0", the I/O pin will be setup as a CMOS output. If the pin is currently setup as an output, instructions can still be used to read the output register. However, it should be noted that the program will in fact only read the status of the output data latch and not the actual logic status of the output pin.

Pin-shared Functions

The flexibility of the microcontroller range is greatly enhanced by the use of pins that have more than one function. Limited numbers of pins can force serious design constraints on designers but by supplying pins with multi-functions, many of these difficulties can be overcome. For some pins, the chosen function of the multi-function I/O pins is set by configuration options while for others the function is set by application program control.

• External Interrupt Inputs

The external interrupt pins INT0, INT1 are pin-shared with the I/O pins PD4, PD5. For applications not requiring an external interrupt input, the pin-shared external interrupt pin can be used as a normal I/O pin, however to do this, the external interrupt enable bits in the INTC0 register must be disabled.

External Timer Clock Input

The external timer pins TMR0, TMR1 and TMR2 are pin-shared with I/O pins. To configure them to operate as timer inputs, the corresponding control bits in the timer control register must be correctly set and the pin must also be setup as an input. Note that the original I/O function will remain even if the pin is setup to be used as an external timer input.

· PFD Output

The device contains a PFD function whose single output is pin-shared with I/O pin PA3. The output function of this pin is chosen via a configuration option and remains fixed after the device is programmed. Note that the corresponding bit of the port control register, PAC.3, must setup the pin as an output to enable the PFD output. If the PAC port control register has setup the pin as an input, then the pin will function as a normal logic input with the usual pull-high selection, even if the PFD configuration option has been selected.

· PWM Outputs

The device contains several PWM outputs shared with pins PD0~PD3. The PWM output functions are chosen via registers. Note that the corresponding bit of the port control register, PDC, must setup the pin as an output to enable the PWM output. If the PDC port control register has setup the pin as an input, then the pin will function as a normal logic input with the usual pull-high selection, even if the PWM registers have enabled the PWM function.

• A/D Inputs

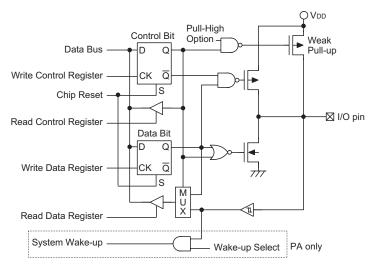
The device contains a multi-channel A/D converter inputs. All of these analog inputs are pin-shared with I/O pins on Port B. If these pins are to be used as A/D inputs and not as normal I/O pins then the corresponding bits in the A/D Converter Control Register, ADCR, must be properly set. There are no configuration options associated with the A/D function. If used as I/O pins, then full pull-high resistor register remain, however if used as A/D inputs then any pull-high resistor selections associated with these pins will be automatically disconnected.

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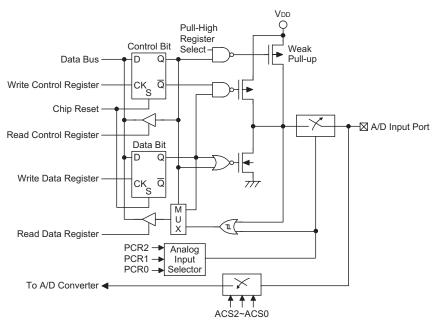


I/O Pin Structures

The accompanying diagrams illustrate the internal structures of some I/O pin types. As the exact logical construction of the I/O pin will differ from these drawings, they are supplied as a guide only to assist with the functional understanding of the I/O pins. The wide range of pin-shared structures does not permit all types to be shown.



Generic Input/Output Structure



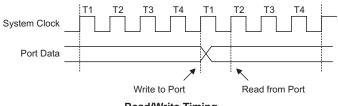
A/D Input/Output Structure

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Programming Considerations

Within the user program, one of the first things to consider is port initialisation. After a reset, all of the I/O data and port control registers will be set high. This means that all I/O pins will default to an input state, the level of which depends on the other connected circuitry and whether pull-high selections have been chosen. If the port control registers, PAC, PBC and PDC, are then programmed to setup some pins as outputs, these output pins will have an initial high output value unless the associated port data registers, PA, PB and PD, are first programmed. Selecting which pins are inputs and which are outputs can be achieved byte-wide by loading the correct values into the appropriate port control register or by programming individual bits in the port control register using the "SET [m].i" and "CLR [m].i" instructions. Note that when using these bit control instructions, a read-modify-write operation takes place. The microcontroller must first read in the data on the entire port, modify it to the required new bit values and then rewrite this data back to the output ports.



Read/Write Timing

Port A has the additional capability of providing wake-up functions. When the device is in the Power Down Mode, various methods are available to wake the device up. One of these is a high to low transition of any of the Port A pins. Single or multiple pins on Port A can be setup to have this function.

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LCD and **LED** Driver

For large volume applications, which incorporate an LCD in their design, the use of a custom display rather than a more expensive character based display reduces costs significantly. However, the corresponding COM and SEG signals required, which vary in both amplitude and time, to drive such a custom display require many special considerations for proper LCD operation to occur. These devices all contain an LCD Driver function, which with their internal LCD signal generating circuitry and various options, will automatically generate these time and amplitude varying signals to provide a means of direct driving and easy interfacing to a range of custom LCDs.

Additionally some of the devices also include LED driver circuitry which can generated the required signals to drive the COM and SEGMENT signals for LED panels.

All device include a wide range of options to enable LCD and LED displays of various types to be driven. The table shows the range of options available across the device range.

Part No.	Duty	Driver No.	Bias	Bias Type	Wave Type
	1/2	25×2		C or R	A or B
HT56R62	1/3	25×3			
	1/4	24×4	1/2 or 1/3		
	1/2	41×2	1/2 01 1/3		
HT56R65	1/3	41×3			
	1/4	40×4			
HT56R642	1/8	24×8			
H130K042	1/16	16×16			
HT56R644	1/8	40×8	1/3, 1/4 or 1/5	R	A or B
HT56R654	1/16	32×16			
HT56R656	1/8	56×8			
H100K000	1/16	48×16			

LCD Selections

Note: 1. The HT56R62 and HT56R65 52-pin packages only have R-bias type.

2. The HT56R62 and HT56R65 devices do not have an LED driver function.

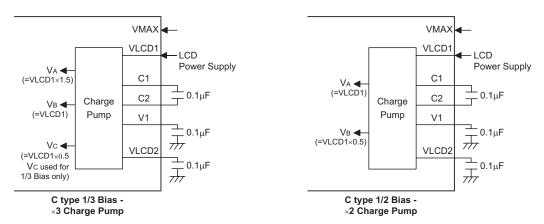
Device	LED Duty	LED Driver No.
	Static	24×1
	1/4	24×4
HT56R642	1/8	24×8
	1/12	16×12
	1/16	16×16
	Static	40×1
	1/4	40×4
HT56R644 HT56R654	1/8	40×8
	1/12	32×12
	1/16	32×16
	Static	56×1
	1/4	56×4
HT56R656	1/8	56×8
	1/12	48×12
	1/16	48×16

LED Selections

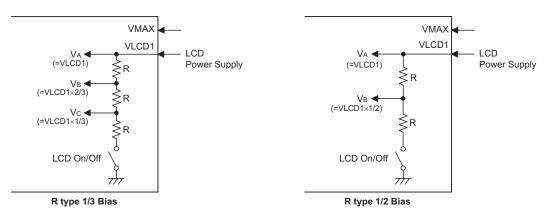
Note: The HT56R62 and HT56R65 devices do not have an LED driver function.

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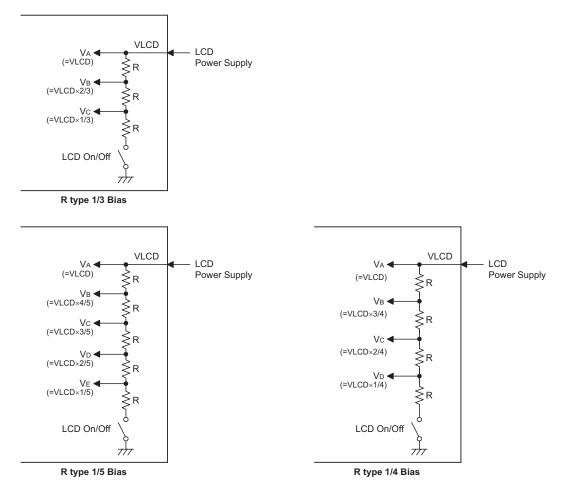
C Type Bias Voltage Levels



R Type Bias Voltage Levels - HT56R62/HT56R65

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R Type Bias Voltage Levels - HT56R642/HT56R644/HT56R654/HT56R656

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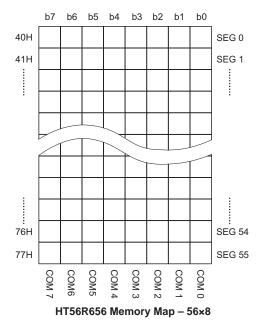
Display Memory

An area of Data Memory is especially reserved for use for the LCD/LED display data. This data area is known as the Display Memory. Any data written here will be automatically read by the internal display driver circuits, which will in turn automatically generate the necessary LCD or LED driving signals. Therefore any data written into this Memory will be immediately reflected into the actual display connected to the microcontroller.

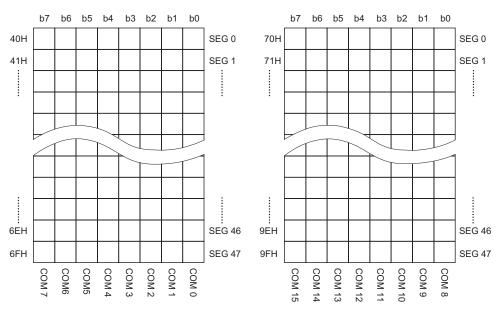
As the Display Memory addresses overlap those of the General Purpose Data Memory, it s stored in its own independent Bank 1 area. The Data Memory Bank to be used is chosen by using the Bank Pointer, which is a special function register in the Data Memory, with the name, BP. To access the Display Memory therefore requires first that Bank 1 is selected by writing a value of 01H to the BP register. After this, the memory can then be accessed by using indirect addressing through the use of Memory Pointer MP1. With Bank 1 selected, then using MP1 to read or write to the memory area, starting with address 40H, will result in operations to the Display Memory. Directly addressing the Display Memory is not applicable and will result in a data access to the Bank 0 General Purpose Data Memory.

The accompanying Display Memory Map diagrams shows how the internal Display Memory is mapped to the Segments and Commons of the display for the largest device, which is the HT56R656. Display Memory Maps for devices with smaller memory capacities can be extrapolated from these diagrams.

The accompanying waveform diagram s show the generated waveforms for a range of duty and bias types. The huge number of permutations of available for the LCD and LED waveform types does not permit all types to be depicted.



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HT56R656 Memory Map - 48×16

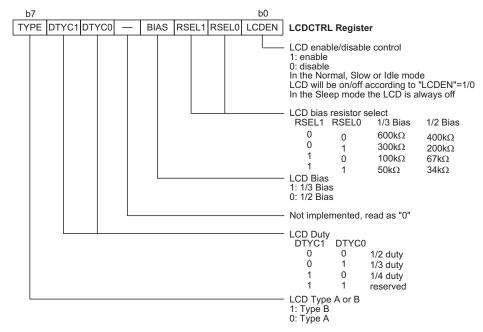
LCD/LED Registers

Control Registers in the Data Memory, are used to control the various setup features of the LCD/LED Driver. There is one control register for the LCD function, LCDCTRL, and one for the LED function, LEDCTRL. Various bits in these registers control functions such as duty type, bias type, bias resistor selection as well as overall LCD enable and disable. The LEDSEL bit in the LEDCTRL register must be first setup to determine whether the display is an LED or LCD type. Programming this bit will determine what other options are available. The LCDEN bit in the LCDCTRL and LEDEN bit in the LEDCTRL register, which provide the overall LCD/LED enable/disable function, will only be effective when the device is in the Normal, Slow or Idle Mode. If the device is in the Sleep Mode then the display will always be disabled. Bits RSEL0 and RSEL1 in the LCDCTRL register select the internal bias resistors to supply the LCD panel with the correct bias voltages. A choice to best match the LCD panel used in the application can be selected also to minimise bias current. The TYPE bit in the same register is used to select whether Type A or Type B LCD control signals are used.

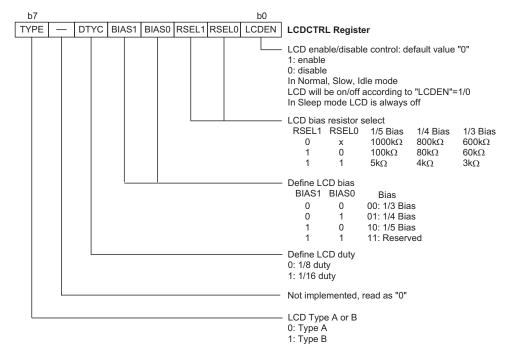
Two registers, LCDOUT1 and LCDOUT2 are used to determine if the output function of display pins SEG0~SEG23 are used as segment drivers or CMOS outputs. If used as CMOS outputs then the Display Memory is used to determine the logic level of the CMOS output pins. Note that as only two bits are used to determine the output function of the SEG0~SEG7 and SEG8~SEG15 pins, individual pins from these two groups of pins cannot be chosen to have either a segment or CMOS output function. The output function of pins SEG16~SEG23 can be chosen individually to be either a segment driver or a CMOS input.

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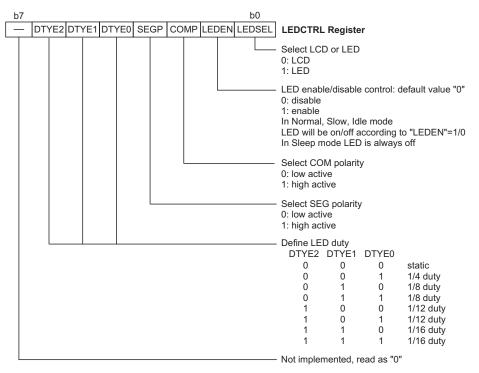
LCD Control Register - LCDCTRL for HT56R62/HT56R65



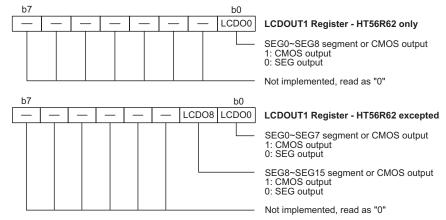
LCD Control Register - LCDCTRL for HT56R642/ HT56R644/ HT56R654/ HT56R656

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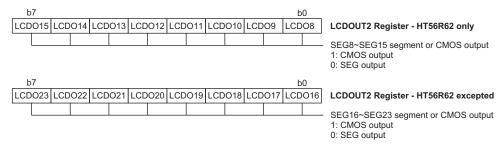




LED Control Register - LEDCTRL



LCD Output Control Register - LCDOUT1



LCD Output Control Register – LCDOUT2

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LCD Reset Function

The LCD has an internal reset function that is an OR function of the inverted LCDEN bit in the LCDCTRL register and the Sleep function. The LCD reset signal is active high. The $\overline{\text{LCDEN}}$ signal is the inverse of the LCDEN bit in the LCDCTRL register.

Reset LCD = (Sleep Mode AND LCDEN) OR $\overline{\text{LCDEN}}$.

LCDEN=0 and LCDEN=1 must be enabled to activate the LCDCTRL register function.

LCDEN	Sleep Mode	Reset LCD
0	Off	√
0	On	√
1	Off	х
1	On	√

LCD Reset Function

Clock Source

The LCD clock source is the internal clock signal, f_{SUB} , divided by 8, using an internal divider circuit. The f_{SUB} internal clock is supplied by either the internal 32K_INT oscillator or the external 32768Hz oscillator, the choice of which is determined by a configuration option. For proper LCD operation, this arrangement is provided to generate an ideal LCD clock source frequency of 4kHz.

f _{SUB} Clock Source	LCD Clock Frequency
Internal 32K_INT Osc.	4kHz
External 32768Hz Osc.	4kHz

LCD Clock Source

LCD Driver Output

When the LEDSEL bit in the LEDCTRL register is cleared to zero, the COM and SEG lines will be setup as LCD driver pins to drive the LCD display.

The number of COM and SEG outputs supplied by the LCD driver, as well as its biasing and duty selections, are dependent upon how the LCD control bits are programmed. The Bias Type, whether C or R type is selected using a configuration option.

If the C-type of bias is used when an internal charge pump will be enabled. Note that the C-type bias is not available on the 52-pin QFP package type.

The nature of Liquid Crystal Displays require that only A_C voltages can be applied to their pixels as the application of DC voltages to LCD pixels may cause permanent damage. For this reason the relative contrast of an LCD display is controlled by the actual RMS voltage applied to each pixel, which is equal to the RMS value of the voltage on the COM pin minus the voltage applied to the SEG pin. This differential RMS voltage must be greater than the LCD saturation voltage for the pixel to be on and less than the threshold voltage for the pixel to be off. The requirement to limit the DC voltage to zero and to control as many pixels as possible with a minimum number of connections, requires that both a time and amplitude signal is generated and applied to the application LCD. These time and amplitude varying signals are automatically generated by the LCD driver circuits in the microcontroller. What is known as the duty determines the number of common lines used, which are also known as backplanes or COMs. The duty, which is chosen by a control bit to have a value of 1/2, 1/3, 1/4 etc and which equates to a COM number of 2, 3, 4 etc, therefore defines the number of time divisions within each LCD signal frame. Two types of signal generation are also provided, known as Type A and Type B, the required type is selected via the TYPE bit in the LCDCTRL register. Type B offers lower frequency signals, however lower frequencies may introduce flickering and influence display clarity.

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LED Driver Output

The LED driver uses the COM and SEG lines to drive the LED display. The number of COM and SEG outputs supplied by the LED driver, as well as its biasing and duty selections, are dependent upon how the LED control bits are programmed.

When the LEDSEL bit in the LEDCTRL register is set high, the COM and SEG lines will be setup as CMOS output drivers to drive the LED display. The COM and SEG lines can be set to be either active high or active low using bits in the LEDCTRL register. This provides 4 different timing modes. These are COM low active, SEG low active; COM low active, SEG high active; COM high active, SEG low active; COM high active. The COM and SEG lines will have a reverse polarity when in the non-active state when the display is off. For the LED driver there are a total of 5 different duty cycle selections which are Static, 14, 18, 112 and 116. The frame rate of each duty cycle will be between 55Hz and 75Hz.

LCD Voltage Source and Biasing

The time and amplitude varying signals generated by the LCD Driver function require the generation of several voltage levels for their operation. The number of voltage levels used by the signal depends upon the value of the BIAS bit in the LCDCTRL register. The device can have either R type or C type biasing selected via a configuration option. Selecting the C type biasing will enable an internal charge pump whose multiplier ratio can be selected using an additional configuration option.

For R type biasing an external LCD voltage source must be supplied on pin VLCD1 to generate the internal biasing voltages. This could be the microcontroller power supply or some other voltage source. For the R type 1/2 bias selection, three voltage levels V_{SS} , V_A and V_B are utilised. The voltage V_A is equal to the externally supplied voltage source applied to pin VLCD1. V_B is generated internally by the microcontroller and will have a value equal to $V_{LCD1}/2$. For the R type 1/3 bias selection, four voltage levels V_{SS} , V_A , V_B and V_C are utilised. The voltage V_A is equal to V_{LCD1}, V_B is equal to $V_{LCD1}\times 2/3$ while V_C is equal to $V_{LCD1}\times 1/3$. In addition to selecting 1/2 or 1/3 bias, several values of bias resistor can be chosen using bits in the LCDCTRL register. Different values of internal bias resistors can be selected using the RSEL0 and RESEL1 bits in the LCDCTRL register. This along with the voltage on pin VLCD1 will determine the bias current. The connection to the VMAX pin depends upon the voltage that is applied to VLCD1. If the V_{DD} voltage is greater than the voltage applied to the VLCD1 pin then the VMAX pin should be connected to VDD, otherwise the VMAX pin should be connected to pin VLCD1. Note that no external capacitors or resistors are required to be connected if R type biasing is used.

Condition	VMAX connection		
$V_{DD} > V_{LCD1}$	Connect VMAX to VDD		
Otherwise	Connect VMAX to VLCD1		

R Type Bias Current VMAX Connection

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For C type biasing an external LCD voltage source must also be supplied on pin VLCD1 to generate the internal biasing voltages. The C type biasing scheme uses an internal charge pump circuit, which in the case of the 1/3 bias selection can generate voltages higher than what is supplied on VLCD1. This feature is useful in applications where the microcontroller supply voltage is less than the supply voltage required by the LCD. An additional charge pump capacitor must also be connected between pins C1 and C2 to generate the necessary voltage levels.

For the C type 1/2 bias selection, three voltage levels V_{SS} , V_A and V_B are utilised. The voltage V_A is generated internally and has a value of V_{LCD1} . V_B will have a value equal to $V_A \times 0.5$. For the C type 1/2 bias configuration V_C is not used.

For the C type 1/3 bias selection, four voltage levels V_{SS} , V_A , V_B and V_C are utilised. The voltage V_A is generated internally and has a value of $V_{LCD1}\times1.5$. V_B will have a value equal to $V_A\times2/3$ and V_C will have a value equal to $V_A\times1/3$. The connection to the VMAX pin depends upon the bias and the voltage that is applied to VLCD, the details are shown in the table. Note that C type biasing is not available on the 52-pin QFP package device types. On these package types, pins C1, C2 and V2 are not provided. It is recommended that a $0.1\mu F$ capacitor is connected between the V1 pin and ground on the 52-pin QFP package types.

It is extremely important to ensure that these charge pump generated internal voltages do not exceed the maximum V_{DD} voltage of 5.5V. Note that the C-type bias type is not available on the 52-pin QFP package type.

Biasing Type		VMAX Connection	
1/2 Diag	V _{DD} >V _{LCD1} ×1.5	Connect VMAX to VDD	
1/3 Bias	Otherwise	Connect VMAX to V1	
1/2 Bias	V _{DD} >V _{LCD1}	Connect VMAX to VDD	
1/2 blas	Otherwise	Connect VMAX to VLCD1	

C Type Biasing VMAX Connection

Programming Considerations

Certain precautions must be taken when programming the LCD/LED. One of these is to ensure that the Display Memory is properly initialised after the microcontroller is powered on. Like the General Purpose Data Memory, the contents of the Display Memory are in an unknown condition after power-on. As the contents of the Display Memory y will be mapped into the actual display, it is important to initialise this memory area into a known condition soon after applying power to obtain a proper display pattern.

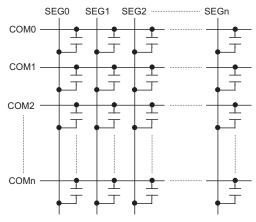
Consideration must also be given to the capacitive load of the actual LCD used in the application. As the load presented to the microcontroller by LCD pixels can be generally modeled as mainly capacitive in nature, it is important that this is not excessive, a point that is particularly true in the case of the COM lines which may be connected to many LCD pixels. The accompanying diagram depicts the equivalent circuit of the LCD.

One additional consideration that must be taken into account is what happens when the microcontroller enters a Power Down condition. The LCDEN control bit in the LCDCTRL or LEDEN bit in the LEDCTRL register permits the display to be powered off to reduce power consumption. If this bit is zero, the driving signals to the display will cease, producing a blank display pattern but reducing any power consumption associated with the LCD.

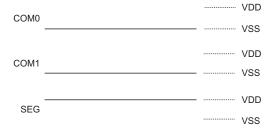
After Power-on, note that as the LCDEN and LEDEN bits will be cleared to zero, the display function will be disabled.

The accompanying timing diagrams depict the display driver signals generated by the microcontroller for various values of duty and bias. The huge range of various permutations only permit a few types to be displayed here.

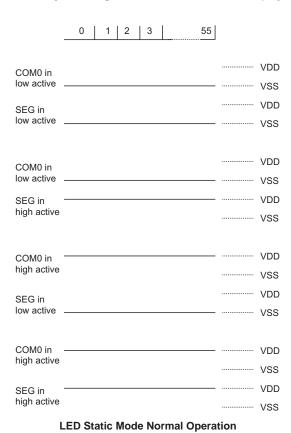
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LCD Panel Equivalent Circuit

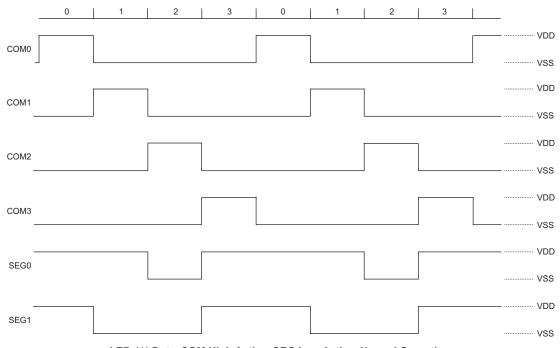


LED 1/4 Duty, COM High Active, SEG Low Active, Display Off

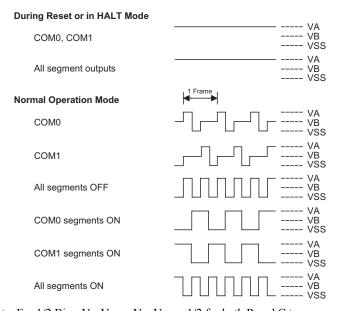


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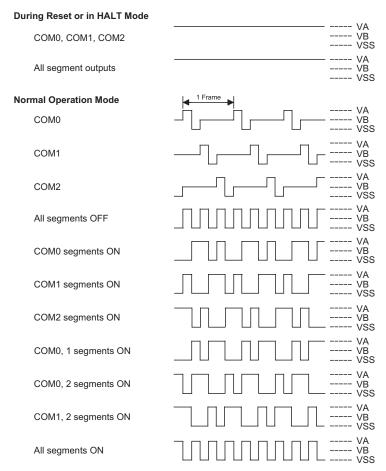


LED 1/4 Duty, COM High Active, SEG Low Active, Normal Operation



LCD Driver Output - Type A - 1/2 Duty, 1/2 Bias



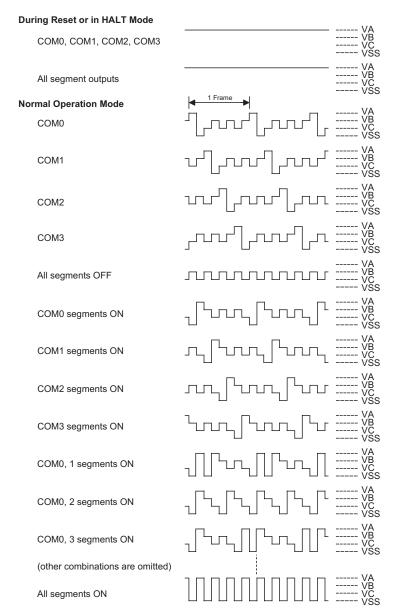


Note: For 1/2 Bias, the $V_A=V_{LCD1}$, $V_B=V_{LCD1}\times 1/2$ for both R and C type.

LCD Driver Output - Type A - 1/3 Duty, 1/2 Bias

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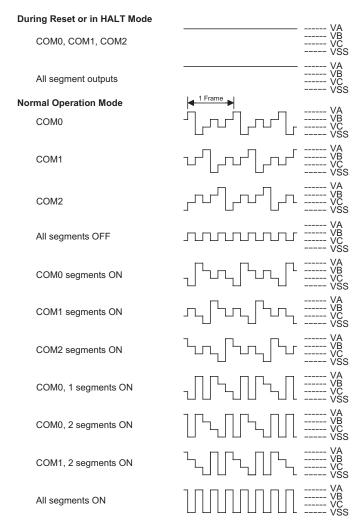




Note: For 1/3 R type bias, the $V_A=V_{LCDI}$, $V_B=V_{LCDI}\times 2/3$ and $V_C=V_{LCDI}\times 1/3$. For 1/3 C type bias, the $V_A=V_{LCDI}\times 1.5$, $V_B=V_{LCDI}$ and $V_C=V_{LCDI}\times 1/2$.

LCD Driver Output - Type A - 1/4 Duty, 1/3 Bias



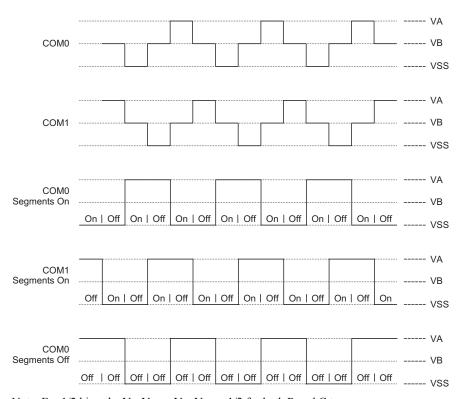


Note: For 1/3 R type bias, the $V_A=V_{LCD1}$, $V_B=V_{LCD1}\times 2/3$ and $V_C=V_{LCD1}\times 1/3$. For 1/3 C type bias, the $V_A=V_{LCD1}\times 1.5$, $V_B=V_{LCD1}$ and $V_C=V_{LCD1}\times 1/2$.

LCD Driver Output - Type A - 1/3 Duty, 1/3 Bias

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Note: For 1/2 bias, the $V_A=V_{LCDI}$, $V_B=V_{LCDI}\times 1/2$ for both R and C type. **LCD Driver Output – Type B – 1/2 Duty, 1/2 Bias**

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Timer/Event Counters

The provision of timers form an important part of any microcontroller, giving the designer a means of carrying out time related functions. The devices contain several 8-bit and 16-bit count-up timers. As each timer has three different operating modes, they can be configured to operate as a general timer, an external event counter or as a pulse width measurement device. The provision of a prescaler to the clock circuitry of the 8-bit Timer/Event Counter also gives added range to this timer.

There are two types of registers related to the Timer/Event Counters. The first are the registers that contain the actual value of the Timer/Event Counter and into which an initial value can be preloaded. Reading from these registers retrieves the contents of the Timer/Event Counter. The second type of associated register is the Timer Control Register which defines the timer options and determines how the Timer/Event Counter is to be used. The Timer/Event Counters can have the their clock configured to come from an internal clock source. In addition, their clock source can also be configured to come from an external timer pin.

Configuring the Timer/Event Counter Input Clock Source

The internal timer's clock can originate from various sources. The system clock source is used when the Timer/Event Counter is in the timer mode or in the pulse width measurement mode. For the 8-bit Timer/Event Counter this internal clock source is f_{SYS} which is also divided by a prescaler, the division ratio of which is conditioned by the Timer Control Register, TMRnC, bits TnPSC0~TnPSC2. For the 16-bit Timer/Event Counter this internal clock source can be chosen from a combination of internal clocks using a configuration option and the TnS bit in the TMRnC register.

An external clock source is used when the timer is in the event counting mode, the clock source being provided on an external timer pin TMR0, TMR1 or TMR2 depending upon which timer is used. Depending upon the condition of the TnE bit, each high to low, or low to high transition on the external timer pin will increment the counter by one.

Device	HT56R62	HT56R642/HT56R644	HT56R65/HT56R654/HT56R656	
No. of 8-bit Timers	2	1	2	
Timer Name Timer/Event Counter 0 Timer/Event Counter 1		Timer/Event Counter 0	Timer/Event Counter 0 Timer/Event Counter2	
Timer Register Name TMR0 TMR1		TMR0	TMR0 TMR2	
Control Register Name	TMR0C TMR1C	TMR0C	TMR0C TMR2C	
No. of 16-bit Timers	0	1	1	
Timer Name	_	Timer/Event Counter 1	Timer/Event Counter 1	
Timer Register Name	_	TMR1L/TMR1H	TMR1L/TMR1H	
Control Register Name	_	TMR1C	TMR1C	

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Timer Registers - TMR0, TMR1, TMR1L/TMR1H, TMR2

The timer registers are special function registers located in the Special Purpose Data Memory and is the place where the actual timer value is stored. For the 8-bit Timer/Event Counters, these registers are known as TMR0, TMR1 or TMR2. For the 16-bit Timer/Event Counter, a pair of registers are required and are known as TMR1L/TMR1H. The value in the timer registers increases by one each time an internal clock pulse is received or an external transition occurs on the external timer pin. The timer will count from the initial value loaded by the preload register to the full count of FFH for the 8-bit timer or FFFFH for the 16-bit timer at which point the timer overflows and an internal interrupt signal is generated. The timer value will then be reset with the initial preload register value and continue counting.

To achieve a maximum full range count of FFH for the 8-bit timer or FFFFH for the 16-bit timer, the preload registers must first be cleared to all zeros. It should be noted that after power-on, the preload register will be in an unknown condition. Note that if the Timer/Event Counter is switched off and data is written to its preload registers, this data will be immediately written into the actual timer registers. However, if the Timer/Event Counter is enabled and counting, any new data written into the preload data registers during this period will remain in the preload registers and will only be written into the timer registers the next time an overflow occurs.

For the 16-bit Timer/Event Counter which has both low byte and high byte timer registers, accessing these registers is carried out in a specific way. It must be noted when using instructions to preload data into the low byte timer register, the data will only be placed in a low byte buffer and not directly into the low byte timer register. The actual transfer of the data into the low byte timer register is only carried out when a write to its associated high byte timer register, namely TMR1H, is executed. On the other hand, using instructions to preload data into the high byte timer register will result in the data being directly written to the high byte timer register. At the same time the data in the low byte buffer will be transferred into its associated low byte timer register. For this reason, the low byte timer register should be written first when preloading data into the 16-bit timer registers. It must also be noted that to read the contents of the low byte timer register, a read to the high byte timer register must be executed first to latch the contents of the low byte timer register into its associated low byte buffer. After this has been done, the low byte timer register can be read in the normal way. Note that reading the low byte timer register will result in reading the previously latched contents of the low byte buffer and not the actual contents of the low byte timer register.

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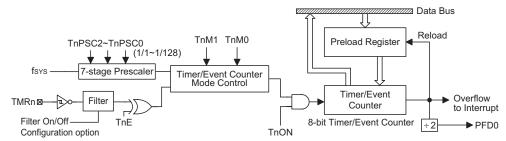


Timer Control Registers - TMR0C, TMR1C, TMR2C

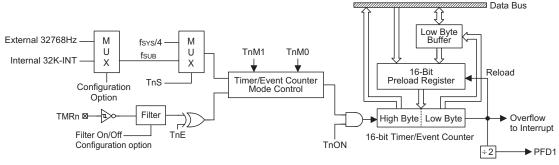
The flexible features of the Holtek microcontroller Timer/Event Counters enable them to operate in three different modes, the options of which are determined by the contents of their respective control

It is the Timer Control Register together with its corresponding timer registers that control the full operation of the Timer/Event Counters. Before the timers can be used, it is essential that the appropriate Timer Control Register is fully programmed with the right data to ensure its correct operation, a process that is normally carried out during program initialisation.

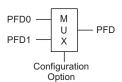
To choose which of the three modes the timer is to operate in, either in the timer mode, the event counting mode or the pulse width measurement mode, bits 7 and 6 of the corresponding Timer Control Register, which are known as the bit pair TnM1/TnM0, must be set to the required logic levels. The timer-on bit, which is bit 4 of the Timer Control Register and known as TnON, depending upon which timer is used, provides the basic on/off control of the respective timer. Setting the bit high allows the counter to run, clearing the bit stops the counter. For timers that have prescalers, bits 0~2 of the Timer Control Register determine the division ratio of the input clock prescaler. The prescaler bit settings have no effect if an external clock source is used. If the timer is in the event count or pulse width measurement mode, the active transition edge level type is selected by the logic level of bit 3 of the Timer Control Register which is known as TnE. An additional TnS bit in the 16-bit Timer/Event Counter control register is used to determine the clock source for the Timer/Event Counter.



8-bit Timer/Event Counter Structure

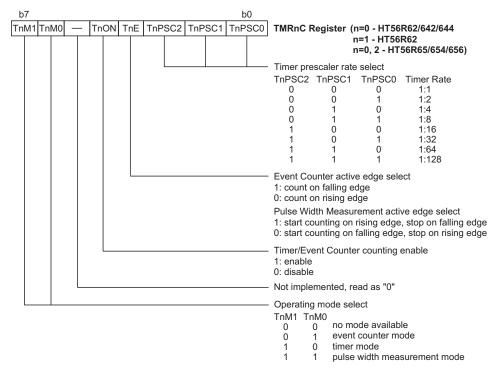


16-bit Timer/Event Counter Structure

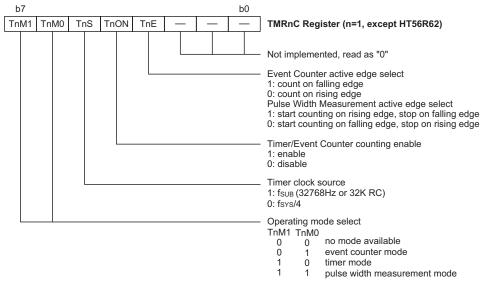


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Timer/Event Counter Control Register - TMRnC



Timer/Event Counter Control Register - TMRnC

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Configuring the Timer Mode

In this mode, the Timer/Event Counter can be utilised to measure fixed time intervals, providing an internal interrupt signal each time the Timer/Event Counter overflows. To operate in this mode, the Operating Mode Select bit pair, TnM1/TnM0, in the Timer Control Register must be set to the correct value as shown.

			-
	Bit7	Bit6	
	1	0	
Control Register O	perating Mod	e Select Bits	for the Timer Mode
Prescaler Output			
Increment Timer Controller Timer + 1 Timer -	+ 2		Timer + N Timer + N + 1

Timer Mode Timing Chart

In this mode the internal clock, f_{SYS} , is used as the internal clock for 8-bit Timer/Event Counter 0 and f_{SUB} or $f_{SYS}/4$ is used as the internal clock for 16-bit Timer/Event Counter 1. However, the clock source, f_{SYS} , for the 8-bit timer is further divided by a prescaler, the value of which is determined by the Prescaler Rate Select bits TnPSC2~TnPSC0, which are bits 2~0 in the Timer Control Register. After the other bits in the Timer Control Register have been setup, the enable bit TnON or TnON, which is bit 4 of the Timer Control Register, can be set high to enable the Timer/Event Counter to run. Each time an internal clock cycle occurs, the Timer/Event Counter increments by one. When it is full and overflows, an interrupt signal is generated and the Timer/Event Counter will reload the value already loaded into the preload register and continue counting. The interrupt can be disabled by ensuring that the Timer/Event Counter Interrupt Enable bit in the corresponding Interrupt Control Register, is reset to zero.

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Configuring the Event Counter Mode

In this mode, a number of externally changing logic events, occurring on the external timer pin, can be recorded by the Timer/Event Counter. To operate in this mode, the Operating Mode Select bit pair, TnM1/TnM0, in the Timer Control Register must be set to the correct value as shown.

Bit7	Bit6
0	1

Control Register Operating Mode Select Bits for the Event Counter Mode



Event Counter Mode Timing Chart

In this mode, the external timer pin, is used as the Timer/Event Counter clock source, however it is not divided by the internal prescaler. After the other bits in the Timer Control Register have been setup, the enable bit TnON, which is bit 4 of the Timer Control Register, can be set high to enable the Timer/Event Counter to run. If the Active Edge Select bit, TnE, which is bit 3 of the Timer Control Register, is low, the Timer/Event Counter will increment each time the external timer pin receives a low to high transition. If the Active Edge Select bit is high, the counter will increment each time the external timer pin receives a high to low transition. When it is full and overflows, an interrupt signal is generated and the Timer/Event Counter will reload the value already loaded into the preload register and continue counting. The interrupt can be disabled by ensuring that the Timer/Event Counter Interrupt Enable bit in the corresponding Interrupt Control Register, is reset to zero.

As the external timer pin is shared with an I/O pin, to ensure that the pin is configured to operate as an event counter input pin, two things have to happen. The first is to ensure that the Operating Mode Select bits in the Timer Control Register place the Timer/Event Counter in the Event Counting Mode, the second is to ensure that the port control register configures the pin as an input. It should be noted that in the event counting mode, even if the microcontroller is in the Power Down Mode, the Timer/Event Counter will continue to record externally changing logic events on the timer input pin. As a result when the timer overflows it will generate a timer interrupt and corresponding wake-up source.

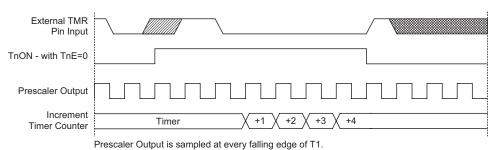
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Configuring the Pulse Width Measurement Mode

In this mode, the Timer/Event Counter can be utilised to measure the width of external pulses applied to the external timer pin. To operate in this mode, the Operating Mode Select bit pair, TnM1/TnM0, in the Timer Control Register must be set to the correct value as shown.

Bit7	Bit6	
1	1	

Control Register Operating Mode Select Bits for the Pulse Width Measurement Mode



Pulse Width Measure Mode Timing Chart

In this mode the internal clock, f_{SYS} , is used as the internal clock for the 8-bit Timer/Event Counter and f_{SUB} or $f_{SYS}/4$ is used as the internal clock for the 16-bit Timer/Event Counter. However, the clock source, f_{SYS} , for the 8-bit timer is further divided by a prescaler, the value of which is determined by the Prescaler Rate Select bits TnPSC2~TnPSC0, which are bits 2~0 in the Timer Control Register. After the other bits in the Timer Control Register have been setup, the enable bit TnON, which is bit 4 of the Timer Control Register, can be set high to enable the Timer/Event Counter, however it will not actually start counting until an active edge is received on the external timer pin.

If the Active Edge Select bit TnE, which is bit 3 of the Timer Control Register, is low, once a high to low transition has been received on the external timer pin, the Timer/Event Counter will start counting until the external timer pin returns to its original high level. At this point the enable bit will be automatically reset to zero and the Timer/Event Counter will stop counting. If the Active Edge Select bit is high, the Timer/Event Counter will begin counting once a low to high transition has been received on the external timer pin and stop counting when the external timer pin returns to its original low level. As before, the enable bit will be automatically reset to zero and the Timer/Event Counter will stop counting. It is important to note that in the Pulse Width Measurement Mode, the enable bit is automatically reset to zero when the external control signal on the external timer pin returns to its original level, whereas in the other two modes the enable bit can only be reset to zero under program control.

The residual value in the Timer/Event Counter, which can now be read by the program, therefore represents the length of the pulse received on the external timer pin. As the enable bit has now been reset, any further transitions on the external timer pin will be ignored. Not until the enable bit is again set high by the program can the timer begin further pulse width measurements. In this way, single shot pulse measurements can be easily Made.

It should be noted that in this mode the Timer/Event Counter is controlled by logical transitions on the external timer pin and not by the logic level. When the Timer/Event Counter is full and overflows, an interrupt signal is generated and the Timer/Event Counter will reload the value already loaded into the preload register and continue counting. The interrupt can be disabled by ensuring that the Timer/Event Counter Interrupt Enable bit in the corresponding Interrupt Control Register, is reset to zero.

As the external timer pin is shared with an I/O pin, to ensure that the pin is configured to operate as a pulse width measurement pin, two things have to happen. The first is to ensure that the Operating Mode Select bits in the Timer Control Register place the Timer/Event Counter in the Pulse Width Measurement Mode, the second is to ensure that the port control register configures the pin as an input.

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Programmable Frequency Divider - PFD

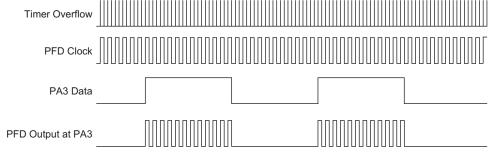
The Programmable Frequency Divider provides a means of producing a variable frequency output suitable for applications requiring a precise frequency generator.

The PFD output is pin-shared with the I/O pin PA3. The PFD function is selected via configuration option, however, if not selected, the pin can operate as a normal I/O pin.

The clock source for the PFD circuit can originate from either Timer/Event Counter 0 or Timer/Event Counter 1 overflow signal selected via configuration option. The output frequency is controlled by loading the required values into the timer registers and prescaler registers to give the required division ratio. The timer will begin to count-up from this preload register value until full, at which point an overflow signal is generated, causing the PFD output to change state. The timer will then be automatically reloaded with the preload register value and continue counting-up.

For the PFD output to function, it is essential that the corresponding bit of the Port A control register PAC bit 3 is setup as an output. If setup as an input the PFD output will not function, however, the pin can still be used as a normal input pin. The PFD output will only be activated if bit PA3 is set to "1". This output data bit is used as the on/off control bit for the PFD output. Note that the PFD output will be low if the PA3 output data bit is cleared to "0".

Using this method of frequency generation, and if a crystal oscillator is used for the system clock, very precise values of frequency can be generated.



PFD Output Control

Prescaler

Bits TnPSC0~TnPSC2 of the control register can be used to define the pre-scaling stages of the internal clock source of the Timer/Event Counter. The Timer/Event Counter overflow signal can be used to generate signals for the PFD and Timer Interrupt.

I/O Interfacing

The Timer/Event Counter, when configured to run in the event counter or pulse width measurement mode, require the use of external pins for correct operation. As these pins are shared pins they must be configured correctly to ensure they are setup for use as Timer/Event Counter inputs and not as a normal I/O pins. This is implemented by ensuring that the mode select bits in the Timer/Event Counter control register, select either the event counter or pulse width measurement mode. Additionally the Port Control Register must be set high to ensure that the pin is setup as an input. Any pull-high resistor on these pins will remain valid even if the pin is used as a Timer/Event Counter input.

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Timer/Event Counter Pins Internal Filter

The external Timer/Event Counter pins are connected to an internal filter to reduce the possibility of unwanted event counting events or inaccurate pulse width measurements due to adverse noise or spikes on the external Timer/Event Counter input signal. As this internal filter circuit will consume a limited amount of power, a configuration option is provided to switch off the filter function, an option which may be beneficial in power sensitive applications, but in which the integrity of the input signal is high. Care must be taken when using the filter on/off configuration option as it will be applied not only to both external Timer/Event Counter pins but also to the external interrupt input pins. Individual Timer/Event Counter or external interrupt pins cannot be selected to have a filter on/off function.

Programming Considerations

When configured to run in the timer mode, the internal system clock is used as the timer clock source and is therefore synchronised with the overall operation of the microcontroller. In this mode when the appropriate timer register is full, the microcontroller will generate an internal interrupt signal directing the program flow to the respective internal interrupt vector. For the pulse width measurement mode, the internal system clock is also used as the timer clock source but the timer will only run when the correct logic condition appears on the external timer input pin. As this is an external event and not synchronized with the internal timer clock, the microcontroller will only see this external event when the next timer clock pulse arrives. As a result, there may be small differences in measured values requiring programmers to take this into account during programming. The same applies if the timer is configured to be in the event counting mode, which again is an external event and not synchronised with the internal system or timer clock.

When the Timer/Event Counter is read, or if data is written to the preload register, the clock is inhibited to avoid errors, however as this may result in a counting error, this should be taken into account by the programmer. Care must be taken to ensure that the timers are properly initialised before using them for the first time. The associated timer enable bits in the interrupt control register must be properly set otherwise the internal interrupt associated with the timer will remain inactive. The edge select, timer mode and clock source control bits in timer control register must also be correctly set to ensure the timer is properly configured for the required application. It is also important to ensure that an initial value is first loaded into the timer registers before the timer is switched on; this is because after power-on the initial values of the timer registers are unknown. After the timer has been initialised the timer can be turned on and off by controlling the enable bit in the timer control register. Note that setting the timer enable bit high to turn the timer on, should only be executed after the timer mode bits have been properly setup. Setting the timer enable bit high together with a mode bit modification, may lead to improper timer operation if executed as a single timer control register byte write instruction.

When the Timer/Event counter overflows, its corresponding interrupt request flag in the interrupt control register will be set. If the timer interrupt is enabled this will in turn generate an interrupt signal. However irrespective of whether the interrupts are enabled or not, a Timer/Event counter overflow will also generate a wake-up signal if the device is in a Power-down condition. This situation may occur if the Timer/Event Counter is in the Event Counting Mode and if the external signal continues to change state. In such a case, the Timer/Event Counter will continue to count these external events and if an overflow occurs the device will be woken up from its Power-down condition. To prevent such a wake-up from occurring, the timer interrupt request flag should first be set high before issuing the HALT instruction to enter the Power Down Mode.

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Timer Program Example

This program example shows how the Timer/Event Counter registers are setup, along with how the interrupts are enabled and managed. Note how the Timer/Event Counter is turned on, by setting bit 4 of the Timer Control Register. The Timer/Event Counter can be turned off in a similar way by clearing the same bit. This example program sets the Timer/Event Counter to be in the timer mode, which uses the internal system clock as the clock source.

```
; external interrupt vector
org 04h
reti
org 08h
              ; Timer/Event Counter 0 interrupt vector
               ; jump here when the Timer/Event Counter O overflows
jmp tmrint
              ; main program internal Timer/Event Counter 0 interrupt routine
org 20h
tmrint:
               ; Timer/Event Counter O main program placed here
reti
begin:
               ; setup Timer O registers
mov a,09bh
              ; setup Timer O preload value
mov tmr0,a;
mov a,081h
            ; setup Timer O control register
mov tmr0c,a ; timer mode and prescaler set to /2 setup interrupt register
mov a,009h ; enable master interrupt and timer interrupt
mov int0c,a
set tmr0c.4 ; start Timer/Event Counter 0 - note mode bits must be previously setup
```



Pulse Width Modulator

The devices contains a series of Pulse Width Modulation, PWM, outputs. Useful for such applications such as motor speed control, the PWM function provides an output with a fixed frequency but with a duty cycle that can be varied by setting particular values into the corresponding PWM register.

Part No.	Channels	PWM Mode	Output Pin	Register Names
HT56R62	3	8+4	PD0~PD2	PWM0L~PWM2L PWM0H~PWM2H
Other Devices	4	8+4	PD0~PD3	PWM0L~PWM3L PWM0H~PWM3H

PWM Overview

A register pair, located in the Data Memory is assigned to each Pulse Width Modulator output and are known as the PWM registers. It is in each register pair that the 12-bit value, which represents the overall duty cycle of one modulation cycle of the output waveform, should be placed. The PWM registers also contain the enable/disable control bit for the PWM outputs. To increase the PWM modulation frequency, each modulation cycle is modulated into sixteen individual modulation sub-sections, known as the 8+4 mode. Note that it is only necessary to write the required modulation value into the corresponding PWM register as the subdivision of the waveform into its sub-modulation cycles is implemented automatically within the microcontroller hardware. The PWM clock source is the system clock f_{Sys}.

This method of dividing the original modulation cycle into a further 16 sub-cycles enables the generation of higher PWM frequencies, which allow a wider range of applications to be served. As long as the periods of the generated PWM pulses are less than the time constants of the load, the PWM output will be suitable as such long time constant loads will average out the pulses of the PWM output. The difference between what is known as the PWM cycle frequency and the PWM modulation frequency should be understood. As the PWM clock is the system clock, f_{SYS} , and as the PWM value is 12-bit wide, the overall PWM cycle frequency is $f_{SYS}/4096$. However, when in the 8+4 mode of operation, the PWM modulation frequency will be $f_{SYS}/256$.

PWM Modulation Frequency	PWM Cycle Frequency	PWM Cycle Duty
f _{SYS} /256	f _{SYS} /4096	(PWM register value)/4096

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8+4 PWM Mode Modulation

Each full PWM cycle, as it is 12-bit wide, has 4096 clock periods. However, in the 8+4 PWM mode, each PWM cycle is subdivided into sixteen individual sub-cycles known as modulation cycle 0~modulation cycle 15, denoted as "i" in the table. Each one of these sixteen sub-cycles contains 256 clock cycles. In this mode, a modulation frequency increase of sixteen is achieved. The 12-bit PWM register value, which represents the overall duty cycle of the PWM waveform, is divided into two groups. The first group which consists of bit4~bit11 is denoted here as the DC value. The second group which consists of bit0~bit3 is known as the AC value. In the 8+4 PWM mode, the duty cycle value of each of the two modulation sub-cycles is shown in the following table.

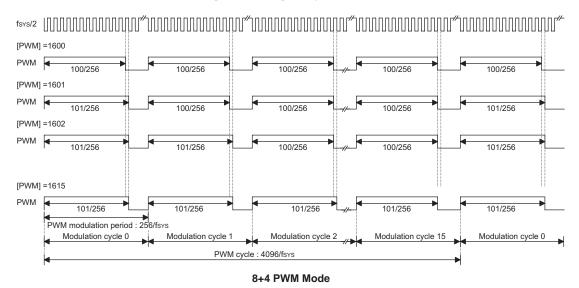
Parameter	AC (0~15)	DC (Duty Cycle)
Modulation cycle i (i=0~15)	i <ac< td=""><td>DC+1 256</td></ac<>	DC+1 256
	i≥AC	<u>DC</u> 256

8+4 Mode Modulation Cycle Values

The accompanying diagram illustrates the waveforms associated with the 8+4 mode of PWM operation. It is important to note how the single PWM cycle is subdivided into 16 individual modulation cycles, numbered 0~15 and how the AC value is related to the PWM value.

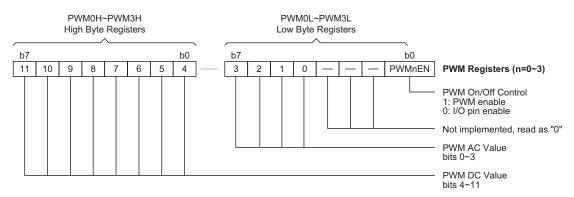
PWM Output Control

The four PWM0~PWM3 outputs are shared with pins PD0~PD3. To operate as a PWM output and not as an I/O pin, bit 0 of the relevant PWM register bit must be set high. A zero must also be written to the corresponding bit in the PDC port control register, to ensure that the PWM0 output pin is setup as an output. After these two initial steps have been carried out, and of course after the required PWM 12-bit value has been written into the PWM register pair register, writing a "1" to the corresponding PD data register will enable the PWM data to appear on the pin. Writing a "0" to the bit will disable the PWM output function and force the output low. In this way, the Port D data output register bits, can also be used as an on/off control for the PWM function. Note that if the enable bit in the PWM register is set high to enable the PWM function, but a "1" has been written to its corresponding bit in the PDC control register to configure the pin as an input, then the pin can still function as a normal input line, with pull-high resistor selections.



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PWM Register Pairs

PWM Programming Example

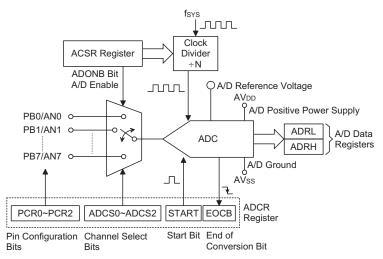
The following sample program shows how the PWM output is setup and controlled.

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Analog to Digital Converter

The need to interface to real world analog signals is a common requirement for many electronic systems. However, to properly process these signals by a microcontroller, they must first be converted into digital signals by A/D converters. By integrating the A/D conversion electronic circuitry into the microcontroller, the need for external components is reduced significantly with the corresponding follow-on benefits of lower costs and reduced component space requirements.



A/D Converter Structure

A/D Overview

The device contains an 8-channel analog to digital converter which can directly interface to external analog signals, such as that from sensors or other control signals and convert these signals directly into either a 12-bit digital value.

Part No.	Input Channels	Conversion Bits	Input Pins		
HT56R62	6	12	PB0~PB5		
Other Devices	8	12	PB0~PB7		

The accompanying block diagram shows the overall internal structure of the A/D converter, together with its associated registers.

A/D Converter Data Registers - ADRL, ADRH

The device, which has an internal 12-bit A/D converter, requires two data registers, a high byte register, known as ADRH, and a low byte register, known as ADRL. After the conversion process takes place, these registers can be directly read by the microcontroller to obtain the digitised conversion value. Only the high byte register, ADRH, utilises its full 8-bit contents. The low byte register utilises only 4 bit of its 8-bit contents as it contains only the lowest bits of the 12-bit converted value.

In the following table, D0~D11 is the A/D conversion data result bits.

Register	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
ADRL	D3	D2	D1	D0	_	_	_	_
ADRH	D11	D10	D9	D8	D7	D6	D5	D4

A/D Data Registers

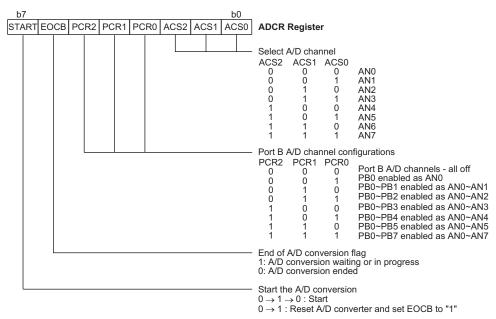
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A/D Converter Control Registers - ADCR, ACSR

To control the function and operation of the A/D converter, two control registers known as ADCR and ACSR are provided. These 8-bit registers define functions such as the selection of which analog channel is connected to the internal A/D converter, which pins are used as analog inputs and which are used as normal I/Os, the A/D clock source as well as controlling the start function and monitoring the A/D converter end of conversion status.

The ACS2~ACS0 bits in the ADCR register define the channel number. As the device contains only one actual analog to digital converter circuit, each of the individual 8 analog inputs must be routed to the converter. It is the function of the ACS2~ACS0 bits in the ADCR register to determine which analog channel is actually connected to the internal A/D converter.

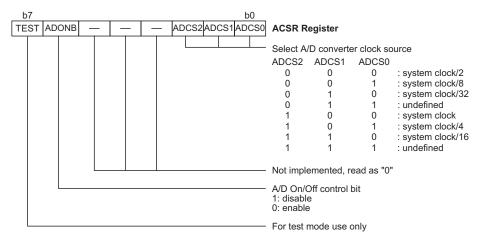
The ADCR control register also contains the PCR2~PCR0 bits which determine which pins on Port B are used as analog inputs for the A/D converter and which pins are to be used as normal I/O pins. If the 3-bit address on PCR2~PCR0 has a value of "111", then all eight pins, namely AN0~AN7 will all be set as analog inputs. Note that if the PCR2~PCR0 bits are all set to zero, then all the Port B pins will be setup as normal I/Os and the internal A/D converter circuitry will be powered off to reduce the power consumption.



A/D Converter Control Register - ADCR

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A/D Converter Control Register - ACSR

The START bit in the register is used to start and reset the A/D converter. When the microcontroller sets this bit from low to high and then low again, an analog to digital conversion cycle will be initiated. When the START bit is brought from low to high but not low again, the EOCB bit in the ADCR register will be set to a "1" and the analog to digital converter will be reset. It is the START bit that is used to control the overall on/off operation of the internal analog to digital converter.

The EOCB bit in the ADCR register is used to indicate when the analog to digital conversion process is complete. This bit will be automatically set to "0" by the microcontroller after a conversion cycle has ended. In addition, the corresponding A/D interrupt request flag will be set in the interrupt control register, and if the interrupts are enabled, an appropriate internal interrupt signal will be generated. This A/D internal interrupt signal will direct the program flow to the associated A/D internal interrupt address for processing. If the A/D internal interrupt is disabled, the microcontroller can be used to poll the EOCB bit in the ADCR register to check whether it has been cleared as an alternative method of detecting the end of an A/D conversion cycle.

The clock source for the A/D converter, which originates from the system clock f_{SYS} , is first divided by a division ratio, the value of which is determined by the ADCS2, ADCS1 and ADCS0 bits in the ACSR register.

Controlling the on/off function of the A/D converter circuitry is implemented using the ADONB bit in the ACSR register and the value of the PCR bits in the ADCR register. Both the ADONB bit must cleared to "0" and the value of the PCR bits must have a non-zero value for the A/D converter to be enabled.

PCR	ADONB	A/D
0	х	Off
> 0	0	On
> 0	1	Off



Although the A/D clock source is determined by the system clock f_{SYS} , and by bits ADCS2, ADCS1 and ADCS0, there are some limitations on the maximum A/D clock source speed that can be selected. As the minimum value of permissible A/D clock period, t_{AD} , is $0.5\mu s$, care must be taken for system clock speeds in excess of 4MHz. For system clock speeds in excess of 4MHz, the ADCS2, ADCS1 and ADCS0 bits should not be set to "000". Doing so will give A/D clock periods that are less than the minimum A/D clock period which may result in inaccurate A/D conversion values. Refer to the following table for examples, where values marked with an asterisk * show where, depending upon the device, special care must be taken, as the values may be less than the specified minimum A/D Clock Period.

	A/D Clock Period (t _{AD})			
fsys	ADCS2, ADCS1, ADCS0=000 (fsys/2)	ADCS2, ADCS1, ADCS0=001 (fsys/8)	ADCS2, ADCS1, ADCS0=010 (fsys/32)	ADCS2, ADCS1, ADCS0=011
1MHz	2µs	8µs	32µs	Undefined
2MHz	1µs	4µs	16µs	Undefined
4MHz	500ns	2µs	8µs	Undefined
8MHz	250ns*	1µs	4µs	Undefined
12MHz	167ns*	667ns	2.67µs	Undefined

A/D Clock Period Examples

A/D Input Pins

All of the A/D analog input pins are pin-shared with the I/O pins on Port B. Bits PCR2~PCR0 in the ADCR register, determine whether the input pins are setup as normal Port B input/output pins or whether they are setup as analog inputs. In this way, pins can be changed under program control to change their function from normal I/O operation to analog inputs and vice versa. Pull-high resistors, which are setup through register programming, apply to the input pins only when they are used as normal I/O pins, if setup as A/D inputs the pull-high resistors will be automatically disconnected. Note that it is not necessary to first setup the A/D pin as an input in the PBC port control register to enable the A/D input as when the PCR2~PCR0 bits enable an A/D input, the status of the port control register will be overridden. The A/D converter has its own power supply pins AVDD and AVSS and a VREF reference pin. The analog input values must not be allowed to exceed the value of VREF.

Initialising the A/D Converter

The internal A/D converter must be initialised in a special way. Each time the Port B A/D channel selection bits are modified by the program, the A/D converter must be re-initialised. If the A/D converter is not initialised after the channel selection bits are changed, the EOCB flag may have an undefined value, which may produce a false end of conversion signal. To initialise the A/D converter after the channel selection bits have changed, then, within a time frame of one to ten instruction cycles, the START bit in the ADCR register must first be set high and then immediately cleared to zero. This will ensure that the EOCB flag is correctly set to a high condition.



Summary of A/D Conversion Steps

The following summarises the individual steps that should be executed in order to implement an A/D conversion process.

• Step 1

Select the required A/D conversion clock by correctly programming bits ADCS2, ADCS1 and ADCS0 in the ACSR register.

Step 2

Enable the A/D by clearing the ADONB in the ACSR register to zero.

• Step 3

Select which channel is to be connected to the internal A/D converter by correctly programming the ACS2~ACS0 bits which are also contained in the ADCR register.

• Step 4

Select which pins on Port B are to be used as A/D inputs and configure them as A/D input pins by correctly programming the PCR2~PCR0 bits in the ADCR register. Note that this step can be combined with Step 2 into a single ADCR register programming operation.

• Step 5

If the interrupts are to be used, the interrupt control registers must be correctly configured to ensure the A/D converter interrupt function is active. The master interrupt control bit, EMI, in the INTC0 interrupt control register must be set to "1", the multi-function interrupt enable bit, EMFI, in the INTC1 register and the A/D converter interrupt bit, EADI, in the INTC1 register must also be set to "1".

• Step 6

The analog to digital conversion process can now be initialised by setting the START bit in the ADCR register from "0" to "1" and then to "0" again. Note that this bit should have been originally set to "0".

• Step 7

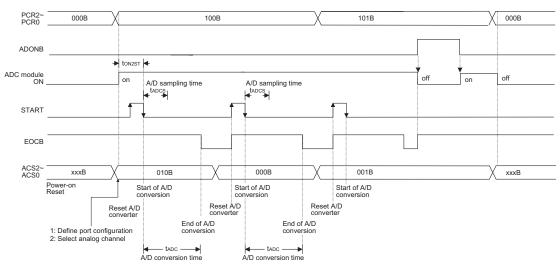
To check when the analog to digital conversion process is complete, the EOCB bit in the ADCR register can be polled. The conversion process is complete when this bit goes low. When this occurs the A/D data registers ADRL and ADRH can be read to obtain the conversion value. As an alternative method if the interrupts are enabled and the stack is not full, the program can wait for an A/D interrupt to occur.

Note: When checking for the end of the conversion process, if the method of polling the EOCB bit in the ADCR register is used, the interrupt enable step above can be omitted.

The accompanying diagram shows graphically the various stages involved in an analog to digital conversion process and its associated timing.

The setting up and operation of the A/D converter function is fully under the control of the application program as there are no configuration options associated with the A/D converter. After an A/D conversion process has been initiated by the application program, the microcontroller internal hardware will begin to carry out the conversion, during which time the program can continue with other functions. The time taken for the A/D conversion is $16t_{AD}$ where t_{AD} is equal to the A/D clock period.





Note: A/D clock must be fsys, fsys/2, fsys/4, fsys/8, fsys/16 or fsys/32 tapcs=4tap

tabc= tabcs+n*tab; n=bit count of ADC resolution

A/D Conversion Timing

Programming Considerations

When programming, special attention must be given to the A/D channel selection bits in the ADCR register. If these bits are all cleared to zero no external pins will be selected for use as A/D input pins allowing the pins to be used as normal I/O pins. When this happens the power supplied to the internal A/D circuitry will be reduced resulting in a reduction of supply current. This ability to reduce power by turning off the internal A/D function by clearing the A/D channel selection bits may be an important consideration in battery powered applications. The ADONB bit in the ACSR register can also be used to power down the A/D function.

Another important programming consideration is that when the A/D channel selection bits change value, the A/D converter must be re-initialised. This is achieved by pulsing the START bit in the ADCR register immediately after the channel selection bits have changed state. The exception to this is where the channel selection bits are all cleared, in which case the A/D converter is not required to be re-initialised.



A/D Programming Example

The following two programming examples illustrate how to setup and implement an A/D conversion. In the first example, the method of polling the EOCB bit in the ADCR register is used to detect when the conversion cycle is complete, whereas in the second example, the A/D interrupt is used to determine when the conversion is complete.

Example: using an EOCB polling method to detect the end of conversion

```
clr EADI
                            ; disable ADC interrupt
    mov a,00000001B
    mov ACSR, a
                           ; select f_{\text{SYS}}/8 as A/D clock and turn on ADONB bit
    mov a,00100000B
                           ; setup ADCR register to configure Port PBO~PB3 as A/D inputs
    mov ADCR, a
                           ; and select ANO to be connected to the A/D converter
       :
                           ; As the Port B channel bits have changed the following
                            ; START signal (0-1-0) must be issued instruction cycles
Start conversion:
    clr START
    set START
                           ; reset A/D
    clr START
                            ; start A/D
Polling EOC:
    sz EOCB
                           ; poll the ADCR register EOCB bit to detect end
                            ; of A/D conversion
                           ; continue polling
    jmp polling EOC
                           ; read low byte conversion result value
    mov a, ADRL
                           ; save result to user defined register
    mov adrl buffer, a
                           ; read high byte conversion result value
    mov a, ADRH
                           ; save result to user defined register
    mov adrh buffer,a
    jmp start conversion ; start next A/D conversion
```



Example: using the interrupt method to detect the end of conversion

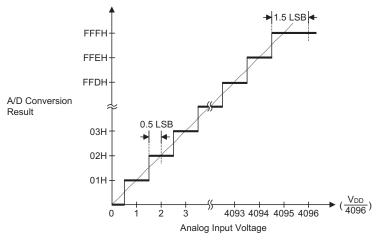
```
clr EADI
                             ; disable ADC interrupt
    mov a,00000001B
    mov ACSR, a
                            ; select f_{\text{SYS}}/8 as A/D clock and turn on ADONB bit
    mov a,00100000B
                            ; setup ADCR register to configure Port PB0~PB3 as A/D inputs
    mov ADCR, a
                             ; and select ANO to be connected to the A/D
      :
                             ; As the Port B channel bits have changed the
                             ; following START signal(0-1-0) must be issued
        :
Start conversion:
    clr START
                            ; reset A/D
    set START
    clr START
                            ; start A/D
                            ; clear ADC interrupt request flag
    clr ADF
    set EADI
                           ; enable ADC interrupt
    set EMFI
                           ; enable multi-function interrupt
     set EMI
                           ; enable global interrupt
       :
                             ; ADC interrupt service routine
ADC :
    mov acc stack, a
                            ; save ACC to user defined memory
    a,STATUS
                            ; save STATUS to user defined memory
     mov status_stack,a
       :
    mov a, ADKL mov adrl_buffer, a
     mov a, ADRL
                            ; read low byte conversion result value
                            ; save result to user defined register
                            ; read high byte conversion result value
     mov a, ADRH
     mov adrh buffer,a ; save result to user defined register
EXIT ISR:
    mov a, status stack
    mov STATUS,a ; restore STATUS from user defined memory mov a,acc_stack ; restore ACC from user defined memory
    clr ADF
                            ; clear ADC interrupt flag
    reti
```



A/D Transfer Function

As the device contain a 12-bit A/D converter, its full-scale converted digitised value is equal to FFFH. Since the full-scale analog input value is equal to the V_{DD} voltage, this gives a single bit analog input value of $V_{DD}/4096$. The diagram show the ideal transfer function between the analog input value and the digitised output value for the A/D converter.

Note that to reduce the quantisation error, a 0.5~LSB offset is added to the A/D Converter input. Except for the digitised zero value, the subsequent digitised values will change at a point 0.5~LSB below where they would change without the offset, and the last full scale digitised value will change at a point 1.5~LSB below the V_{DD} level.



Ideal A/D Transfer Function



Serial Interface Function

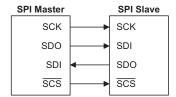
The device contains a Serial Interface Function, which includes both the four line SPI interface and the two line I²C interface types, to allow an easy method of communication with external peripheral hardware. Having relatively simple communication protocols, these serial interface types allow the microcontroller to interface to external SPI or I²C based hardware such as sensors, Flash or EEPROM memory, etc. The SIM interface pins are pin-shared with other I/O pins therefore the SIM interface function must first be selected using a configuration option. As both interface types share the same pins and registers, the choice of whether the SPI or I²C type is used is made using a bit in an internal register.

HT56R62/HT56R65

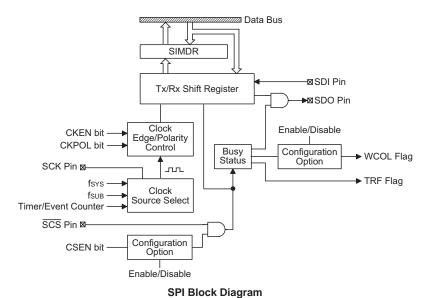
SPI Interface

The SPI interface is often used to communicate with external peripheral devices such as sensors, Flash or EEPROM memory devices etc. Originally developed by Motorola, the four line SPI interface is a synchronous serial data interface that has a relatively simple communication protocol simplifying the programming requirements when communicating with external hardware devices.

The communication is full duplex and operates as a slave/master type, where the MCU can be either master or slave. Although the SPI interface specification can control multiple slave devices from a single master, here, as only a single select pin, SCS, is provided only one slave device can be connected to the SPI bus.



SPI Master/Slave Connection



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SPI Interface Operation

The SPI interface is a full duplex synchronous serial data link. It is a four line interface with pin names SDI, SDO, SCK and \overline{SCS} . Pins SDI and SDO are the Serial Data Input and Serial Data Output lines, SCK is the Serial Clock line and \overline{SCS} is the Slave Select line. As the SPI interface pins are pin-shared with normal I/O pins and with the I²C function pins, the SPI interface must first be enabled by selecting the SIM enable configuration option and setting the correct bits in the SIMCTL0/SIMCTL2 register. After the SPI configuration option has been configured it can also be additionally disabled or enabled using the SIMEN bit in the SIMCTL0 register. Communication between devices connected to the SPI interface is carried out in a slave/master mode with all data transfer initiations being implemented by the master. The Master also controls the clock signal. As the device only contains a single \overline{SCS} pin only one slave device can be utilised.

The SPI function in this device offers the following features:

- · Full duplex synchronous data transfer
- · Both Master and Slave modes
- LSB first or MSB first data transmission modes
- · Transmission complete flag
- · Rising or falling active clock edge
- · WCOL and CSEN bit enabled or disable select

The status of the SPI interface pins is determined by a number of factors such as whether the device is in the master or slave mode and upon the condition of certain control bits such as CSEN, SIMEN and \overline{SCS} . In the table I, Z represents an input floating condition.

There are several configuration options associated with the SPI interface. One of these is to enable the SIM function which selects the SIM pins rather than normal I/O pins. Note that if the configuration option does not select the SIM function then the SIMEN bit in the SIMCTL0 register will have no effect. Another two SIM configuration options determine if the CSEN and WCOL bits are to be used.

Configuration Option	Function
SIM Function	SIM interface or I/O pins
SPI CSEN bit	Enable/Disable
SPI WCOL bit	Enable/Disable

SPI Interface Configuration Options



SPI Registers

There are three internal registers which control the overall operation of the SPI interface. These are the SIMDR data register and two control registers SIMCTL0 and SIMCTL2. Note that the SIMCTL1 register is only used by the I²C interface.

The SIMDR register is used to store the data being transmitted and received. The same register is used by both the SPI and I²C functions. Before the microcontroller writes data to the SPI bus, the actual data to be transmitted must be placed in the SIMDR register. After the data is received from the SPI bus, the microcontroller can read it from the SIMDR register. Any transmission or reception of data from the SPI bus must be made via the SIMDR register.

Bit	7	6	5	4	3	2	1	0
Label	SD7	SD6	SD5	SD4	SD3	SD2	SD1	SD0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	X	Х	X	Х	Χ	X	Χ	X

There are also two control registers for the SPI interface, SIMCTL0 and SIMCTL2. Note that the SIMCTL2 register also has the name SIMAR which is used by the I²C function. The SIMCTL1 register is not used by the SPI function, only by the I²C function. Register SIMCTL0 is used to control the enable/disable function and to set the data transmission clock frequency. Although not connected with the SPI function, the SIMCTL0 register is also used to control the Peripheral Clock prescaler. Register SIMCTL2 is used for other control functions such as LSB/MSB selection, write collision flag etc.

The following gives further explanation of each SIMCTL1 register bit:

• SIMIDLE

The SIMIDLE bit is used to select if the SPI interface continues running when the device is in the IDLE mode. Setting the bit high allows the SPI interface to maintain operation when the device is in the Idle mode. Clearing the bit to zero disables any SPI operations when in the Idle mode. This SPI/I²C idle mode control bit is located at CLKMOD register bit4.

SIMEN

The SIMEN bit is the overall on/off control for the SPI interface. When the SIMEN bit is cleared to zero to disable the SPI interface, the SDI, SDO, SCK and \overline{SCS} lines will be in a floating condition and the SPI operating current will be reduced to a minimum value. When the bit is high the SPI interface is enabled. The SIMEN configuration option must have first enabled the SIMEN interface for this bit to be effective. Note that when the SIMEN bit changes from low to high the contents of the SPI control registers will be in an unknown condition and should therefore be first initialised by the application program.



• SIM0~SIM2

These bits setup the overall operating mode of the SIM function. As well as selecting if the I²C or SPI function, they are used to control the SPI Master/Slave selection and the SPI Master clock frequency. The SPI clock is a function of the system clock but can also be chosen to be sourced from the Timer/Event Counter. If the SPI Slave Mode is selected then the clock will be supplied by an external Master device.

SIM0	SIM1	SIM2	SPI Master/Slave Clock Control and I ² C Enable
0	0	0	SPI Master, f _{SYS} /4
0	0	1	SPI Master, f _{SYS} /16
0	1	0	SPI Master, f _{SYS} /64
0	1	1	SPI Master, f _{SUB}
1	0	0	SPI Master Timer/Event Counter 0 output/2
1	0	1	SPI Slave
1	1	0	I ² C mode
1	1	0	Not used

SPI Control Register - SIMCTL2

The SIMCTL2 register is also used by the I²C interface but has the name SIMAR.

TRF

The TRF bit is the Transmit/Receive Complete flag and is set high automatically when an SPI data transmission is completed, but must be cleared by the application program. It can be used to generate an interrupt.

• WCOL

The WCOL bit is used to detect if a data collision has occurred. If this bit is high it means that data has been attempted to be written to the SIMDR register during a data transfer operation. This writing operation will be ignored if data is being transferred. The bit can be cleared by the application program. Note that using the WCOL bit can be disabled or enabled via configuration option.

CSEN

The CSEN bit is used as an on/off control for the \overline{SCS} pin. If this bit is low then the \overline{SCS} pin will be disabled and placed into a floating condition. If the bit is high the \overline{SCS} pin will be enabled and used as a select pin. Note that using the CSEN bit can be disabled or enabled via configuration option.

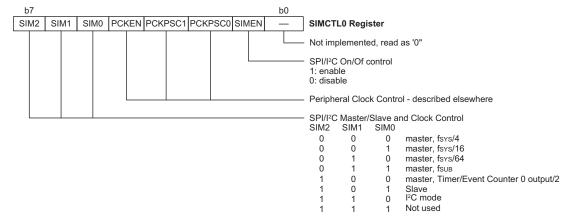
• MLS

This is the data shift select bit and is used to select how the data is transferred, either MSB or LSB first. Setting the bit high will select MSB first and low for LSB first.

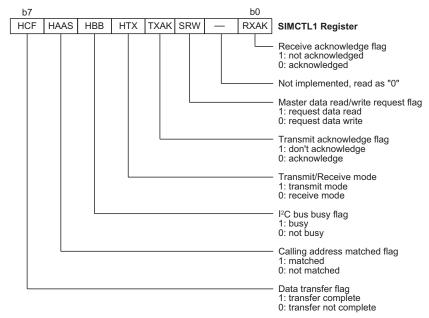
· CKEG and CKPOL

These two bits are used to setup the way that the clock signal outputs and inputs data on the SPI bus. These two bits must be configured before data transfer is executed otherwise an erroneous clock edge may be generated. The CKPOL bit determines the base condition of the clock line, if the bit is high then the SCK line will be low when the clock is inactive. When the CKPOL bit is low then the SCK line will be high when the clock is inactive. The CKEG bit determines active clock edge type which depends upon the condition of CKPOL.

CKPOL	CKEG	SCKClock Signal
0	0	High Base Level Active Rising Edge
0	1	High Base Level Active Falling Edge
1	0	Low Base Level Active Falling Edge
1	1	Low Base Level Active Rising Edge

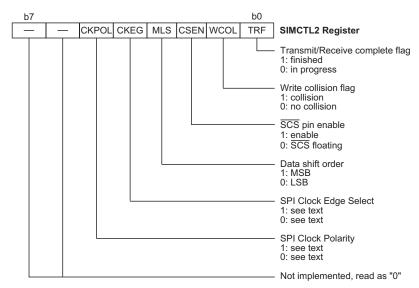


SPI/I²C Control Register - SIMCTL0



I²C Control Register - SIMCTL1



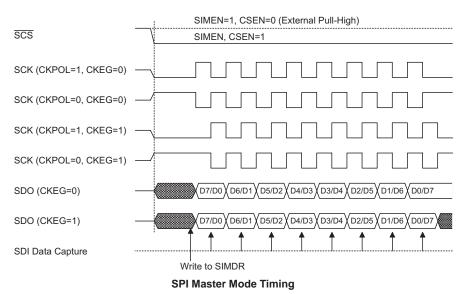


SPI Control Register - SIMCTL2

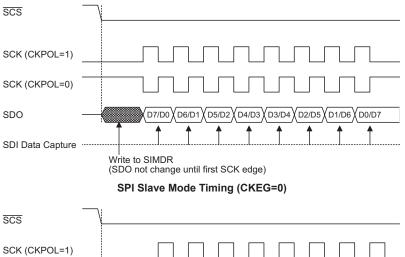
SPI Communication

After the SPI interface is enabled by setting the SIMEN bit high, then in the Master Mode, when data is written to the SIMDR register, transmission/reception will begin simultaneously. When the data transfer is complete, the TRF flag will be set automatically, but must be cleared using the application program. In the Slave Mode, when the clock signal from the master has been received, any data in the SIMDR register will be transmitted and any data on the SDI pin will be shifted into the SIMDR register. The master should output an \overline{SCS} signal to enable the slave device before a clock signal is provided and slave data transfers should be enabled/disabled before/after an \overline{SCS} signal is received.

The SPI will continue to function even after a HALT instruction has been executed.



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SCK (CKPOL=1)

SCK (CKPOL=0)

D7/D0 \(D6/D1 \) \(D5/D2 \) \(D4/D3 \) \(D3/D4 \) \(D2/D5 \) \(D1/D6 \) \(D0/D7 \)

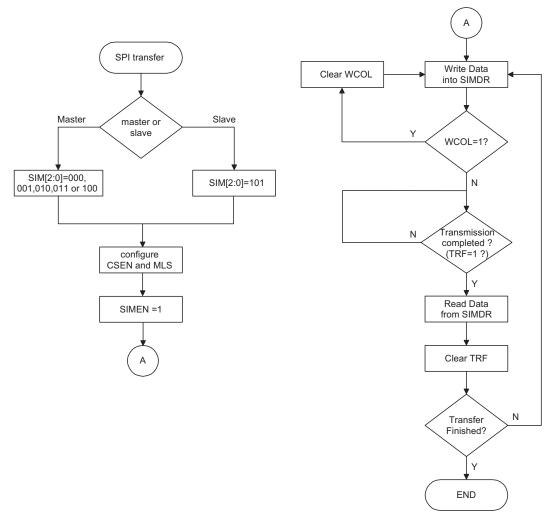
SDI Data Capture

Write to SIMDR
(SDO change as soon as writing occur; SDO=floating if SCS=1)

Note: For SPI slave mode, if SIMEN=1 and CSEN=0, SPI is always enabled and ignore the \overline{SCS} level.

SPI Slave Mode Timing (CKEG=1)





SPI Transfer Control Flowchart

I²C Interface

The 1²C interface is used to communicate with external peripheral devices such as sensors, EEPROM memory etc. Originally developed by Philips, it is a two line low speed serial interface for synchronous serial data transfer. The advantage of only two lines for communication, relatively simple communication protocol and the ability to accommodate multiple devices on the same bus has made it an extremely popular interface type for many applications.

I²C Interface Operation

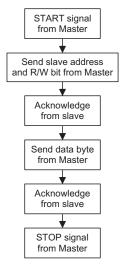
The I²C serial interface is a two line interface, a serial data line, SDA, and serial clock line, SCL. As many devices may be connected together on the same bus, their outputs are both open drain types. For this reason it is necessary that external pull-high resistors are connected to these outputs. Note that no chip select line exists, as each device on the I²C bus is identified by a unique address which will be transmitted and received on the I²C bus.

When two devices communicate with each other on the bidirectional I²C bus, one is known as the master device and one as the slave device. Both master and slave can transmit and receive data, however, it is the master device that has overall control of the bus. For these devices, which only operates in slave mode, there are two methods of transferring data on the I²C bus, the slave transmit mode and the slave receive mode.

There are several configuration options associated with the I²C interface. One of these is to enable the function which selects the SIM pins rather than normal I/O pins. Note that if the configuration option does not select the SIM function then the SIMEN bit in the SIMCTL0 register will have no effect. A configuration option exists to allow a clock other than the system clock to drive the I²C interface. Another configuration option determines the debounce time of the I²C interface. This uses the internal clock to in effect add a debounce time to the external clock to reduce the possibility of glitches on the clock line causing erroneous operation. The debounce time, if selected, can be chosen to be either 1 or 2 system clocks.

SIM	Function	
SIM function	interface or SEG pins	
I ² C clock	I ² C runs without internal clock Disable/Enable	
I ² C debounce	No debounce, 1 system clock; 2 system clocks	

I²C Interface Configuration Options





I²C Registers

There are three control registers associated with the I²C bus, SIMCTL0, SIMCTL1 and SIMAR and one data register, SIMDR. The SIMDR register, which is shown in the above SPI section, is used to store the data being transmitted and received on the I²C bus. Before the microcontroller writes data to the I²C bus, the actual data to be transmitted must be placed in the SIMDR register. After the data is received from the I²C bus, the microcontroller can read it from the SIMDR register. Any transmission or reception of data from the I²C bus must be made via the SIMDR register.

Note that the SIMAR register also has the name SIMCTL2 which is used by the SPI function. Bits SIMIDLE, SIMEN and bits SIM0~SIM2 in register SIMCTL0 are used by the I²C interface. The SIMCTL0 register is shown in the above SPI section.

SIMIDLE

The SIMIDLE bit is used to select if the I²C interface continues running when the device is in the IDLE mode. Setting the bit high allows the I²C interface to maintain operation when the device is in the Idle mode. Clearing the bit to zero disables any I²C operations when in the Idle mode. This SPI/I²C idle mode control bit is located at CLKMOD register bit4.

SIMEN

The SIMEN bit is the overall on/off control for the I²C interface. When the SIMEN bit is cleared to zero to disable the I²C interface, the SDA and SCL lines will be in a floating condition and the I²C operating current will be reduced to a minimum value. In this condition the pins can be used as SEG functions. When the bit is high the I²C interface is enabled. The SIM configuration option must have first enabled the SIM interface for this bit to be effective. Note that when the SIMEN bit changes from low to high the contents of the I²C control registers will be in an unknown condition and should therefore be first initialised by the application program

SIM0~SIM2

These bits setup the overall operating mode of the SIM function. To select the I²C function, bits SIM2~SIM0 should be set to the value 110.

RXAK

The RXAK flag is the receive acknowledge flag. When the RXAK bit has been reset to zero it means that a correct acknowledge signal has been received at the 9th clock, after 8 bits of data have been transmitted. When in the transmit mode, the transmitter checks the RXAK bit to determine if the receiver wishes to receive the next byte. The transmitter will therefore continue sending out data until the RXAK bit is set high. When this occurs, the transmitter will release the SDA line to allow the master to send a STOP signal to release the bus.

• SRW

The SRW bit is the Slave Read/Write bit. This bit determines whether the master device wishes to transmit or receive data from the I²C bus. When the transmitted address and slave address match, that is when the HAAS bit is set high, the device will check the SRW bit to determine whether it should be in transmit mode or receive mode. If the SRW bit is high, the master is requesting to read data from the bus, so the device should be in transmit mode. When the SRW bit is zero, the master will write data to the bus, therefore the device should be in receive mode to read this data.

TXAK

The TXAK flag is the transmit acknowledge flag. After the receipt of 8-bit of data, this bit will be transmitted to the bus on the 9th clock. To continue receiving more data, this bit has to be reset to zero before further data is received.

HTX

The HTX flag is the transmit/receive mode bit. This flag should be set high to set the transmit mode and low for the receive mode.



HBB

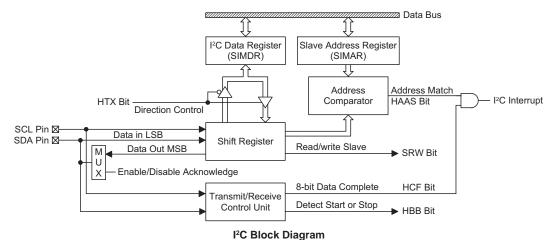
The HBB flag is the I²C busy flag. This flag will be high when the I²C bus is busy which will occur when a START signal is detected. The flag will be reset to zero when the bus is free which will occur when a STOP signal is detected.

HASS

The HAAS flag is the address match flag. This flag is used to determine if the slave device address is the same as the master transmit address. If the addresses match then this bit will be high, if there is no match then the flag will be low.

HCF

The HCF flag is the data transfer flag. This flag will be zero when data is being transferred. Upon completion of an 8-bit data transfer the flag will go high and an interrupt will be generated.



I O Block Bla

I²C Control Register - SIMAR

The SIMAR register is also used by the SPI interface but has the name SIMCTL2.

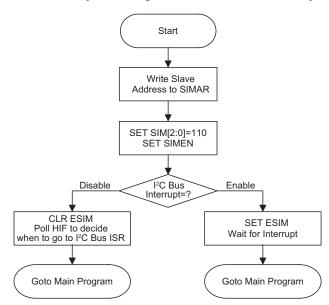
The SIMAR register is the location where the 7-bit slave address of the microcontroller is stored. Bits 1~7 of the SIMAR register define the microcontroller slave address. Bit 0 is not defined. When a master device, which is connected to the I²C bus, sends out an address, which matches the slave address in the SIMAR register, the microcontroller slave device will be selected. Note that the SIMAR register is the same register as SIMCTL2 which is used by the SPI interface.



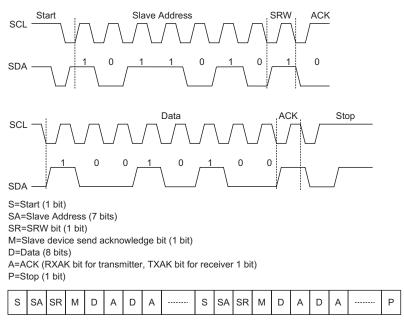
I²C Bus Communication

Communication on the I²C bus requires four separate steps, a START signal, a slave device address transmission, a data transmission and finally a STOP signal. When a START signal is placed on the I²C bus, all devices on the bus will receive this signal and be notified of the imminent arrival of data on the bus. The first seven bits of the data will be the slave address with the first bit being the MSB. If the address of the microcontroller matches that of the transmitted address, the HAAS bit in the SIMCTL1 register will be set and an I²C interrupt will be generated. After entering the interrupt service routine, the microcontroller slave device must first check the condition of the HAAS bit to determine whether the interrupt source originates from an address match or from the completion of an 8-bit data transfer. During a data transfer, note that after the 7-bit slave address has been transmitted, the following bit, which is the 8th bit, is the read/write bit whose value will be placed in the SRW bit. This bit will be checked by the microcontroller to determine whether to go into transmit or receive mode. Before any transfer of data to or from the I²C bus, the microcontroller must initialise the bus, the following are steps to achieve this:

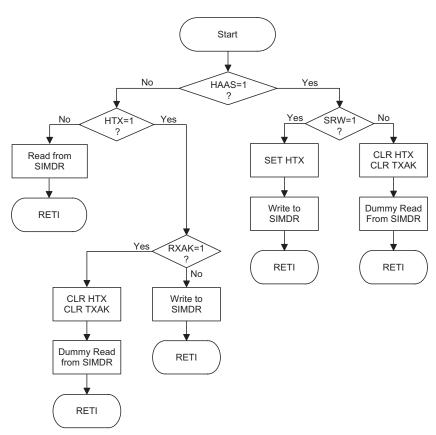
- Step 1
 Write the slave address of the microcontroller to the I²C bus address register SIMAR.
- Step 2
 Set the SIMEN bit in the SIMCTL0 register to "1" to enable the I²C bus.
- Step 3
 Set the ESIM bit of the interrupt control register to enable the I²C bus interrupt.



I²C Bus Initialisation Flow Chart



I²C Communication Timing Diagram



I2C Bus ISR Flow Chart



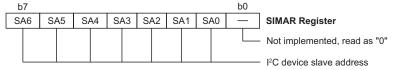
Start Signal

The START signal can only be generated by the master device connected to the I²C bus and not by the microcontroller, which is only a slave device. This START signal will be detected by all devices connected to the I²C bus. When detected, this indicates that the I²C bus is busy and therefore the HBB bit will be set. A START condition occurs when a high to low transition on the SDA line takes place when the SCL line remains high.

Slave Address

The transmission of a START signal by the master will be detected by all devices on the I²C bus. To determine which slave device the master wishes to communicate with, the address of the slave device will be sent out immediately following the START signal. All slave devices, after receiving this 7-bit address data, will compare it with their own 7-bit slave address. If the address sent out by the master matches the internal address of the microcontroller slave device, then an internal I²C bus interrupt signal will be generated. The next bit following the address, which is the 8th bit, defines the read/write status and will be saved to the SRW bit of the SIMCTL1 register. The device will then transmit an acknowledge bit, which is a low level, as the 9th bit. The microcontroller slave device will also set the status flag HAAS when the addresses match.

As an I²C bus interrupt can come from two sources, when the program enters the interrupt subroutine, the HAAS bit should be examined to see whether the interrupt source has come from a matching slave address or from the completion of a data byte transfer. When a slave address is matched, the device must be placed in either the transmit mode and then write data to the SIMDR register, or in the receive mode where it must implement a dummy read from the SIMDR register to release the SCL line.



I²C Slave Address Register – SIMAR

SRW Bit

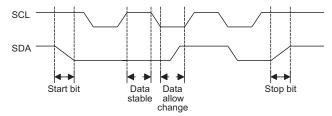
The SRW bit in the SIMCTL1 register defines whether the microcontroller slave device wishes to read data from the I²C bus or write data to the I²C bus. The microcontroller should examine this bit to determine if it is to be a transmitter or a receiver. If the SRW bit is set to "1" then this indicates that the master wishes to read data from the I²C bus, therefore the microcontroller slave device must be setup to send data to the I²C bus as a transmitter. If the SRW bit is "0" then this indicates that the master wishes to send data to the I²C bus, therefore the microcontroller slave device must be setup to read data from the I²C bus as a receiver.

Acknowledge Bit

After the master has transmitted a calling address, any slave device on the I²C bus, whose own internal address matches the calling address, must generate an acknowledge signal. This acknowledge signal will inform the master that a slave device has accepted its calling address. If no acknowledge signal is received by the master then a STOP signal must be transmitted by the master to end the communication. When the HAAS bit is high, the addresses have matched and the microcontroller slave device must check the SRW bit to determine if it is to be a transmitter or a receiver. If the SRW bit is high, the microcontroller slave device should be setup to be a transmitter so the HTX bit in the SIMCTL1 register should be set to "1" if the SRW bit is low then the microcontroller slave device should be setup as a receiver and the HTX bit in the SIMCTL1 register should be set to "0".

Data Byte

The transmitted data is 8-bit wide and is transmitted after the slave device has acknowledged receipt of its slave address. The order of serial bit transmission is the MSB first and the LSB last. After receipt of 8-bit of data, the receiver must transmit an acknowledge signal, level "0", before it can receive the next data byte. If the transmitter does not receive an acknowledge bit signal from the receiver, then it will release the SDA line and the master will send out a STOP signal to release control of the I²C bus. The corresponding data will be stored in the SIMDR register. If setup as a transmitter, the microcontroller slave device must first write the data to be transmitted into the SIMDR register. If setup as a receiver, the microcontroller slave device must read the transmitted data from the SIMDR register.



Data Timing Diagram

Receive Acknowledge Bit

When the receiver wishes to continue to receive the next data byte, it must generate an acknowledge bit, known as TXAK, on the 9th clock. The microcontroller slave device, which is setup as a transmitter will check the RXAK bit in the SIMCTL1 register to determine if it is to send another data byte, if not then it will release the SDA line and await the receipt of a STOP signal from the master.

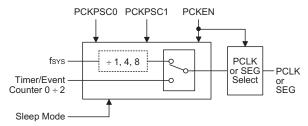


Peripheral Clock Output

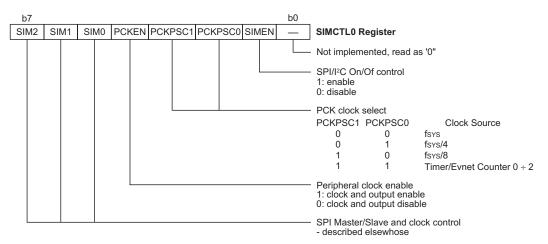
The Peripheral Clock Output allows the device to supply external hardware with a clock signal synchronised to the microcontroller clock.

Peripheral Clock Operation

As the peripheral clock output pin,, is shared with one of the LCD segment lines, the required pin function is chosen via in SIMCTL0 register. The Peripheral Clock function is controlled using the SIMCTL0 register. The clock source for the Peripheral Clock Output can originate from either the Timer/Event Counter 0 divided by two or a divided ratio of the internal f_{SYS} clock. The bit in the SIMCTL0 register is the overall on/off control, setting the bit high enables the Peripheral Clock, clearing it disables it. The required division ratio of the system clock is selected using the PCKPSC0 and PCKPSC1 bits in the same register. If the system enters the Sleep Mode this will disable the Peripheral Clock output.



Peripheral Clock Block Diagram



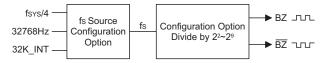
Peripheral Clock Output Control - SIMCTL0

Buzzer

Operating in a similar way to the Programmable Frequency Divider, the Buzzer function provides a means of producing a variable frequency output, suitable for applications such as Piezo-buzzer driving or other external circuits that require a precise frequency generator. The BZ and \overline{BZ} pins form a complementary pair, and are pin-shared with I/O pins, PA0 and PA1. A configuration option is used to select from one of three buzzer options. The first option is for both pins PA0 and PA1 to be used as normal I/Os, the second option is for both pins to be configured as BZ and \overline{BZ} buzzer pins, the third option selects only the PA0 pin to be used as a BZ buzzer pin with the PA1 pin retaining its normal I/O pin function. Note that the \overline{BZ} pin is the inverse of the BZ pin which together generate a differential output which can supply more power to connected interfaces such as buzzers.

The buzzer is driven by the internal clock source,, which then passes through a divider, the division ratio of which is selected by configuration options to provide a range of buzzer frequencies from $f_s/2^2$ to $f_s/2^9$. The clock source that generates f_s , which in turn controls the buzzer frequency, can originate from three different sources, the 32768Hz oscillator, the 32K_INT oscillator or the System oscillator/4, the choice of which is determined by the f_s clock source configuration option. Note that the buzzer frequency is controlled by configuration options, which select both the source clock for the internal clock f_s and the internal division ratio. There are no internal registers associated with the buzzer frequency.

If the configuration options have selected both pins PA0 and PA1 to function as a BZ and \overline{BZ} complementary pair of buzzer outputs, then for correct buzzer operation it is essential that both pins must be setup as outputs by setting bits PAC0 and PAC1 of the PAC port control register to zero. The PA0 data bit in the PA data register must also be set high to enable the buzzer outputs, if set low, both pins PA0 and PA1 will remain low. In this way the single bit PA0 of the PA register can be used as an on/off control for both the BZ and \overline{BZ} buzzer pin outputs. Note that the PA1 data bit in the PA register has no control over the \overline{BZ} buzzer pin PA1.



Buzzer Function

PA0/PA1 Pin Function Control

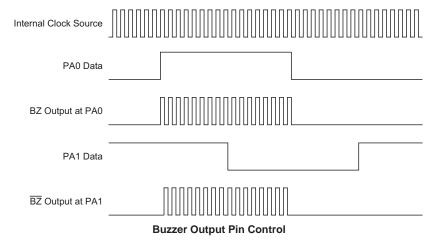
PAC Register PAC0	PAC Register PAC1	PA Data Register PA0	PA Data Register PA1	Output Function
0	0	1	x	PA0=BZ PA1=BZ
0	0	0	x	PA0="0" PA1="0"
0	1	1	х	PA0=BZ PA1=input line
0	1	0	х	PA0="0" PA1=input line
1	0	х	D	PA0=input line PA1=D
1	1	х	х	PA0=input line PA0=input line

[&]quot;x" stands for don't care; "D" stands for Data "0" or "1"



If configuration options have selected that only the PA0 pin is to function as a BZ buzzer pin, then the PA1 pin can be used as a normal I/O pin. For the PA0 pin to function as a BZ buzzer pin, PA0 must be setup as an output by setting bit PAC0 of the PAC port control register to zero. The PA0 data bit in the PA data register must also be set high to enable the buzzer output, if set low pin PA0 will remain low. In this way the PA0 bit can be used as an on/off control for the BZ buzzer pin PA0. If the PAC0 bit of the PAC port control register is set high, then pin PA0 can still be used as an input even though the configuration option has configured it as a BZ buzzer output.

Note that no matter what configuration option is chosen for the buzzer, if the port control register has setup the pin to function as an input, then this will override the configuration option selection and force the pin to always behave as an input pin. This arrangement enables the pin to be used as both a buzzer pin and as an input pin, so regardless of the configuration option chosen; the actual function of the pin can be changed dynamically by the application program by programming the appropriate port control register bit.



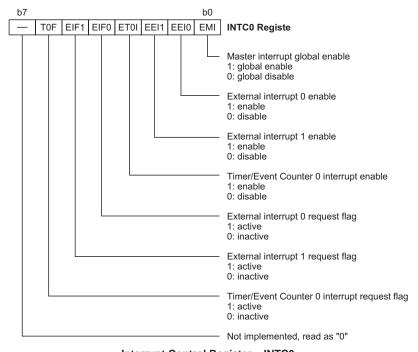
Note: The above drawing shows the situation where both pins PA0 and PA1 are selected by configuration option to be BZ and \overline{BZ} buzzer pin outputs. The Port Control Register of both pins must have already been setup as output. The data setup on pin PA1 has no effect on the buzzer outputs.

Interrupts

Interrupts are an important part of any microcontroller system. When an external event or an internal function such as a Timer/Event Counter or an A/D converter requires microcontroller attention, their corresponding interrupt will enforce a temporary suspension of the main program allowing the microcontroller to direct attention to their respective needs. The device contains several external interrupt and internal interrupts functions. The external interrupts are controlled by the action of the external INTO, INT1 and $\overline{\text{PINT}}$ pins, while the internal interrupts are controlled by the Timer/Event Counter overflows, the Time Base interrupt, the RTC interrupt, the SPI/I²C interrupt and the the A/D converter interrupt.

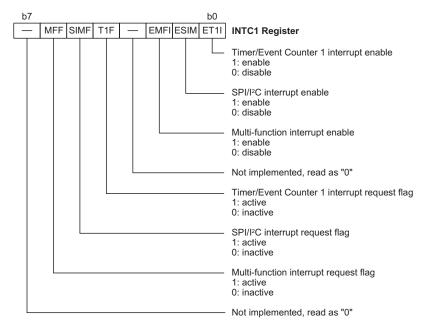
Interrupt Registers

Overall interrupt control, which means interrupt enabling and request flag setting, is controlled by the INTC0, INTC1, and MFIC/MFIC0/MFIC1 registers, which are located in the Data Memory. By controlling the appropriate enable bits in these registers each individual interrupt can be enabled or disabled. Also when an interrupt occurs, the corresponding request flag will be set by the microcontroller. The global enable flag if cleared to zero will disable all interrupts.

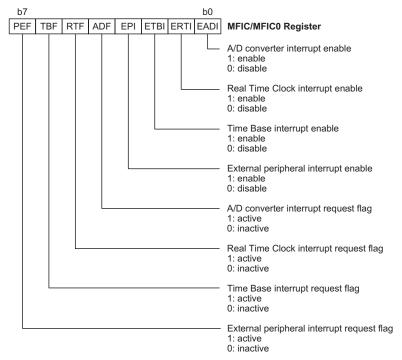


Interrupt Control Register – INTC0



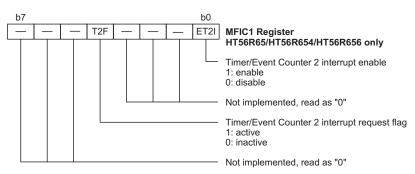


Interrupt Control Register - INTC1



Interrupt Control Register - MFIC/MFIC0





Interrupt Control Register - MFIC1

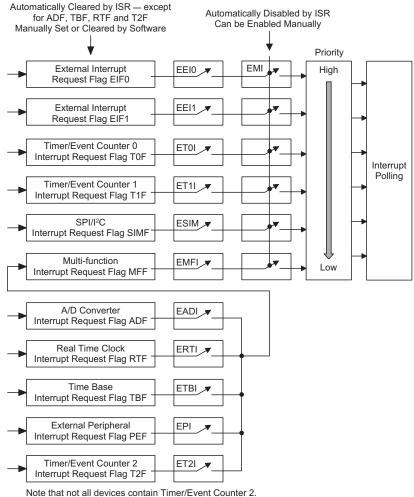
Interrupt Operation

A Timer/Event Counter overflow, Time Base, RTC overflow, SPI/I²C data transfer complete, an end of A/D conversion or the external interrupt line being triggered will all generate an interrupt request by setting their corresponding request flag. When this happens and if their appropriate interrupt enable bit is set, the Program Counter, which stores the address of the next instruction to be executed, will be transferred onto the stack. The Program Counter will then be loaded with a new address which will be the value of the corresponding interrupt vector. The microcontroller will then fetch its next instruction from this interrupt vector. The instruction at this vector will usually be a JMP statement which will jump to another section of program which is known as the interrupt service routine. Here is located the code to control the appropriate interrupt. The interrupt service routine must be terminated with a RETI statement, which retrieves the original Program Counter address from the stack and allows the microcontroller to continue with normal execution at the point where the interrupt occurred.

The various interrupt enable bits, together with their associated request flags, are shown in the accompanying diagram with their order of priority.

Once an interrupt subroutine is serviced, all the other interrupts will be blocked, as the EMI bit will be cleared automatically. This will prevent any further interrupt nesting from occurring. However, if other interrupt requests occur during this interval, although the interrupt will not be immediately serviced, the request flag will still be recorded. If an interrupt requires immediate servicing while the program is already in another interrupt service routine, the EMI bit should be set after entering the routine, to allow interrupt nesting. If the stack is full, the interrupt request will not be acknowledged, even if the related interrupt is enabled, until the Stack Pointer is decremented. If immediate service is desired, the stack must be prevented from becoming full.





Interrupt Structure

Interrupt Priority

Interrupts, occurring in the interval between the rising edges of two consecutive T2 pulses, will be serviced on the latter of the two T2 pulses, if the corresponding interrupts are enabled. In case of simultaneous requests, the following table shows the priority that is applied.

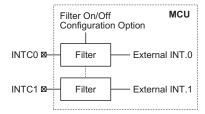
Interrupt Source	Priority	Vector
External Interrupt 0	1	04H
External Interrupt 1	2	08H
Timer/Event Counter 0 Overflow	3	0CH
Timer/Event Counter 1 Overflow	4	10H
SPI/I ² C Interrupt	5	14H
Multi-function Interrupt	6	18H

The A/D converter interrupt, Real Time clock interrupt, Time Base interrupt and External Peripheral interrupt all share the same interrupt vector which is 18H. Each of these interrupts have their own own individual interrupt flag but also share the same MFF interrupt flag. The MFF flag will be cleared by hardware once the Multi-function interrupt is serviced, however the individual interrupts that have triggered the Multi-function interrupt need to be cleared by the application program.

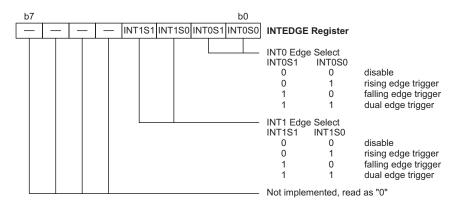
External Interrupt

For an external interrupt to occur, the global interrupt enable bit, EMI, and external interrupt enable bits, EEI0 and EEI1, must first be set. Additionally the correct interrupt edge type must be selected using the INTEDGE register to enable the external interrupt function and to choose the trigger edge type. An actual external interrupt will take place when the external interrupt request flag, EIF0 or EIF1, is set, a situation that will occur when a transition, whose type is chosen by the edge select bit, appears on the INT0 or INT1 pin. The external interrupt pins are pin-shared with the I/O pins PD4 and PD5 and can only be configured as external interrupt pins if their corresponding external interrupt enable bit in the INTC0 register has been set. The pin must also be setup as an input by setting the corresponding PDC.4 and PDC.5 bits in the port control register. When the interrupt is enabled, the stack is not full and the correct transition type appears on the external interrupt pin, a subroutine call to the external interrupt vector at location 04H or 08H, will take place. When the interrupt is serviced, the external interrupt request flags, EIF0 or EIF1, will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts. Note that any pull-high resistor selections on this pin will remain valid even if the pin is used as an external interrupt input.

The INTEDGE register is used to select the type of active edge that will trigger the external interrupt. A choice of either rising and falling edge types can be chosen along with an option to allow both edge types to trigger an external interrupt. Note that the INTEDGE register can also be used to disable the external interrupt function.







Interrupt Active Edge Register - INTEDGE

The external interrupt pins are connected to an internal filter to reduce the possibility of unwanted external interrupts due to adverse noise or spikes on the external interrupt input signal. As this internal filter circuit will consume a limited amount of power, a configuration option is provided to switch off the filter function, an option which may be beneficial in power sensitive applications, but in which the integrity of the input signal is high. Care must be taken when using the filter on/off configuration option as it will be applied not only to both the external interrupt pins but also to the Timer/Event Counter external input pins. Individual external interrupt or Timer/Event Counter pins cannot be selected to have a filter on/off function.

External Peripheral Interrupt

The External Peripheral Interrupt operates in a similar way to the external interrupt and is contained within the Multi-function interrupt.

For an external peripheral interrupt to occur, the global interrupt enable bit, EMI, external peripheral interrupt enable bit, EPI, and Multi-function interrupt enable bit, EMFI, must first be set. An actual external peripheral interrupt will take place when the external interrupt request flag, PEF, is set, a situation that will occur when a negative transition, appears on the PINT pin. The external peripheral interrupt pin is pin-shared with one of the segment pins, and is configured as a peripheral interrupt pin via a configuration option. When the interrupt is enabled, the stack is not full and a negative transition type appears on the external peripheral interrupt pin, a subroutine call to the Multi-function interrupt vector at location 18H, will take place. When the external peripheral interrupt is serviced, the EMI bit will be cleared to disable other interrupts, however only the MFF interrupt request flag will be reset. As the PEF flag will not be automatically reset, it has to be cleared by the application program.

Timer/Event Counter Interrupt

For a Timer/Event Counter 0 or Timer/Event Counter 1 interrupt to occur, the global interrupt enable bit, EMI, and the corresponding timer interrupt enable bit, ET0I or ET1I must first be set. An actual Timer/Event Counter interrupt will take place when the Timer/Event Counter request flag, T0F or T1F is set, a situation that will occur when the Timer/Event Counter overflows. When the interrupt is enabled, the stack is not full and a Timer/Event Counter overflow occurs, a subroutine call to the timer interrupt vector at location 0CH or 10H, will take place. When the interrupt is serviced, the timer interrupt request flag, T0F or T1F, will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts.

Timer Event Counter 0 and Timer/Event Counter 1 have their own individual interrupt vectors, however the interrupt vector for Timer/Event Counter 2 is contained within the Multi-function Interrupt. For a Timer/Event Counter 2 interrupt to occur, the global interrupt enable bit, EMI, Timer/Event Counter 2 interrupt enable bit, ET2I, and Multi-function interrupt enable bit, EMFI, must first be set. An actual external peripheral interrupt will take place when the Timer/Event Counter 2 request flag, T2F, is set, a situation that will occur when the Timer/Event Counter 2 overflows. When the interrupt is enabled, the stack is not full and the Timer/Event Counter 2 overflows, a subroutine call to the Multi-function interrupt vector at location 18H, will take place. When the Timer/Event 2 interrupt is serviced, the EMI bit will be cleared to disable other interrupts, however only the MFF interrupt request flag will be reset. As the T2F flag will not be automatically reset, it has to be cleared by the application program.

A/D Interrupt

The A/D Interrupt is contained within the Multi-function Interrupt.

For an A/D Interrupt to be generated, the global interrupt enable bit, EMI, A/D Interrupt enable bit, EADI, and Multi-function interrupt enable bit, EMFI, must first be set. An actual A/D Interrupt will take place when the A/D Interrupt request flag, ADF, is set, a situation that will occur when the A/D conversion process has finished. When the interrupt is enabled, the stack is not full and the A/D conversion process has ended, a subroutine call to the Multi-function interrupt vector at location 18H, will take place. When the A/D Interrupt is serviced, the EMI bit will be cleared to disable other interrupts, however only the MFF interrupt request flag will be reset. As the ADF flag will not be automatically reset, it has to be cleared by the application program.

SPI/I²C Interface Interrupt

For an SPI/I²C interrupt to occur, the global interrupt enable bit, EMI, and the corresponding interrupt enable bit, ESIM must be first set. An actual SPI/I²C interrupt will take place when the SPI/I²C interrupt request flag, SIMF, is set, a situation that will occur when a byte of data has been transmitted or received by the SPI/I²C interface or when an I²C address match occurs. When the interrupt is enabled, the stack is not full and a byte of data has been transmitted or received by the SPI/I²C interface or an I²C address match occurs, a subroutine call to the SPI/I²C interrupt vector at location 14H, will take place. When the interrupt is serviced, the SPI/I²C request flag, SIMF will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts.



Multi-function Interrupt

An additional interrupt known as the Multi-function interrupt is provided. Unlike the other interrupts, this interrupt has no independent source, but rather is formed from four or five other existing interrupt sources, namely the A/D Converter interrupt, Time Base interrupt, Real Time Clock interrupt, External Peripheral interrupt and the Timer 2 overflow interrupt.

For a Multi-function interrupt to occur, the global interrupt enable bit, EMI, and the Multi-function interrupt enable bit, EMFI, must first be set. An actual Multi-function interrupt will take place when the Multi-function interrupt request flag, MFF, is set. This will occur when either a Time Base overflow, a Real Time Clock overflow, an A/D conversion completion, an External Peripheral Interrupt or Timer 2 overflow interrupt is generated. When the interrupt is enabled and the stack is not full, and either one of the interrupts contained within the Multi-function interrupt occurs, a subroutine call to the Multi-function interrupt vector at location 018H will take place. When the interrupt is serviced, the Multi-Function request flag, MFF, will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts. However, it must be noted that the request flags from the original source of the Multi-function interrupt, namely the Time-Base interrupt, Real Time Clock interrupt, A/D Converter interrupt, External Peripheral interrupt or Timer 2 overflow interrupt will not be automatically reset and must be manually reset by the application program.

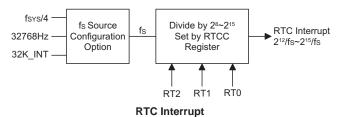
Real Time Clock Interrupt

The Real Time Clock Interrupt is contained within the Multi-function Interrupt.

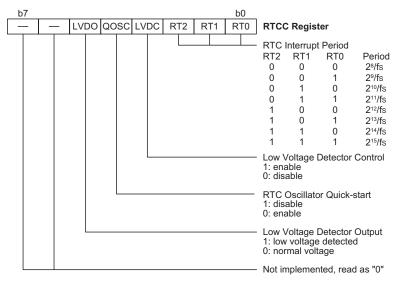
For a Real Time Clock interrupt to be generated, the global interrupt enable bit, EMI, Real Time Clock interrupt enable bit, ERTI, and Multi-function interrupt enable bit, EMFI, must first be set. An actual Real Time Clock interrupt will take place when the Real Time Clock request flag, RTF, is set, a situation that will occur when the Real Time Clock overflows. When the interrupt is enabled, the stack is not full and the Real Time Clock overflows, a subroutine call to the Multi-function interrupt vector at location 18H, will take place. When the Real Time Clock interrupt is serviced, the EMI bit will be cleared to disable other interrupts, however only the MFF interrupt request flag will be reset. As the RTF flag will not be automatically reset, it has to be cleared by the application program.

Similar in operation to the Time Base interrupt, the purpose of the RTC interrupt is also to provide an interrupt signal at fixed time periods. The RTC interrupt clock source originates from the internal clock source f_s . This f_s input clock first passes through a divider, the division ratio of which is selected by programming the appropriate bits in the RTCC register to obtain longer RTC interrupt periods whose value ranges from $2^8/f_s \sim 2^{15}/f_s$. The clock source that generates f_s , which in turn controls the RTC interrupt period, can originate from three different sources, the 32768Hz oscillator, $32K_INT$ oscillator or the System oscillator/4, the choice of which is determine by the f_s clock source configuration option.

Note that the RTC interrupt period is controlled by both configuration options and an internal register RTCC. A configuration option selects the source clock for the internal clock f_s , and the RTCC register bits RT2, RT1 and RT0 select the division ratio. Note that the actual division ratio can be programmed from 2^8 to 2^{15} .



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Real Time Clock Control Register - RTCC

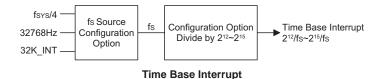
Time Base Interrupt

The Time Base Interrupt is contained within the Multi-function Interrupt.

For a Time Base Interrupt to be generated, the global interrupt enable bit, EMI, Time Base Interrupt enable bit, ETBI, and Multi-function interrupt enable bit, EMFI, must first be set. An actual Time Base Interrupt will take place when the Time Base Interrupt request flag, TBF, is set, a situation that will occur when the Time Base overflows. When the interrupt is enabled, the stack is not full and the Time Base overflows, a subroutine call to the Multi-function interrupt vector at location 18H, will take place. When the Time Base Interrupt is serviced, the EMI bit will be cleared to disable other interrupts, however only the MFF interrupt request flag will be reset. As the TBF flag will not be automatically reset, it has to be cleared by the application program.

The purpose of the Time Base function is to provide an interrupt signal at fixed time periods. The Time Base interrupt clock source originates from the Time Base interrupt clock source originates from the internal clock source f_s . This f_s input clock first passes through a divider, the division ratio of which is selected by configuration options to provide longer Time Base interrupt periods. The Time Base interrupt time-out period ranges from $2^{12}/f_s \sim 2^{15}/f_s$. The clock source that generates f_s , which in turn controls the Time Base interrupt period, can originate from three different sources, the 32768Hz oscillator, the $32K_INT$ internal oscillator or the System oscillator/4, the choice of which is determine by the f_s clock source configuration option.

Essentially operating as a programmable timer, when the Time Base overflows it will set a Time Base interrupt flag which will in turn generate an Interrupt request via the Multi-function Interrupt vector.



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Programming Considerations

By disabling the interrupt enable bits, a requested interrupt can be prevented from being serviced, however, once an interrupt request flag is set, it will remain in this condition in the INTC0, INTC1 and MFIC registers until the corresponding interrupt is serviced or until the request flag is cleared by the application program.

It is recommended that programs do not use the "CALL subroutine" instruction within the interrupt subroutine. Interrupts often occur in an unpredictable manner or need to be serviced immediately in some applications. If only one stack is left and the interrupt is not well controlled, the original control sequence will be damaged once a "CALL subroutine" is executed in the interrupt subroutine.

All of these interrupts have the capability of waking up the processor when in the Power Down Mode.

Only the Program Counter is pushed onto the stack. If the contents of the status or other registers are altered by the interrupt service program, which may corrupt the desired control sequence, then the contents should be saved in advance.

Reset and Initialisation

A reset function is a fundamental part of any microcontroller ensuring that the device can be set to some predetermined condition irrespective of outside parameters. The most important reset condition is after power is first applied to the microcontroller. In this case, internal circuitry will ensure that the microcontroller, after a short delay, will be in a well defined state and ready to execute the first program instruction. After this power-on reset, certain important internal registers will be set to defined states before the program commences. One of these registers is the Program Counter, which will be reset to zero forcing the microcontroller to begin program execution from the lowest Program Memory address.

In addition to the power-on reset, situations may arise where it is necessary to forcefully apply a reset condition when the microcontroller is running. One example of this is where after power has been applied and the microcontroller is already running, the RES line is forcefully pulled low. In such a case, known as a normal operation reset, some of the microcontroller registers remain unchanged allowing the microcontroller to proceed with normal operation after the reset line is allowed to return high. Another type of reset is when the Watchdog Timer overflows and resets the microcontroller. All types of reset operations result in different register conditions being setup.

Another reset exists in the form of a Low Voltage Reset, LVR, where a full reset, similar to the $\overline{\text{RES}}$ reset is implemented in situations where the power supply voltage falls below a certain threshold.

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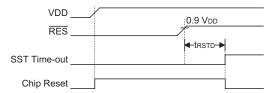
Reset Functions

There are five ways in which a microcontroller reset can occur, through events occurring both internally and externally:

· Power-on Reset

The most fundamental and unavoidable reset is the one that occurs after power is first applied to the microcontroller. As well as ensuring that the Program Memory begins execution from the first memory address, a power-on reset also ensures that certain other registers are preset to known conditions. All the I/O port and port control registers will power up in a high condition ensuring that all pins will be first set to inputs.

Although the microcontroller has an internal RC reset function, if the V_{DD} power supply rise time is not fast enough or does not stabilise quickly at power-on, the internal reset function may be incapable of providing proper reset operation. For this reason it is recommended that an external RC network is connected to the \overline{RES} pin, whose additional time delay will ensure that the \overline{RES} pin remains low for an extended period to allow the power supply to stabilise. During this time delay, normal operation of the microcontroller will be inhibited. After the \overline{RES} line reaches a certain voltage value, the reset delay time t_{RSTD} is invoked to provide an extra delay time after which the microcontroller will begin normal operation. The abbreviation SST in the figures stands for System Start-up Timer.

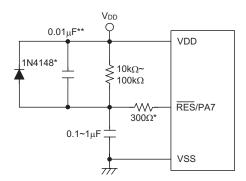


Power-On Reset Timing Chart

For most applications a resistor connected between VDD and the \overline{RES} pin and a capacitor connected between VSS and the \overline{RES} pin will provide a suitable external reset circuit. Any wiring connected to the \overline{RES} pin should be kept as short as possible to minimise any stray noise interference.

For applications that operate within an environment where more noise is present the Reset Circuit shown is recommended.

More information regarding external reset circuits is located in Application Note HA0075E on the Holtek website.



Note: "*" It is recommended that this component is added for added ESD protection

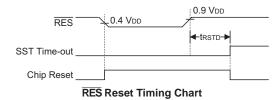
"**" It is recommended that this component is added in environments where power line noise is significant

External RES Circuit



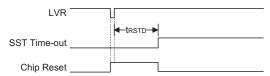
• RES Pin Reset

This type of reset occurs when the microcontroller is already running and the RES pin is forcefully pulled low by external hardware such as an external switch. In this case as in the case of other reset, the Program Counter will reset to zero and program execution initiated from this point.



• Low Voltage Reset - LVR

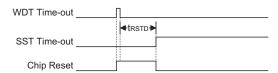
The microcontroller contains a low voltage reset circuit in order to monitor the supply voltage of the device, which is selected via a configuration option. If the supply voltage of the device drops to within a range of $0.9V\sim V_{LVR}$ such as might occur when changing the battery, the LVR will automatically reset the device internally. The LVR includes the following specifications: For a valid LVR signal, a low voltage, i.e., a voltage in the range between $0.9V\sim V_{LVR}$ must exist for greater than the value t_{LVR} specified in the A.C. characteristics. If the low voltage state does not exceed 1ms, the LVR will ignore it and will not perform a reset function. One of a range of specified voltage values for V_{LVR} can be selected using configuration options. The V_{LVR} value will be selected as a pair in conjunction with a Low Voltage Detect value.



Low Voltage Reset Timing Chart

• Watchdog Time-out Reset during Normal Operation

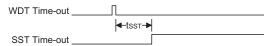
The Watchdog time-out Reset during normal operation is the same as a hardware RES pin reset except that the Watchdog time-out flag TO will be set to "1".



WDT Time-out Reset during Normal Operation Timing Chart

· Watchdog Time-out Reset during Power Down

The Watchdog time-out Reset during Power Down is a little different from other kinds of reset. Most of the conditions remain unchanged except that the Program Counter and the Stack Pointer will be cleared to "0" and the TO flag will be set to "1". Refer to the A.C. Characteristics for t_{SST} details.



WDT Time-out Reset during Power Down Timing Chart

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Reset Initial Conditions

The different types of reset described affect the reset flags in different ways. These flags, known as PDF and TO are located in the status register and are controlled by various microcontroller operations, such as the Power Down function or Watchdog Timer. The reset flags are shown in the table:

то	PDF	RESET Conditions	
0	0	RES reset during power-on	
u	u	RES or LVR reset during normal operation	
1	u	WDT time-out reset during normal operation	
1	1	WDT time-out reset during Power Down	

"u" stands for unchanged

The following table indicates the way in which the various components of the microcontroller are affected after a power-on reset occurs.

Item	Condition After RESET
Program Counter	Reset to zero
Interrupts	All interrupts will be disabled
WDT	Clear after reset, WDT begins counting
Timer/Event Counter	Timer Counter will be turned off
Prescaler	The Timer Counter Prescaler will be cleared
Input/Output Ports	I/O ports will be setup as inputs
Stack Pointer	Stack Pointer will point to the top of the stack

The different kinds of resets all affect the internal registers of the microcontroller in different ways. To ensure reliable continuation of normal program execution after a reset occurs, it is important to know what condition the microcontroller is in after a particular reset occurs. The following table describes how each type of reset affects each of the microcontroller internal registers. Note that where more than one package type exists the table will reflect the situation for the larger package type.

HT56R62

Register	Reset (Power-on)	RES Reset (Normal Operation)	Time-out (Normal Operation)	Time-out (HALT)
MP0	-xxx xxxx	-uuu uuuu	-uuu uuuu	-uuu uuuu
MP1	-xxx xxxx	-uuu uuuu	-uuu uuuu	-uuu uuuu
ВР	000	000	000	uuu
ACC	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu
PCL	0000 0000	0000 0000	0000 0000	0000 0000
TBLP	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu
TBLH	xx xxxx	uu uuuu	uu uuuu	uu uuuu
RTCC	00 0111	00 0111	00 0111	uu uuuu
STATUS	00 xxxx	uu uuuu	1u uuuu	11 uuuu
INTC0	-000 0000	-000 0000	-000 0000	-uuu uuuu
TMR0	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
TMR0C	00-0 1000	00-0 1000	00-0 1000	uu-u uuuu
TMR1	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
TMR1C	00-0 1000	00-0 1000	00-0 1000	uu-u uuuu
PA	1111 1111	1111 1111	1111 1111	uuuu uuuu
PAC	1111 1111	1111 1111	1111 1111	uuuu uuuu
РВ	11 1111	11 1111	11 1111	uu uuuu



Register	Reset (Power-on)	RES Reset (Normal Operation)	Time-out (Normal Operation)	Time-out (HALT)
PBC	11 1111	11 1111	11 1111	uu uuuu
PD	-111 -111	-111 -111	-111 -111	-uuu -uuu
PDC	-111 -111	-111 -111	-111 -111	-uuu -uuu
PWM0L	00000	00000	00000	uuuuu
PWM0H	0000 0000	0000 0000	0000 0000	uuuu uuuu
PWM1L	00000	00000	00000	uuuuu
PWM1H	0000 0000	0000 0000	0000 0000	uuuu uuuu
INTC1	-000 -000	-000 -000	-000 -000	-uuu -uuu
PWM2L	00000	00000	00000	uuuuu
PWM2H	0000 0000	0000 0000	0000 0000	uuuu uuuu
ADRL	xxxx	xxxx	xxxx	uuuu
ADRH	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
ADCR	0100 0000	0100 0000	0100 0000	uuuu uuuu
ACSR	10000	10000	10000	uuuuu
CLKMOD	0000 0x11	0000 0x11	0000 0x11	uuuu uuuu
PAWU	0000 0000	0000 0000	0000 0000	uuuu uuuu
PAPU	0000 0000	0000 0000	0000 0000	uuuu uuuu
PBPU	11 1111	11 1111	11 1111	uu uuuu
PDPU	-111 -111	-111 -111	-111 -111	-uuu -uuu
INTEDGE	0000	0000	0000	uuuu
LCDCTRL	000- 0000	000- 0000	000- 0000	uuu- uuuu
LCDOUT1	0	0	0	u
LCDOUT2	0000 0000	0000 0000	0000 0000	uuuu uuuu
MISC	0000 1010	0000 1010	0000 1010	uuuu uuuu
MFIC	0000 0000	0000 0000	0000 0000	uuuu uuuu
SIMCTL0	1110 0000	1110 0000	1110 0000	uuuu uuuu
SIMCTL1	1000 00-1	1000 00-1	1000 00-1	uuuu uu-u
SIMDR	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
SIMAR/SIMCTL2	0000 0000	0000 0000	0000 0000	uuuu uuuu

Note: "u" stands for unchanged

"x" stands for unknown

"-" stands for unimplemented



HT56R65/HT56R642/HT56R644/HT56R654/HT56R656

MPO	Register	Reset (Power-on)	RES Reset (Normal Operation)	Time-out (Normal Operation)	Time-out (HALT)
BP	MP0	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu
ACC	MP1	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu
PCL	BP	000	000	000	uuu
TBLP	ACC	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu
TBLH XXXX XXXX UUUU UUUU TTCC TOO 0111 TOO 0100 TTCO TT	PCL	0000 0000	0000 0000	0000 0000	0000 0000
RTCC	TBLP	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu
STATUS	TBLH	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu
NTCO	RTCC	00 0111	00 0111	00 0111	uu uuuu
TMRO XXXX XXXX XXXX XXXX XXXX XXXX XXXX XXXX UUUU UUUU TMROC 00-0 1000 00-0 1000 00-0 1000 uu-u uuuu TMRTH XXXX XXXX XXXX XXXX XXXX XXXX uuuu uuu TMRTL 0000 1 0000 1 0000 1 uuuu uuu TMR2 XXXX XXXX XXXX XXXX XXXX XXXX Uuuu uuuu TMR2 XXXX XXXX XXXX XXXX XXXX XXXX Uuuu uuuu PA 1111 1111 1	STATUS	00 xxxx	uu uuuu	1u uuuu	11 uuuu
TMROC 00-0 1000 00-0 1000 00-0 1000 uu-u uuuu TMR1H XXXX XXXX XXXX XXXX XXXX XXXX uuuu uuuu TMR1L XXXX XXXX XXXX XXXX XXXX XXXX uuuu uuu TMR1C 0000 1 0000 1 0000 1 uuuu uuu TMR2 XXXX XXXX XXXX XXXX XXXX XXXX uuuu uuu PA 1111 1111 1111 1111 1111 1111 uuuu uuu PAC 1111 1111 1111 1111 1111 1111 uuuu uuu PB 1111 1111 1111 1111 1111 1111 uuuu uuu PBC 1111 1111 1111 1111 1111 1111 uuuu uuu PDC 1111 1111 1111 1111 1111 1111 uuuu uuu PWMOL 00000 00000 00000 uuuu uuu PWMHH 0000 0000 0000 0000 0000 0000 uuuu uuu PWM2H 0000 0000 0000 0000 0000 0000 uuuu uuu PWM2H 0000 0000 0000 0000 0000 0000	INTC0	0000 0000	0000 0000	0000 0000	uuuu uuuu
TMR1H XXXX XXXX XXXX XXXX XXXX XXXX UUUU UUUU TMR1L XXXX XXXX XXXX XXXX XXXX XXXX UUUU UUUU TMR1C 0000 1 0000 1 0000 1 uuuu uuu TMR2 XXXX XXXX XXXX XXXX XXXX XXXX uuuu uuu TMR2C 00-0 1000 00-0 1000 uu-u uuu PA 1111 1111 1111 1111 1111 1111 uuuu uuu PA 1111 1111 1111 1111 1111 1111 uuuu uuuu PB 1111 1111 1111 1111 1111 1111 uuuu uuuu PBC 1111 1111 1111 1111 1111 1111 uuuu uuuu PD 1111 1111	TMR0	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
TMR1L XXXX XXXX XXXX XXXX XXXX XXXX UUUU UUU TMR2C 0000 1 0000 1 0000 1 uuuu uu TMR2C 00-0 1000 00-0 1000 00-0 1000 uu-u uuuu PA 1111 1111	TMR0C	00-0 1000	00-0 1000	00-0 1000	uu-u uuuu
TMR1C	TMR1H	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
TMR2	TMR1L	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
TMR2C	TMR1C	0000 1	0000 1	0000 1	uuuu u
PA 1111 1111 1111 1111 1111 1111 1111	TMR2	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
PAC 1111 1111 1111 1111 1111 1111 1111	TMR2C	00-0 1000	00-0 1000	00-0 1000	uu-u uuuu
PB 1111 1111 1111	PA	1111 1111	1111 1111	1111 1111	uuuu uuuu
PBC	PAC	1111 1111	1111 1111	1111 1111	uuuu uuuu
PD 1111 1111 11111 1111 1111 1111 1111 1111 1111	РВ	1111 1111	1111 1111	1111 1111	uuuu uuuu
PDC 1111 1111 1111	PBC	1111 1111	1111 1111	1111 1111	uuuu uuuu
PWM0L 00000 00000 00000 uuuuu PWM0H 0000 0000 0000 0000 0000 0000 uuuu uuuu PWM1L 00000 00000 uuuuuu PWM1H 0000 0000 0000 0000 0000 0000 uuuuuu PWM2L 00000 00000 00000 uuuuuu PWM2L 00000 0000 000 0000 000 uuuuuu PWM2H 0000 000 0000 000 0000 000 uuuuuu PWM3L 00000 00000 00000 uuuuuu PWM3H 0000 0000 0000 0000 0000 0000 uuuu uuu ADRL xxxx xxxx xxxx uuuu uuu ADRH xxxx xxxx xxxx xxxx xxxx xxxx uuuu uuuu ACSR 10 000 10 000 10 000 uuuu uuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 0000 0000	PD	1111 1111	1111 1111	1111 1111	uuuu uuuu
PWM0H 0000 0000 0000 0000 0000 0000 uuuu uuuu PWM1L 00000 00000 00000 uuuuu PWM1H 0000 0000 0000 0000 0000 0000 uuuu uuuu INTC1 -00000 -00000 -00000 -uuuuu PWM2L 00000 00000 00000 uuuuuu PWM2H 0000 0000 0000 0000 0000 0000 uuuu uuuu PWM3L 00000 00000 00000 uuuuuu PWM3H 0000 0000 0000 0000 0000 0000 uuuu uuuu ADRL xxxx xxxx xxxx uuuu uuuu ADRH xxxx xxxx xxxx xxxx xxxx xxxx uuuu uuuu ACSR 10 000 10 000 10 000 uuuu uuuu ACSR 10 000 0000 000 0000 000 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PBPU 0000 0000 0000 0000 0000 0000	PDC	1111 1111	1111 1111	1111 1111	uuuu uuuu
PWM1L 00000 00000 00000 uuuuu PWM1H 0000 0000 0000 0000 0000 0000 uuuu uuuu INTC1 -00000 -00000 -00000 -uuuuu PWM2L 00000 00000 00000 uuuuu PWM2H 0000 0000 0000 0000 0000 0000 uuuuu PWM3L 00000 00000 00000 uuuuu PWM3H 0000 0000 0000 0000 0000 0000 uuuu uuuu ADRL xxxx xxxx xxxx xxxx xxxx uuuu ADRH xxxx xxxx xxxx xxxx xxxx xxxx uuuu uuuu ACSR 0100 0000 0100 0000 0100 0000 uuuu uuuu ACSR 10 000 10 000 10 000 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000	PWM0L	00000	00000	00000	uuuuu
PWM1H 0000 0000 0000 0000 0000 0000 uuuu uuuu INTC1 -00000 -00000 -00000 -uuuuu PWM2L 00000 00000 00000 uuuuuu PWM2H 0000 0000 0000 0000 0000 0000 uuuu uuuu PWM3L 00000 00000 00000 uuuu uuuu PWM3H 0000 0000 0000 0000 0000 0000 uuuu uuuu ADRL xxxx xxxx xxxx xxxx xxxx uuuu uuuu ADRH xxxx xxxx xxxx xxxx xxxx xxxx uuuu uuuu ACSR 0100 0000 0100 0000 0100 0000 uuuu uuuu ACSR 10000 10000 10000 uuuuu CLKMOD 0000 0x11 0000 0x11 0000 0x11 0000 0x11 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 -	PWM0H	0000 0000	0000 0000	0000 0000	uuuu uuuu
INTC1	PWM1L	00000	00000	00000	uuuuu
PWM2L 00000 00000 uuuuu PWM2H 0000 0000 0000 0000 0000 0000 uuuu uuuu PWM3L 00000 00000 00000 uuuuu PWM3H 0000 0000 0000 0000 0000 0000 uuuu uuuu ADRL xxxx xxxx xxxx xxxx xxxx uuuu ADRH xxxx xxxx xxxx xxxx xxxx xxxx uuuu uuuu ACSR 0100 0000 0100 0000 0100 0000 uuuu uuuu CLKMOD 0000 0x11 0000 0x11 0000 0x11 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT2 0000 0000 0000 0000 0000 0000 uuuu uuuu	PWM1H	0000 0000	0000 0000	0000 0000	uuuu uuuu
PWM2H 0000 0000 0000 0000 0000 0000 uuuu uuuu PWM3L 00000 00000 00000 uuuuu PWM3H 0000 0000 0000 0000 0000 0000 uuuu uuuu ADRL xxxx xxxx xxxx xxxx uuuu uuuu ADRH xxxx xxxx xxxx xxxx xxxx xxxx uuuu uuuu ADCR 0100 0000 0100 0000 0100 0000 uuuu uuuu ACSR 10000 10000 10000 uuuuu CLKMOD 0000 0x11 0000 0x11 0000 0x11 uuuu uuuu PAWU 0000 0000 0000 0000 0000 0000 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000 000 000 000 LCDOUT1 00 00 00 LCDOUT2 0000 0000	INTC1	-00000	-00000	-00000	-uuuuu
PWM3L 00000 00000 00000 uuuuu PWM3H 0000 0000 0000 0000 0000 0000 uuuu uuuu ADRL xxxx xxxx xxxx xxxx uuuu uuuu ADRH xxxx xxxx xxxx xxxx xxxx xxxx uuuu uuuu ADCR 0100 0000 0100 0000 0100 0000 uuuu uuuu ACSR 10000 10000 10000 uuuuu CLKMOD 0000 0x11 0000 0x11 0000 0x11 uuuu uuuu PAWU 0000 0000 0000 0000 0000 0000 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000 0000 0000 uuuu LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 000 000	PWM2L	00000	00000	00000	uuuuu
PWM3H 0000 0000 0000 0000 0000 0000 0000 0	PWM2H	0000 0000	0000 0000	0000 0000	uuuu uuuu
ADRL	PWM3L	00000	00000	00000	uuuuu
ADRH	PWM3H	0000 0000	0000 0000	0000 0000	uuuu uuuu
ADCR 0100 0000 0100 0000 0100 0000 uuuu uuuu ACSR 10000 10000 10000 uuuuu CLKMOD 0000 0x11 0000 0x11 0000 0x11 uuuu uuuu	ADRL	xxxx	xxxx	xxxx	uuuu
ACSR 10000 10000 10000 uuuuu CLKMOD 0000 0x11 0000 0x11 0000 0x11 uuuu uuuu	ADRH	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
CLKMOD 0000 0x11 0000 0x11 0000 0x11 uuuu uuuu PAWU 0000 0000 0000 0000 0000 0000 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000 uuuu LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 00 00	ADCR	0100 0000	0100 0000	0100 0000	uuuu uuuu
PAWU 0000 0000 0000 0000 0000 0000 uuuu uuuu PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000 uuuu LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 00 00 uu LCDOUT2 0000 0000 0000 0000 0000 0000 uuuu uuuu	ACSR	10000	10000	10000	uuuuu
PAPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000 uuuu LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 00 00	CLKMOD	0000 0x11	0000 0x11	0000 0x11	uuuu uuuu
PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000 uuuu LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 00 00	PAWU	0000 0000	0000 0000	0000 0000	uuuu uuuu
PBPU 0000 0000 0000 0000 0000 0000 uuuu uuuu PDPU 0000 0000 0000 0000 0000 0000 uuuu uuuu INTEDGE 0000 0000 uuuu LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 00 00	PAPU	0000 0000	0000 0000	0000 0000	uuuu uuuu
INTEDGE 0000 0000 uuuu LCDCTRL 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 00 uu LCDOUT2 0000 0000 0000 0000 0000 0000 uuuu uuuu	PBPU	0000 0000	0000 0000	0000 0000	
LCDCTRL 0000 0000 0000 0000 0000 0000 uuuu uuuu LCDOUT1 00 00 uu LCDOUT2 0000 0000 0000 0000 0000 0000 uuuu uuuu	PDPU	0000 0000	0000 0000	0000 0000	uuuu uuuu
LCDOUT1	INTEDGE	0000	0000	0000	uuuu
LCDOUT2 0000 0000 0000 0000 0000 uuuu uuuu	LCDCTRL	0000 0000	0000 0000	0000 0000	uuuu uuuu
LCDOUT2 0000 0000 0000 0000 0000 uuuu uuuu	LCDOUT1	00	00	00	uu
MISC 0000 1010 0000 1010 0000 1010 uuuu uuuu	LCDOUT2	0000 0000		0000 0000	uuuu uuuu
	MISC	0000 1010	0000 1010	0000 1010	uuuu uuuu



Register	Reset (Power-on)	RES Reset (Normal Operation)	Time-out (Normal Operation)	Time-out (HALT)
MFIC/MFIC0	0000 0000	0000 0000	0000 0000	uuuu uuuu
MFIC1	00	00	00	uu
SIMCTL0	1110 0000	1110 0000	1110 0000	uuuu uuuu
SIMCTL1	1000 00-1	1000 00-1	1000 00-1	uuuu uu-u
SIMDR	xxxx xxxx	xxxx xxxx	xxxx xxxx	uuuu uuuu
SIMAR/SIMCTL2	0000 0000	0000 0000	0000 0000	uuuu uuuu

Note: "u" stands for unchanged
"x" stands for unknown
"-" stands for unimplemented

Oscillator

Various oscillator options offer the user a wide range of functions according to their various application requirements. Five types of system clocks can be selected while various clock source options for the Watchdog Timer are provided for maximum flexibility. All oscillator options are selected through the configuration options.

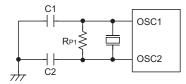
System Clock Configurations

There are five methods of generating the system clock, two high oscillators, two low oscillators and an externally supplied clock. The two high oscillators are the external crystal/ceramic oscillator and the external RC network. The two low oscillators are the fully integrated 32K_INT oscillator and the external 32768Hz oscillator. Selecting whether the low or high oscillator is used as the system oscillator is implemented using the HLCLK bit in the CLKMOD register. The source clock for the high and low oscillators is chosen via configuration options. The frequency of the slow oscillator is also determined using the SLOWC0~SLOWC2 bits in the CLKMOD register.

System Crystal/Ceramic Oscillator

After selecting the external crystal configuration option, the simple connection of a crystal across OSC1 and OSC2, is normally all that is required to create the necessary phase shift and feedback for oscillation, without requiring external capacitors. However, for some crystal types and frequencies, to ensure oscillation, it may be necessary to add two small value capacitors, C1 and C2. Using a ceramic resonator will usually require two small value capacitors, C1 and C2, to be connected as shown for oscillation to occur. The values of C1 and C2 should be selected in consultation with the crystal or resonator manufacturer's specification. In most applications, resistor $R_{\rm P1}$ is not required, however for those applications where the LVR function is not used, $R_{\rm P1}$ may be necessary to ensure the oscillator stops running when $V_{\rm DD}$ falls below its operating range. The internal oscillator circuit contains a filter circuit to reduce the possibility of erratic operation due to noise on the oscillator pins. An additional configuration option must be setup to configure the device according to whether the oscillator frequency is high, defined as equal to or above 1MHz, or low, which is defined as below 1MHz.

More information regarding oscillator applications is located on the Holtek website.



Crystal/Ceramic Oscillator



Crystal Oscillator C1 and C2 Values					
Crystal Frequency C1 C2					
12MHz	_	_			
8MHz	_	_			
4MHz	_	_			
1MHz	_	_			
455kHz (see Note 2)	10pF	10pF			

Note: 1. C1 and C2 values are for guidance only.

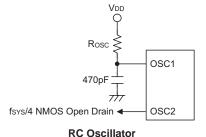
- 2. XTAL mode configuration option: 455kHz.
- 3. R_{P1} =5 $M\Omega$ ~10 $M\Omega$ is recommended.

Crystal Recommended Capacitor Values

External System RC Oscillator

After selecting the correct configuration option, using the external system RC oscillator requires that a resistor, with a value between $47k\Omega$ and $1.5M\Omega$, is connected between OSC1 and VDD, and a 470pF capacitor is connected to ground. Although this is a cost effective oscillator configuration, the oscillation frequency can vary with V_{DD} , temperature and process variations and is therefore not suitable for applications where timing is critical or where accurate oscillator frequencies are required. For the value of the external resistor R_{OSC} refer to the Appendix section for typical RC Oscillator vs. Temperature and V_{DD} characteristics graphics.

Note that an internal capacitor together with the external resistor, $R_{\rm OSC}$, are the components which determine the frequency of the oscillator. The external capacitor shown on the diagram does not influence the frequency of oscillation. This external capacitor should be added to improve oscillator stability if the open-drain OSC2 output is utilised in the application circuit. The internal oscillator circuit contains a filter circuit to reduce the possibility of erratic operation due to noise on the oscillator pins.

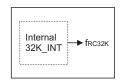


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Internal 32K INT Oscillator

When microcontrollers enter a power down condition, their internal clocks are normally switched off to stop microcontroller activity and to conserve power. However, in many microcontroller applications it may be necessary to keep some internal functions operational, such as timers, even when the microcontroller is in the Power-down mode. To do this, the device has a 32K_INT oscillator, which is a fully integrated free running RC oscillator with a typical period of 31.2µs at 5V, requiring no external components. It is selected via configuration option. When the device enters the Power Down Mode, the system clock will stop running, however the 32K_INT oscillator will continue to run if selected to keep various internal functions operational.



Internal 32K_INT Oscillator

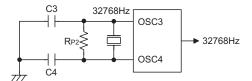
External 32768Hz Oscillator

With a function similar to the internal 32K-INT 32KHz oscillator, that is to keep some device functions operational during power down, this device also has an external 32768Hz oscillator. This oscillator also remains active at all times, even when the microcontroller is in the Power-down mode. This clock source has a fixed frequency of 32768Hz and requires a 32768Hz crystal to be connected between pins OSC3 and OSC4.

The external resistor and capacitor components connected to the 32768Hz crystal are not necessary to provide oscillation. For applications where precise frequencies are essential, these components may be required to provide frequency compensation due to different crystal manufacturing tolerances.

A configuration option selects whether the external 32768Hz oscillator or the internal 32K_INT oscillator is selected. Selecting low frequency oscillators for use as a system oscillator is implmented using bits in the CLKMOD register.

During power-up there is a time delay associated with the 32768Hz oscillator waiting for it to start-up. To minimise this time delay, bit 4 of the RTCC register, known as the QOSC bit, is provided to have a quick start-up function. During a power-up condition, this bit will be cleared to zero which will initiate the 32768Hz oscillator quick start-up function. However, as there is additional power consumption associated with this quick start-up function, to reduce power consumption after start-up takes place, it is recommended that the application program should set the QOSC bit high for about 2 seconds after power-on. It should be noted that, no matter what condition the QOSC bit is set to, the 32768Hz oscillator will always function normally, only there is more power consumption associated with the quick start-up function.



External 32768Hz Oscillator

32768Hz Oscillator C1 and C2 Values				
Crystal Frequency C3 C4				
32768Hz 8pF 10pF				
Note: 1. C3 and C4 values are for guidance only. 2. R _{P2} =5M~10MΩ is recommended.				

32768 Hz Crystal Recommended Capacitor Values

External Oscillator

The system clock can also be supplied by an externally supplied clock giving users a method of synchronising their external hardware to the microcontroller operation. This is selected using a configuration option and supplying the clock on pin OSC1. Pin OSC2 should be left floating if the external oscillator is used. The internal oscillator circuit contains a filter circuit to reduce the possibility of erratic operation due to noise on the oscillator pin, however as the filter circuit consumes a certain amount of power, a oscillator configuration option exists to turn this filter off. Not using the internal filter should be considered in power sensitive applications and where the externally supplied clock is of a high integrity and supplied by a low impedance source.

System Operating Modes

The devices have the ability to operate in several different modes. This range of operating modes, known as Normal Mode, Slow Mode, Idle Mode and Sleep Mode, allow the devices to run using a wide range of different slow and fast clock sources. The devices also possess the ability to dynamically switch between different clocks and operating modes. With this choice of operating functions users are provided with the flexibility to ensure they obtain optimal performance from the device according to their application specific requirements.

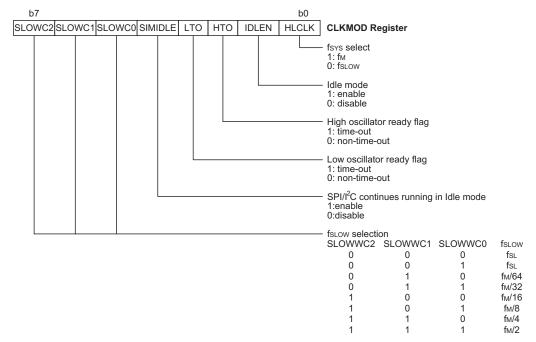
Clock Sources

In discussing the system clocks for the devices, they can be seen as having a dual clock mode. These dual clocks are what are known as a High Oscillator and the other as a Low Oscillator. The High and Low Oscillator are the system clock sources and can be selected dynamically using the HLCLK bit in the CLKMOD register.

The High Oscillator has the internal name f_M whose source is selected using a configuration option from a choice of either an external crystal/resonator, external RC oscillator or external clock source.

The Low Oscillator clock source, has the internal name f_{SL} , whose source is also selected by configuration option from a choice of either an external 32768Hz oscillator or the internal 32K_INT oscillator. This internal f_{SL} , f_{M} clock, is further modified by the SLOWC0~SLOWC2 bits in the CLKMOD register to provide the low frequency clock source f_{SLOW} .





Clock Control Register - CLKMOD

An additional sub internal clock, with the internal name f_{SUB} , is a 32kHz clock source which can be sourced from either the internal 32K_INT oscillator or an external 32768 Hz crystal, selected by configuration option. Together with $f_{SYS}/4$, it is used as a clock source for certain internal functions such as the LCD driver, Watchdog Timer, Buzzer, RTC Interrupt and Time Base Interrupt. The LCD clock source is the f_{SUB} clock source divided by 8, giving a frequency of 4kHz. The internal clock f_{S} , is simply a choice of either f_{SUB} or $f_{SYS}/4$, using a configuration option.

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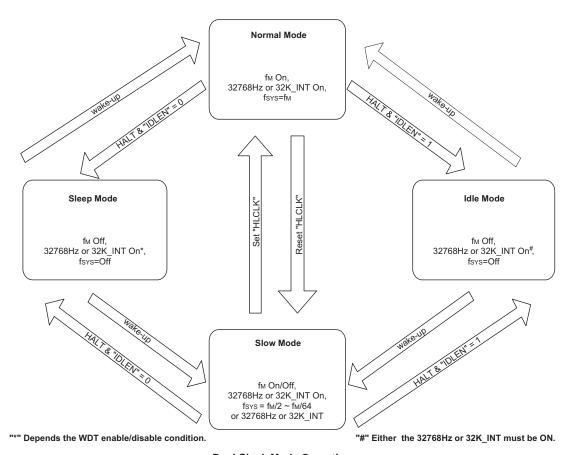


Operating Modes

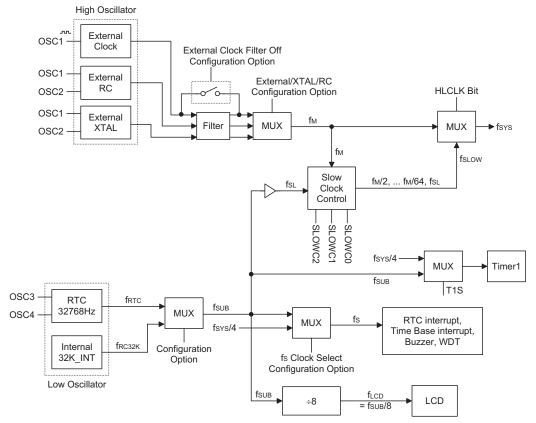
After the correct clock source configuration selections are made, overall operation of the chosen clock is achieved using the CLKMOD register. A combination of the HLCLK and IDLEN bits in the CLKMOD register and use of the HALT instruction determine in which mode the device will be run. The devices can operate in the following Modes.

- Normal Mode
 f_M on, f_{SLOW} on, f_{SYS}=f_M, CPU on, f_S on, f_{LCD} on/off depending upon the LCDEN bit, f_{WDT} on/off depending upon the WDT configuration option and WDT control register.
- Slow Mode0
 f_M off, f_{SLOW}=32K_INT oscillator or the 32768Hz oscillator, f_{SYS}=f_{SLOW}, CPU on, f_S on, f_{LCD} on/off depending upon the LCDEN bit, f_{WDT} on/off depending upon the WDT configuration option and WDT control register.
- Slow Mode1 f_M on, $f_{SLOW}=f_M/2\sim f_M/64$, $f_{SYS}=f_{SLOW}$, CPU on, f_S on, f_{LCD} on/off depending upon the LCDEN bit, f_{WDT} on/off depending upon the WDT configuration option and WDT control register.
- Idle Mode
 f_M, f_{SLOW}, f_{SYS} off, CPU off; f_{SUB} on, f_S on/off by selecting f_{SUB} or f_{SYS}/4, f_{LCD} on/off depending
 upon the LCDEN bit, f_{WDT} on/off depending upon the WDT configuration option and WDT
 control register.
- Sleep Mode f_M , f_{SLOW} , f_{SYS} , f_S , f_{LCD} off, CPU off; f_{SUB} , f_{WDT} on/off depending upon the WDT configuration option and WDT control register.





Dual Clock Mode Operation



Dual Clock Mode Structure



Power Down Mode and Wake-up

Power Down Mode

All of the Holtek microcontrollers have the ability to enter a Power Down Mode. When the device enters this mode, the normal operating current, will be reduced to an extremely low standby current level. This occurs because when the device enters the Power Down Mode, the system oscillator is stopped which reduces the power consumption to extremely low levels, however, as the device maintains its present internal condition, it can be woken up at a later stage and continue running, without requiring a full reset. This feature is extremely important in application areas where the MCU must have its power supply constantly maintained to keep the device in a known condition but where the power supply capacity is limited such as in battery applications.

Entering the Power Down Mode

There is only one way for the device to enter the Power Down Mode and that is to execute the "HALT" instruction in the application program. When this instruction is executed, the following will occur:

- The system oscillator will stop running and the application program will stop at the "HALT" instruction.
- The Data Memory contents and registers will maintain their present condition.
- The WDT will be cleared and resume counting if the WDT clock source is selected to come from the WDT oscillator. The WDT will stop if its clock source originates from the system clock.
- The I/O ports will maintain their present condition.
- In the status register, the Power Down flag, PDF, will be set and the Watchdog time-out flag, TO, will be cleared.

Standby Current Considerations

As the main reason for entering the Power Down Mode is to keep the current consumption of the MCU to as low a value as possible, perhaps only in the order of several micro-amps, there are other considerations which must also be taken into account by the circuit designer if the power consumption is to be minimized. Special attention must be made to the I/O pins on the device. All high-impedance input pins must be connected to either a fixed high or low level as any floating input pins could create internal oscillations and result in increased current consumption. This also applies to devices which have different package types, as there may be undonbed pins, which must either be setup as outputs or if setup as inputs must have pull-high resistors connected. Care must also be taken with the loads, which are connected to I/O pins, which are setup as outputs. These should be placed in a condition in which minimum current is drawn or connected only to external circuits that do not draw current, such as other CMOS inputs. Also note that additional standby current will also be required if the configuration options have enabled the Watchdog Timer internal oscillator.

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Wake-up

After the system enters the Power Down Mode, it can be woken up from one of various sources listed as follows:

- · An external reset
- · An external falling edge on Port A
- · A system interrupt
- A WDT overflow

If the system is woken up by an external reset, the device will experience a full system reset, however, if the device is woken up by a WDT overflow, a Watchdog Timer reset will be initiated. Although both of these wake-up methods will initiate a reset operation, the actual source of the wake-up can be determined by examining the TO and PDF flags. The PDF flag is cleared by a system power-up or executing the clear Watchdog Timer instructions and is set when executing the "HALT" instruction. The TO flag is set if a WDT time-out occurs, and causes a wake-up that only resets the Program Counter and Stack Pointer, the other flags remain in their original status.

Each pin on Port A can be setup via an individual configuration option to permit a negative transition on the pin to wake-up the system. When a Port A pin wake-up occurs, the program will resume execution at the instruction following the "HALT" instruction.

If the system is woken up by an interrupt, then two possible situations may occur. The first is where the related interrupt is disabled or the interrupt is enabled but the stack is full, in which case the program will resume execution at the instruction following the "HALT" instruction. In this situation, the interrupt which woke-up the device will not be immediately serviced, but will rather be serviced later when the related interrupt is finally enabled or when a stack level becomes free. The other situation is where the related interrupt is enabled and the stack is not full, in which case the regular interrupt response takes place. If an interrupt request flag is set to "1" before entering the Power Down Mode, the wake-up function of the related interrupt will be disabled.

No matter what the source of the wake-up event is, once a wake-up situation occurs, a time period equal to 1024 system clock periods will be required before normal system operation resumes. However, if the wake-up has originated due to an interrupt, the actual interrupt subroutine execution will be delayed by an additional one or more cycles. If the wake-up results in the execution of the next instruction following the "HALT" instruction, this will be executed immediately after the 1024 system clock period delay has ended.

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Low Voltage Detector - LVD

The Low Voltage Detect internal function provides a means for the user to monitor when the power supply voltage falls below a certain fixed level as specified in the DC characteristics.

LVD Operation

The LVD function must be first enabled via a configuration option after which bits 3 and 5 of the RTCC register are used to control the overall function of the LVD. Bit 3 is the enable/disable control bit and is known as LVDC, when set low the overall function of the LVD will be disabled. Bit 5 is the LVD detector output bit and is known as LVDO. Under normal operation, and when the power supply voltage is above the specified V_{LVD} value in the DC characteristic section, the LVDO bit will remain at a zero value. If the power supply voltage should fall below this V_{LVD} value then the LVDO bit will change to a high value indicating a low voltage condition. Note that the LVDO bit is a read-only bit. By polling the LVDO bit in the RTCC register, the application program can therefore determine the presence of a low voltage condition.

After power-on, or after a reset, the LVD will be switched off by clearing the LVDC bit in the RTCC register to zero. Note that if the LVD is enabled there will be some power consumption associated with its internal circuitry, however, by clearing the LVDC bit to zero the power can be minimised. It is important not to confuse the LVD with the LVR function. In the LVR function an automatic reset will be generated by the microcontroller, whereas in the LVD function only the LVDO bit will be affected with no influence on other microcontroller functions.

There are a range of voltage values, selected using a configuration option, which can be chosen to activate the LVD.

Watchdog Timer

The Watchdog Timer is provided to prevent program malfunctions or sequences from jumping to unknown locations, due to certain uncontrollable external events such as electrical noise. It operates by providing a device reset when the Watchdog Timer counter overflows.

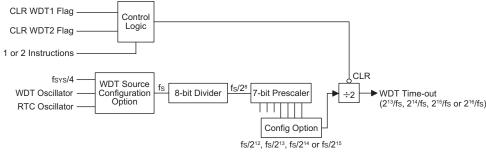
Watchdog Timer Operation

The Watchdog Timer clock source is provided by the internal clock, f_s , which is in turn supplied by one of two sources selected by configuration option: f_{SUB} or $f_{SYS}/4$. Note that if the Watchdog Timer configuration option has been disabled, then any instruction relating to its operation will result in no operation.

Most of the Watchdog Timer options, such as enable/disable, Watchdog Timer clock source and clear instruction type are selected using configuration options. In addition to a configuration option to enable the Watchdog Timer, there are four bits, WDTEN3~WDTEN0, in the MISC register to offer an additional enable control of the Watchdog Timer. These bits must be set to a specific value of 1010 to disable the Watchdog Timer. Any other values for these bits will keep the Watchdog Timer enabled. After power on these bits will have the disabled value of 1010.

One of the WDT clock sources is the internal f_{SUB} , which can be sourced from either the 32K_INT internal oscillator or the 32768Hz oscillator. The 32K_INT internal oscillator has an approximate period of 31.2 μ s at a supply voltage of 5V. However, it should be noted that this specified internal clock period can vary with V_{DD}, temperature and process variations. The 32768Hz oscillator is supplied by an external 32768Hz crystal. The other Watchdog Timer clock source option is the $f_{SYS}/4$ clock. Whether the Watchdog Timer clock source is its own internal 32K_INT, the 32768Hz oscillator or $f_{SYS}/4$, it is divided by $2^{13}\sim2^{16}$, using configuration option to obtain the required Watchdog Timer time-out period. The max time out period is when the 2^{16} option is selected. This time-out period may vary with temperature, V_{DD} and process variations. As the clear instruction only resets the last stage of the divider chain, for this reason the actual division ratio and corresponding Watchdog Timer time-out can vary by a factor of two. The exact division ratio depends upon the residual value in the Watchdog Timer counter before the clear instruction is executed.

If the f_{SYS}/4 clock is used as the Watchdog Timer clock source, it should be noted that when the system enters the Power Down Mode, then the instruction clock is stopped and the Watchdog Timer will lose its protecting purposes. For systems that operate in noisy environments, using the 32K_INT RC oscillator is strongly recommended.



Watchdog Timer

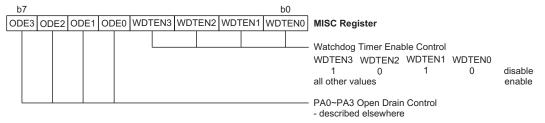
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Under normal program operation, a Watchdog Timer time-out will initialise a device reset and set the status bit TO. However, if the system is in the Power Down Mode, when a Watchdog Timer time-out occurs, the TO bit in the status register will be set and only the Program Counter and Stack Pointer will be reset. Three methods can be adopted to clear the contents of the Watchdog Timer. The first is an external hardware reset, which means a low level on the RES pin, the second is using the watchdog software instructions and the third is via a "HALT" instruction.

Clearing the Watchdog Timer

There are two methods of using software instructions to clear the Watchdog Timer, one of which must be chosen by configuration option. The first option is to use the single "CLR WDT" instruction while the second is to use the two commands "CLR WDT1" and "CLR WDT2". For the first option, a simple execution of "CLR WDT" will clear the WDT while for the second option, both "CLR WDT1" and "CLR WDT2" must both be executed to successfully clear the Watchdog Timer. Note that for this second option, if "CLR WDT1" is used to clear the Watchdog Timer, successive executions of this instruction will have no effect, only the execution of a "CLR WDT2" instruction will clear the Watchdog Timer. Similarly after the "CLR WDT2" instruction has been executed, only a successive "CLR WDT1" instruction can clear the Watchdog Timer.



Watchdog Timer Software Control - MISC

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Configuration Options

Configuration options refer to certain options within the MCU that are programmed into the device during the programming process. During the development process, these options are selected using the HT-IDE software development tools. As these options are programmed into the device using the hardware programming tools, once they are selected they cannot be changed later as the application software has no control over the configuration options. All options must be defined for proper system function, the details of which are shown in the table.

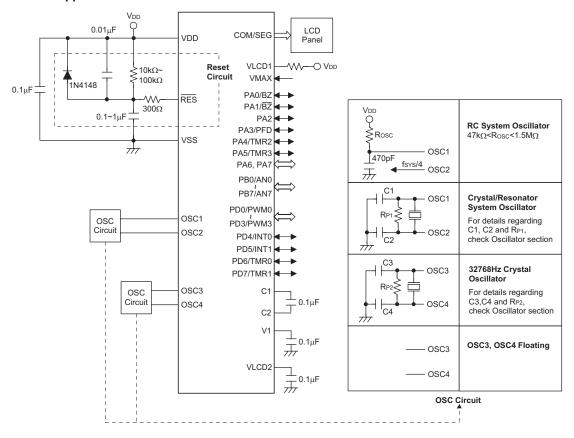
	system function, the details of which are shown in the table.
No.	Options
Oscillator	Options
1	High Oscillator type selection – f _M 1. External Crystal Oscillator 2. External RC Oscillator 3. Externally supplied clock – internal filter on 4. Externally supplied clock – internal filter off
2	f _{SUB} clock selection: 1. 32768Hz External Oscillator 2. 32K_INT Internal Oscillator
3	fs clock selection: f _{SUB} or f _{SYS} /4
4	XTAL mode selection: 455kHz or 1M~12MHz
5	32768Hz Crystal: enable or disable
PFD Optio	ns
6	PA3: normal I/O or PFD output
7	PFD clock selection: Timer/Event Counter 0 or Timer/Event Counter 1
Buzzer Op	ntions
8	PA0/PA1: normal I/O or BZ/BZ or PA0=BZ and PA1 as normal I/O
9	Buzzer frequency: fs/22, fs/23, fs/24, fs/25, fs/26, fs/27, fs/28, fs/29
Time Base	• Option
10	Time base time-out period: 212/fs, 213/fs, 214/fs, 215/fs,
LCD Optio	on .
11	LCD type: R or C - HT56R62/HT56R65 only
Watchdog	Options
12	Watchdog Timer function: enable or disable
13	CLRWDT instructions: 1 or 2 instructions
14	WDT time-out period: 2 ¹² /f _s ~2 ¹³ /f _s , 2 ¹³ /f _s ~2 ¹⁴ /f _s , 2 ¹⁴ /f _s ~2 ¹⁵ /f _s , 2 ¹⁵ /f _s ~2 ¹⁶ /f _s
LVD/LVR	Options
15	LVD function: enable or disable
16	LVR function: enable or disable
17	LVR/LVD voltage: 2.1V/2.2V or 3.15V/3.3V or 4.2V/4.4V
SPI Option	ns
18	SIM pin enable/disable
19	SPI_WCOL: enable/disable
20	SPI_CSEN: enable/disable, used to enable/disable (1/0) software CSEN function
I ² C Option	
21	I ² C debounce Time: no debounce, 1 system clock debounce, 2 system clock debounce
PINT Optio	n
22	External peripheral interrupt or Segment function
Timer/Eve	nt Counter and External Interrupt Pins Filter Option
23	Interrupt and Timer/Event Counter input pins internal filter On/Off control – applies to all pins
Lock Option	ons
24	Lock All
25	Partial Lock

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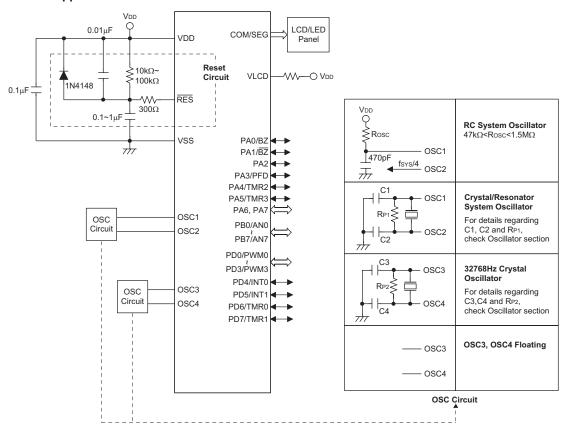


Application Circuits

Application Circuit for HT56R62/HT56R65



Application Circuit for HT56R642/HT56R644/HT56R654/HT56R656



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Instruction Set

Introduction

Central to the successful operation of any microcontroller is its instruction set, which is a set of program instruction codes that directs the microcontroller to perform certain operations. In the case of Holtek microcontroller, a comprehensive and flexible set of over 60 instructions is provided to enable programmers to implement their application with the minimum of programming overheads.

For easier understanding of the various instruction codes, they have been subdivided into several functional groupings.

Instruction Timing

Most instructions are implemented within one instruction cycle. The exceptions to this are branch, call, or table read instructions where two instruction cycles are required. One instruction cycle is equal to 4 system clock cycles, therefore in the case of an 8MHz system oscillator, most instructions would be implemented within 0.5µs and branch or call instructions would be implemented within 1µs. Although instructions which require one more cycle to implement are generally limited to the JMP, CALL, RET, RETI and table read instructions, it is important to realize that any other instructions which involve manipulation of the Program Counter Low register or PCL will also take one more cycle to implement. As instructions which change the contents of the PCL will imply a direct jump to that new address, one more cycle will be required. Examples of such instructions would be "CLR PCL" or "MOV PCL, A". For the case of skip instructions, it must be noted that if the result of the comparison involves a skip operation then this will also take one more cycle, if no skip is involved then only one cycle is required.

Moving and Transferring Data

The transfer of data within the microcontroller program is one of the most frequently used operations. Making use of three kinds of MOV instructions, data can be transferred from registers to the Accumulator and vice-versa as well as being able to move specific immediate data directly into the Accumulator. One of the most important data transfer applications is to receive data from the input ports and transfer data to the output ports.

Arithmetic Operations

The ability to perform certain arithmetic operations and data manipulation is a necessary feature of most microcontroller applications. Within the Holtek microcontroller instruction set are a range of add and subtract instruction mnemonics to enable the necessary arithmetic to be carried out. Care must be taken to ensure correct handling of carry and borrow data when results exceed 255 for addition and less than 0 for subtraction. The increment and decrement instructions INC, INCA, DEC and DECA provide a simple means of increasing or decreasing by a value of one of the values in the destination specified.

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Logical and Rotate Operation

The standard logical operations such as AND, OR, XOR and CPL all have their own instruction within the Holtek microcontroller instruction set. As with the case of most instructions involving data manipulation, data must pass through the Accumulator which may involve additional programming steps. In all logical data operations, the zero flag may be set if the result of the operation is zero. Another form of logical data manipulation comes from the rotate instructions such as RR, RL, RRC and RLC which provide a simple means of rotating one bit right or left. Different rotate instructions exist depending on program requirements. Rotate instructions are useful for serial port programming applications where data can be rotated from an internal register into the Carry bit from where it can be examined and the necessary serial bit set high or low. Another application which rotate data operations are used is to implement multiplication and division calculations.

Branches and Control Transfer

Program branching takes the form of either jumps to specified locations using the JMP instruction or to a subroutine using the CALL instruction. They differ in the sense that in the case of a subroutine call, the program must return to the instruction immediately when the subroutine has been carried out. This is done by placing a return instruction "RET" in the subroutine which will cause the program to jump back to the address right after the CALL instruction. In the case of a JMP instruction, the program simply jumps to the desired location. There is no requirement to jump back to the original jumping off point as in the case of the CALL instruction. One special and extremely useful set of branch instructions are the conditional branches. Here a decision is first made regarding the condition of a certain data memory or individual bits. Depending upon the conditions, the program will continue with the next instruction or skip over it and jump to the following instruction. These instructions are the key to decision making and branching within the program perhaps determined by the condition of certain input switches or by the condition of internal data bits.

Bit Operations

The ability to provide single bit operations on Data Memory is an extremely flexible feature of all Holtek microcontrollers. This feature is especially useful for output port bit programming where individual bits or port pins can be directly set high or low using either the "SET [m].i" or "CLR [m].i" instructions respectively. The feature removes the need for programmers to first read the 8-bit output port, manipulate the input data to ensure that other bits are not changed and then output the port with the correct new data. This read-modify-write process is taken care of automatically when these bit operation instructions are used.

Table Read Operations

Data storage is normally implemented by using registers. However, when working with large amounts of fixed data, the volume involved often makes it inconvenient to store the fixed data in the Data Memory. To overcome this problem, Holtek microcontrollers allow an area of Program Memory to be setup as a table where data can be directly stored. A set of easy to use instructions provides the means by which this fixed data can be referenced and retrieved from the Program Memory.

Other Operations

In addition to the above functional instructions, a range of other instructions also exist such as the "HALT" instruction for Power-down operations and instructions to control the operation of the Watchdog Timer for reliable program operations under extreme electric or electromagnetic environments. For their relevant operations, refer to the functional related sections.



Instruction Set Summary

The following table depicts a summary of the instruction set categorised according to function and can be consulted as a basic instruction reference using the following listed conventions.

Table Conventions

x: Bits immediate data

m: Data Memory address

A: Accumulator

i: 0~7 number of bits

addr: Program memory address

add	addr: Program memory address				
Mnemonic	Description	Cycles	Flag Affected		
Arithmetic					
ADD A,[m]	Add Data Memory to ACC	1	Z, C, AC, OV		
ADDM A,[m]	Add ACC to Data Memory	1 Note	Z, C, AC, OV		
ADD A,x	Add immediate data to ACC	1	Z, C, AC, OV		
ADC A,[m]	Add Data Memory to ACC with Carry	1	Z, C, AC, OV		
ADCM A,[m]	Add ACC to Data memory with Carry	1 Note	Z, C, AC, OV		
SUB A,x	Subtract immediate data from the ACC	1	Z, C, AC, OV		
SUB A,[m]	Subtract Data Memory from ACC	1	Z, C, AC, OV		
SUBM A,[m]	Subtract Data Memory from ACC with result in Data Memory	1 Note	Z, C, AC, OV		
SBC A,[m]	Subtract Data Memory from ACC with Carry	1	Z, C, AC, OV		
SBCM A,[m]	Subtract Data Memory from ACC with Carry, result in Data Memory	1 Note	Z, C, AC, OV		
DAA [m]	Decimal adjust ACC for Addition with result in Data Memory	1 Note	С		
Logic Operation					
AND A,[m]	Logical AND Data Memory to ACC	1	Z		
OR A,[m]	Logical OR Data Memory to ACC	1	Z		
XOR A,[m]	Logical XOR Data Memory to ACC	1	Z		
ANDM A,[m]	Logical AND ACC to Data Memory	1 Note	Z		
ORM A,[m]	Logical OR ACC to Data Memory	1 Note	Z		
XORM A,[m]	Logical XOR ACC to Data Memory	1 Note	Z		
AND A,x	Logical AND immediate Data to ACC	1	Z		
OR A,x	Logical OR immediate Data to ACC	1	Z		
XOR A,x	Logical XOR immediate Data to ACC	1	Z		
CPL [m]	Complement Data Memory	1 Note	Z		
CPLA [m]	Complement Data Memory with result in ACC	1	Z		
Increment & Decrement					
INCA [m]	Increment Data Memory with result in ACC	1	Z		
INC [m]	Increment Data Memory	1 Note	Z		
DECA [m]	Decrement Data Memory with result in ACC	1	Z		
DEC [m]	Decrement Data Memory	1 Note	Z		
Rotate	Rotate				
RRA [m]	Rotate Data Memory right with result in ACC	1	None		
RR [m]	Rotate Data Memory right	1 Note	None		
RRCA [m]	Rotate Data Memory right through Carry with result in ACC	1	С		
RRC [m]	Rotate Data Memory right through Carry	1 Note	С		
RLA [m]	Rotate Data Memory left with result in ACC	1	None		
RL [m]	Rotate Data Memory left	1 Note	None		
RLCA [m]	Rotate Data Memory left through Carry with result in ACC	1	С		
RLC [m]	Rotate Data Memory left through Carry	1 Note	С		



Mnemonic	Description	Cycles	Flag Affected
Data Move			
MOV A,[m]	Move Data Memory to ACC	1	None
MOV [m],A	Move ACC to Data Memory	1 Note	None
MOV A,x	Move immediate data to ACC	1	None
Bit Operation			
CLR [m].i	Clear bit of Data Memory	1 Note	None
SET [m].i	Set bit of Data Memory	1 Note	None
Branch		,	
JMP addr	Jump unconditionally	2	None
SZ [m]	Skip if Data Memory is zero	1 Note	None
SZA [m]	Skip if Data Memory is zero with data movement to ACC	1 Note	None
SZ [m].i	Skip if bit i of Data Memory is zero	1 Note	None
SNZ [m].i	Skip if bit i of Data Memory is not zero	1 Note	None
SIZ [m]	Skip if increment Data Memory is zero	1 Note	None
SDZ [m]	Skip if decrement Data Memory is zero	1 Note	None
SIZA [m]	Skip if increment Data Memory is zero with result in ACC	1 Note	None
SDZA [m]	Skip if decrement Data Memory is zero with result in ACC	1 Note	None
CALL addr	Subroutine call	2	None
RET	Return from subroutine	2	None
RET A,x	Return from subroutine and load immediate data to ACC	2	None
RETI	Return from interrupt	2	None
Table Read			
TABRD [m]	Read table to TBLH and Data Memory	2 ^{Note}	None
TABRDL [m]	Read table (last page) to TBLH and Data Memory	2 ^{Note}	None
Miscellaneous			
NOP	No operation	1	None
CLR [m]	Clear Data Memory	1 Note	None
SET [m]	Set Data Memory	1 Note	None
CLR WDT	Clear Watchdog Timer	1	TO, PDF
CLR WDT1	Pre-clear Watchdog Timer	1	TO, PDF
CLR WDT2	Pre-clear Watchdog Timer	1	TO, PDF
SWAP [m]	Swap nibbles of Data Memory	1 Note	None
SWAPA [m]	Swap nibbles of Data Memory with result in ACC	1	None
HALT	Enter power down mode	1	TO, PDF

Note: 1. For skip instructions, if the result of the comparison involves a skip then two cycles are required, if no skip takes place only one cycle is required.

- 2. Any instruction which changes the contents of the PCL will also require 2 cycles for execution.
- 3. For the "CLR WDT1" and "CLR WDT2" instructions the TO and PDF flags may be affected by the execution status. The TO and PDF flags are cleared after both "CLR WDT1" and "CLR WDT2" instructions are consecutively executed. Otherwise the TO and PDF flags remain unchanged.



Instruction Definition

ADC A,[m] Add Data Memory to ACC with Carry

Description The contents of the specified Data Memory, Accumulator and the carry flag are added.

The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC + [m] + C$

Affected flag(s) OV, Z, AC, C

ADCM A,[m] Add ACC to Data Memory with Carry

Description The contents of the specified Data Memory, Accumulator and the carry flag are added.

The result is stored in the specified Data Memory.

Operation $[m] \leftarrow ACC + [m] + C$

Affected flag(s) OV, Z, AC, C

ADD A,[m] Add Data Memory to ACC

Description The contents of the specified Data Memory and the Accumulator are added.

The result is stored in the Accumulator.

 $\begin{array}{ll} \text{Operation} & \text{ACC} \leftarrow \text{ACC} + [m] \\ \text{Affected flag(s)} & \text{OV, Z, AC, C} \end{array}$

ADD A,x Add immediate data to ACC

Description The contents of the Accumulator and the specified immediate data are added.

The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC + x$ Affected flag(s) OV, Z, AC, C

ADDM A,[m] Add ACC to Data Memory

Description The contents of the specified Data Memory and the Accumulator are added.

The result is stored in the specified Data Memory.

 $\label{eq:continuous} \begin{array}{ll} \text{Operation} & & [m] \leftarrow ACC + [m] \\ \text{Affected flag(s)} & & \text{OV, Z, AC, C} \end{array}$

AND A,[m] Logical AND Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise logical AND

operation. The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC "AND" [m]$

Affected flag(s) Z

AND A,x Logical AND immediate data to ACC

Description Data in the Accumulator and the specified immediate data perform a bit wise logical AND

operation. The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC$ "AND" x

Affected flag(s) Z

ANDM A,[m] Logical AND ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical AND

operation. The result is stored in the Data Memory.

Operation $[m] \leftarrow ACC "AND" [m]$

Affected flag(s) Z



CALL addr Subroutine call

Description Unconditionally calls a subroutine at the specified address. The Program Counter then

increments by 1 to obtain the address of the next instruction which is then pushed onto the stack. The specified address is then loaded and the program continues execution from this new address. As this instruction requires an additional operation, it is a two cycle instruction.

Operation Stack \leftarrow Program Counter + 1

 $Program\ Counter \leftarrow addr$

Affected flag(s) None

CLR [m] Clear Data Memory

Description Each bit of the specified Data Memory is cleared to 0.

Operation $[m] \leftarrow 00H$ Affected flag(s) None

CLR [m].i Clear bit of Data Memory

Description Bit i of the specified Data Memory is cleared to 0.

Operation [m].i \leftarrow 0 Affected flag(s) None

CLR WDT Clear Watchdog Timer

Description The TO, PDF flags and the WDT are all cleared.

Operation WDT cleared

 $TO \leftarrow 0$
PDF $\leftarrow 0$

Affected flag(s) TO, PDF

CLR WDT1 Pre-clear Watchdog Timer

Description The TO, PDF flags and the WDT are all cleared. Note that this instruction works in

conjunction with CLR WDT2 and must be executed alternately with CLR WDT2 to have effect. Repetitively executing this instruction without alternately executing CLR WDT2 will

have no effect.

Operation WDT cleared

 $\begin{aligned} & TO \leftarrow 0 \\ & PDF \leftarrow 0 \end{aligned}$

Affected flag(s) TO, PDF

CLR WDT2 Pre-clear Watchdog Timer

Description The TO, PDF flags and the WDT are all cleared. Note that this instruction works in conjunction

with CLR WDT1 and must be executed alternately with CLR WDT1 to have effect.

Repetitively executing this instruction without alternately executing CLR WDT1 will have no

effect.

Operation WDT cleared

 $TO \leftarrow 0$
PDF \leftleftharpoonup 0

Affected flag(s) TO, PDF

CPL [m] Complement Data Memory

Description Each bit of the specified Data Memory is logically complemented (1's complement). Bits which

previously contained a 1 are changed to 0 and vice versa.

Operation $[m] \leftarrow \overline{[m]}$

Affected flag(s) Z



CPLA [m] Complement Data Memory with result in ACC

Description Each bit of the specified Data Memory is logically complemented (1's complement). Bits which

previously contained a 1 are changed to 0 and vice versa. The complemented result is stored in

the Accumulator and the contents of the Data Memory remain unchanged.

Operation $ACC \leftarrow \overline{[m]}$

Affected flag(s) Z

DAA [m] Decimal-Adjust ACC for addition with result in Data Memory

Description Convert the contents of the Accumulator value to a BCD (Binary Coded Decimal) value

resulting from the previous addition of two BCD variables. If the low nibble is greater than 9 or if AC flag is set, then a value of 6 will be added to the low nibble. Otherwise the low nibble remains unchanged. If the high nibble is greater than 9 or if the C flag is set, then a value of 6 will be added to the high nibble. Essentially, the decimal conversion is performed by adding 00H, 06H, 60H or 66H depending on the Accumulator and flag conditions. Only the C flag may be affected by this instruction which indicates that if the original BCD sum is greater than

100, it allows multiple precision decimal addition.

Operation $[m] \leftarrow ACC + 00H \text{ or}$

 $[m] \leftarrow ACC + 06H \text{ or}$ $[m] \leftarrow ACC + 60H \text{ or}$ $[m] \leftarrow ACC + 66H$

Affected flag(s) C

DEC [m] Decrement Data Memory

Description Data in the specified Data Memory is decremented by 1.

Operation $[m] \leftarrow [m] - 1$

Affected flag(s) Z

DECA [m] Decrement Data Memory with result in ACC

Description Data in the specified Data Memory is decremented by 1. The result is stored in the

Accumulator. The contents of the Data Memory remain unchanged.

Operation $ACC \leftarrow [m] - 1$

Affected flag(s) Z

HALT Enter power down mode

Description This instruction stops the program execution and turns off the system clock. The contents of

the Data Memory and registers are retained. The WDT and prescaler are cleared. The power

down flag PDF is set and the WDT time-out flag TO is cleared.

Operation $TO \leftarrow 0$

 $PDF \leftarrow 1$

Affected flag(s) TO, PDF

INC [m] Increment Data Memory

Description Data in the specified Data Memory is incremented by 1.

Operation $[m] \leftarrow [m] + 1$

Affected flag(s) Z

INCA [m] Increment Data Memory with result in ACC

Description Data in the specified Data Memory is incremented by 1. The result is stored in the Accumulator.

The contents of the Data Memory remain unchanged.

Operation $ACC \leftarrow [m] + 1$

Affected flag(s) Z

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JMP addr Jump unconditionally

Description The contents of the Program Counter are replaced with the specified address. Program

execution then continues from this new address. As this requires the insertion of a dummy

instruction while the new address is loaded, it is a two cycle instruction.

Operation Program Counter ← addr

Affected flag(s) None

MOV A,[m] Move Data Memory to ACC

Description The contents of the specified Data Memory are copied to the Accumulator.

 $\begin{array}{ll} \text{Operation} & \quad & \text{ACC} \leftarrow [m] \\ \text{Affected flag(s)} & \quad & \text{None} \\ \end{array}$

MOV A,x Move immediate data to ACC

Description The immediate data specified is loaded into the Accumulator.

Operation $ACC \leftarrow x$ Affected flag(s) None

MOV [m],A Move ACC to Data Memory

Description The contents of the Accumulator are copied to the specified Data Memory.

Operation $[m] \leftarrow ACC$ Affected flag(s) None

NOP No operation

Description No operation is performed. Execution continues with the next instruction.

Operation No operation
Affected flag(s) None

OR A,[m] Logical OR Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise

logical OR operation. The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC "OR" [m]$

Affected flag(s) Z

OR A,x Logical OR immediate data to ACC

Description Data in the Accumulator and the specified immediate data perform a bitwise logical OR

operation. The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC "OR" x$

Affected flag(s) Z

ORM A,[m] Logical OR ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical OR

operation. The result is stored in the Data Memory.

Operation $[m] \leftarrow ACC "OR" [m]$

Affected flag(s) Z

RET Return from subroutine

Description The Program Counter is restored from the stack. Program execution continues at the restored

address.

Operation Program Counter ← Stack

Affected flag(s) None



RET A,x Return from subroutine and load immediate data to ACC

Description The Program Counter is restored from the stack and the Accumulator loaded with the specified

immediate data. Program execution continues at the restored address.

Operation Program Counter ← Stack

 $ACC \leftarrow x$

Affected flag(s) None

RETI Return from interrupt

Description The Program Counter is restored from the stack and the interrupts are re-enabled by setting the

EMI bit. EMI is the master interrupt global enable bit. If an interrupt was pending when the RETI instruction is executed, the pending Interrupt routine will be processed before returning

to the main program.

Operation Program Counter ← Stack

 $EMI \leftarrow 1$

Affected flag(s) None

RL [m] Rotate Data Memory left

Description The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.

Operation $[m].(i+1) \leftarrow [m].i; (i=0\sim6)$

 $[m].0 \leftarrow [m].7$

Affected flag(s) None

RLA [m] Rotate Data Memory left with result in ACC

Description The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.

The rotated result is stored in the Accumulator and the contents of the Data Memory remain

unchanged.

Operation ACC.(i+1) \leftarrow [m].i; (i=0 \sim 6)

 $ACC.0 \leftarrow [m].7$

Affected flag(s) None

RLC [m] Rotate Data Memory left through Carry

Description The contents of the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7

replaces the Carry bit and the original carry flag is rotated into bit 0.

Operation $[m].(i+1) \leftarrow [m].i; (i=0\sim6)$

 $[m].0 \leftarrow C$

 $C \leftarrow [m].7$

Affected flag(s) C

RLCA [m] Rotate Data Memory left through Carry with result in ACC

Description Data in the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7 replaces the

Carry bit and the original carry flag is rotated into the bit 0. The rotated result is stored in the

Accumulator and the contents of the Data Memory remain unchanged.

Operation $ACC.(i+1) \leftarrow [m].i; (i=0\sim6)$

 $ACC.0 \leftarrow C$

 $C \leftarrow [m].7$

Affected flag(s) C

RR [m] Rotate Data Memory right

Description The contents of the specified Data Memory are rotated right by 1 bit with bit 0 rotated into bit 7.

Operation $[m].i \leftarrow [m].(i+1); (i=0\sim6)$

 $[m].7 \leftarrow [m].0$

Affected flag(s) None



RRA [m] Rotate Data Memory right with result in ACC

Description Data in the specified Data Memory and the carry flag are rotated right by 1 bit with bit 0

rotated into bit 7. The rotated result is stored in the Accumulator and the contents of the

Data Memory remain unchanged.

Operation ACC.i \leftarrow [m].(i+1); (i=0 \sim 6)

 $ACC.7 \leftarrow [m].0$

Affected flag(s) None

RRC [m] Rotate Data Memory right through Carry

Description The contents of the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0

replaces the Carry bit and the original carry flag is rotated into bit 7.

Operation $[m].i \leftarrow [m].(i+1); (i=0\sim6)$

 $[m].7 \leftarrow C$

 $C \leftarrow [m].0$

Affected flag(s) C

RRCA [m] Rotate Data Memory right through Carry with result in ACC

Description Data in the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0 replaces

the Carry bit and the original carry flag is rotated into bit 7. The rotated result is stored in the

Accumulator and the contents of the Data Memory remain unchanged.

 $ACC.i \leftarrow [m].(i+1); (i=0\sim6)$

 $ACC.7 \leftarrow C$

 $C \leftarrow [m].0$

Affected flag(s) C

Operation

SBC A,[m] Subtract Data Memory from ACC with Carry

Description The contents of the specified Data Memory and the complement of the carry flag are

subtracted from the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is

positive or zero, the C flag will be set to 1.

Operation $ACC \leftarrow ACC - [m] - C$

Affected flag(s) OV, Z, AC, C

SBCM A,[m] Subtract Data Memory from ACC with Carry and result in Data Memory

Description The contents of the specified Data Memory and the complement of the carry flag are

subtracted from the Accumulator. The result is stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is

positive or zero, the C flag will be set to 1.

Operation $[m] \leftarrow ACC - [m] - C$

Affected flag(s) OV, Z, AC, C

SDZ [m] Skip if decrement Data Memory is 0

Description The contents of the specified Data Memory are first decremented by 1. If the result is 0 the

following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program

proceeds with the following instruction.

Operation $[m] \leftarrow [m] - 1$

Skip if [m]=0

Affected flag(s) None



SDZA [m] Skip if decrement Data Memory is zero with result in ACC

Description The contents of the specified Data Memory are first decremented by 1. If the result is 0, the

following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy

instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0,

the program proceeds with the following instruction.

Operation $ACC \leftarrow [m] - 1$

Skip if ACC=0

Affected flag(s) None

SET [m] Set Data Memory

Description Each bit of the specified Data Memory is set to 1.

Operation $[m] \leftarrow FFH$ Affected flag(s) None

SET [m].i Set bit of Data Memory

Description Bit i of the specified Data Memory is set to 1.

 $\begin{array}{ll} \text{Operation} & \quad [m].i \leftarrow 1 \\ \text{Affected flag(s)} & \quad \text{None} \end{array}$

SIZ [m] Skip if increment Data Memory is 0

Description The contents of the specified Data Memory are first incremented by 1. If the result is 0, the

following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program

proceeds with the following instruction.

Operation $[m] \leftarrow [m] + 1$

Skip if [m]=0

Affected flag(s) None

SIZA [m] Skip if increment Data Memory is zero with result in ACC

Description The contents of the specified Data Memory are first incremented by 1. If the result is 0, the

following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy

instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not

0 the program proceeds with the following instruction.

Operation $ACC \leftarrow [m] + 1$

Skip if ACC=0

Affected flag(s) None

SNZ [m].i Skip if bit i of Data Memory is not 0

Description If bit i of the specified Data Memory is not 0, the following instruction is skipped. As this

requires the insertion of a dummy instruction while the next instruction is fetched, it is a two

cycle instruction. If the result is 0 the program proceeds with the following instruction.

Operation Skip if [m]. $i \neq 0$

Affected flag(s) None

SUB A,[m] Subtract Data Memory from ACC

Description The specified Data Memory is subtracted from the contents of the Accumulator. The result is

stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be

cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation $ACC \leftarrow ACC - [m]$

Affected flag(s) OV, Z, AC, C



SUBM A,[m] Subtract Data Memory from ACC with result in Data Memory

Description The specified Data Memory is subtracted from the contents of the Accumulator. The result is

stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be

cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

 $\begin{array}{ll} \text{Operation} & [m] \leftarrow ACC - [m] \\ \text{Affected flag(s)} & \text{OV, Z, AC, C} \end{array}$

SUB A,x Subtract immediate data from ACC

Description The immediate data specified by the code is subtracted from the contents of the Accumulator.

The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation $ACC \leftarrow ACC - x$ Affected flag(s) OV, Z, AC, C

SWAP [m] Swap nibbles of Data Memory

Description The low-order and high-order nibbles of the specified Data Memory are interchanged.

Operation [m].3 \sim [m].0 \leftrightarrow [m].7 \sim [m].4

Affected flag(s) None

SWAPA [m] Swap nibbles of Data Memory with result in ACC

Description The low-order and high-order nibbles of the specified Data Memory are interchanged. The

result is stored in the Accumulator. The contents of the Data Memory remain unchanged.

Operation $ACC.3 \sim ACC.0 \leftarrow [m].7 \sim [m].4$

 $ACC.7 \sim ACC.4 \leftarrow [m].3 \sim [m].0$

Affected flag(s) None

SZ [m] Skip if Data Memory is 0

Description If the contents of the specified Data Memory is 0, the following instruction is skipped. As this

requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program proceeds with the following instruction.

Operation Skip if [m]=0

Affected flag(s) None

SZA [m] Skip if Data Memory is 0 with data movement to ACC

Description The contents of the specified Data Memory are copied to the Accumulator. If the value is zero,

the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the

program proceeds with the following instruction.

Operation $ACC \leftarrow [m]$

Skip if [m]=0

Affected flag(s) None

SZ [m].i Skip if bit i of Data Memory is 0

Description If bit i of the specified Data Memory is 0, the following instruction is skipped. As this requires

the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle

instruction. If the result is not 0, the program proceeds with the following instruction.

Operation Skip if [m].i=0

Affected flag(s) None



TABRD [m] Read table (current page) to TBLH and Data Memory

Description The low byte of the program code (current page) addressed by the table pointer (TBLP) is

moved to the specified Data Memory and the high byte moved to TBLH.

Operation $[m] \leftarrow \text{program code (low byte)}$

TBLH ← program code (high byte)

Affected flag(s) None

TABRDL [m] Read table (last page) to TBLH and Data Memory

Description The low byte of the program code (last page) addressed by the table pointer (TBLP) is moved

to the specified Data Memory and the high byte moved to TBLH.

Operation $[m] \leftarrow \text{program code (low byte)}$

TBLH ← program code (high byte)

Affected flag(s) None

XOR A,[m] Logical XOR Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise logical XOR

operation. The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC "XOR" [m]$

Affected flag(s) Z

XORM A,[m] Logical XOR ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical XOR

operation. The result is stored in the Data Memory.

Operation $[m] \leftarrow ACC "XOR" [m]$

Affected flag(s) Z

XOR A,x Logical XOR immediate data to ACC

Description Data in the Accumulator and the specified immediate data perform a bitwise logical XOR

operation. The result is stored in the Accumulator.

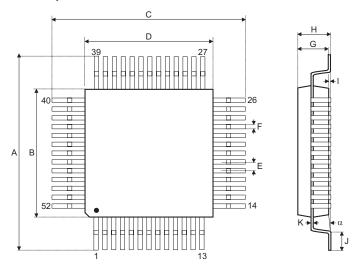
Operation $ACC \leftarrow ACC "XOR" x$

Affected flag(s) Z

Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the Holtek website (http://www.holtek.com.tw/english/literature/package.pdf) for the latest version of the package information.

52-pin QFP (14mm×14mm) Outline Dimensions

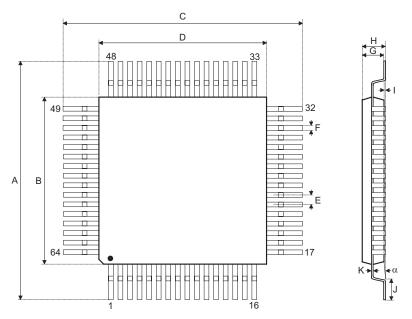


Cumbal		Dimensions in inch	
Symbol	Min.	Nom.	Max.
Α	0.681	_	0.689
В	0.547	_	0.555
С	0.681	_	0.689
D	0.547	_	0.555
E	_	0.039	_
F	_	0.016	_
G	0.098	_	0.122
Н	_	_	0.134
I	_	0.004	_
J	0.029	_	0.041
K	0.004	_	0.008
α	0°	_	7°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
А	17.30	_	17.50
В	13.90	_	14.10
С	17.30	_	17.50
D	13.90	_	14.10
E	_	1.00	_
F	_	0.40	_
G	2.50	_	3.10
Н	_	_	3.40
I	_	0.10	_
J	0.73	_	1.03
K	0.10	_	0.20
α	0°	_	7°



64-pin LQFP (7mm×7mm) Outline Dimensions

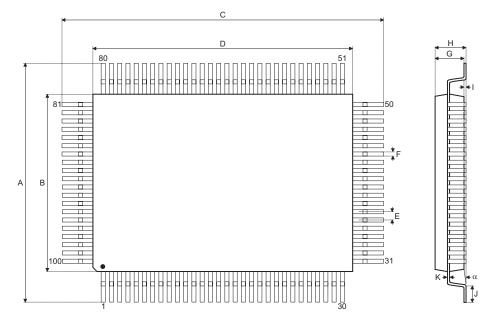


Symbol	Dimensions in inch		
	Min.	Nom.	Max.
А	0.350	_	0.358
В	0.272	_	0.280
С	0.350	_	0.358
D	0.272	_	0.280
E	_	0.016	_
F	0.005	_	0.009
G	0.053	_	0.057
Н	_	_	0.063
I	0.002	_	0.006
J	0.018	_	0.030
K	0.004	_	0.008
α	0°	_	7°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
А	8.90	_	9.10
В	6.90	_	7.10
С	8.90	_	9.10
D	6.90	_	7.10
E	_	0.40	_
F	0.13	_	0.23
G	1.35	_	1.45
Н	_	_	1.60
I	0.05	_	0.15
J	0.45	_	0.75
K	0.09	_	0.20
α	0°	_	7°



100-pin LQFP (14mm×14mm) Outline Dimensions



Symbol	Dimensions in inch		
	Min.	Nom.	Max.
А	0.626		0.634
В	0.547	_	0.555
С	0.626	_	0.634
D	0.547	_	0.555
E	_	0.020	_
F	_	0.008	_
G	0.053	_	0.057
Н	_	_	0.063
1	_	0.004	_
J	0.018	_	0.030
K	0.004	_	0.008
α	0°	_	7°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
А	15.90	_	16.10
В	13.90	_	14.10
С	15.90	_	16.10
D	13.90	_	14.10
Е	_	0.50	_
F	_	0.20	_
G	1.35	_	1.45
Н	_	_	1.60
I	_	0.10	_
J	0.45	_	0.75
K	0.10	_	0.20
α	0°	-	7°



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